## UT81NDQ512G8T

#### Features

- Open NAND Flash Interface (ONFI) 4.0-compliant<sup>1</sup>
- JEDEC NAND Flash Interoperability (JESD230C) compliant<sup>2</sup>
- Triple-level cell (TLC)
- B17A Industrial die source
- Organization
  - Page size x8: 18,592 bytes (16,384 + 2208 bytes)
  - Block size: 2304 pages, (36,864K + 4968K bytes)
  - Plane size: 4 planes x 504 blocks
  - Device size: 16128 blocks
- NV-DDR3 I/O performance<sup>3</sup>
  - Up to NV-DDR3 timing mode 9
  - Clock rate: 3ns (NV-DDR3)
  - Read/write throughput per pin: 667 MT/s
  - Tested over temperature in mode 9
- NV-DDR2 I/O performance<sup>4</sup>
  - Up to NV-DDR2 timing mode 8
  - Clock rate: 3.75ns (NV-DDR2)
  - Read/write throughput per pin: 533 MT/s
  - Tested over temperature in mode 6
- Asynchronous I/O performance<sup>4</sup>
  - Up to asynchronous timing mode 5
  - tRC/tWC: 20ns (MIN)
  - Read/write throughput per pin: 50 MT/s
  - Tested over temperature in mode 5
- TLC Array performance
  - SNAP READ operation time without VPP: 51µs(TYP)
  - Single-Plane READ PAGE operation time without/with VPP : 74/73µs (TYP)
  - Multi-Plane READ PAGE operation time without VPP: 88µs(TYP)
  - Effective Program page time without VPP : 1900µs(TYP)
  - Erase block time: 15ms (TYP)
- Operating Voltage Range
  - VCC: 2.7-3.6V
  - VCCQ: 1.14-1.26V, 1.7-1.95V
- Command set: ONFI NAND Flash Protocol
- Data is required to be randomized by the external host prior to being inputted to the NAND device, see External Data Randomization in the User Manual
- First block (block address 00h) is valid when shipped from factory. For minimum required ECC, see Error Management in the User Manual<sup>5</sup>
- RESET (FFh) required as first command after power-on
- Operation status byte provides software method for detecting
  - Operation completion



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- Pass/fail condition
- Write-protect status
- Data strobe (DQS) signals provide a hardware method for synchronizing data DQ in the NV-DDR2/NVDDR3 interface
- Copyback operations supported within the plane from which data is read
- On-die Termination (ODT)<sup>6</sup>
- Quality and reliability<sup>7</sup>
  - Testing methodology: JESD47
  - Data retention: JESD47 compliant
  - TLC Endurance: 3,000 PROGRAM/ERASE cycles
  - SLC Endurance: 40,000 PROGRAM/ERASE cycles
- Package
  - 132-ball BGA
  - ΘJC : 2.68 °C/W
  - 2000V HBM ESD
  - 0.534 grams

#### Notes:

- 1) The ONFI 4.0 specification is available at <u>www.onfi.org</u>
- 2) The JEDEC specification is available at <u>www.jedec.org/standards-documents</u>
- 3) NV-DDR3 functionality is only available with 1.2V VCCQ
- 4) NV-DDR2 and Asynchronous functionality is only available with 1.8V VCCQ
- 5) ODT functionality is supported only in NVDDR2 and NV-DDR3 mode
- 6) READ RETRY and AUTO READ CALIBRATION operations are required to achieve specified endurance and for general array data integrity
- 7) For minimum required ECC, see External Data Randomization in the User Manual
- 8) Radiation testing is performed without VPP. VPP operations should not be used in a radiation environment. Devices using  $V_{PP}$  operations in a radiation environment will not be warrantied

#### **Operational Environment**

- Temperature Range: -40°C to +85°C
- Total Dose: 30 to 50 krad(Si)
- SEL Immune: ≤ 60 MeV-cm<sup>2</sup>/mg

#### Notes:

- 1. Radiation testing is performed without VPP. VPP operations should not be used in a radiation environment. Devices using  $V_{PP}$  operations in a radiation environment will not be warrantied
- 2. Contact supplier for bit error performance and availability of material at a specific SLC and TLC TID levels

#### 1 General Description

NAND Flash devices include an asynchronous data interface for I/O operations. These devices use a highly multiplexed 8-bit bus (DQx) to transfer commands, address, and data. There are five control signals used to implement the asynchronous data interface: CE#, CLE, ALE, WE#, and RE#. Additional signals control hardware write protection (WP#) and monitor device status (R/B#).

This NAND Flash device additionally includes a NV-DDR2, and/or a NV-DDR3 data interface for high-performance I/O operations. Data transfers include a bidirectional data strobe (DQS).

This hardware interface creates a low pin-count device with a standard pinout that remains the same from one density to another, enabling future upgrades to higher densities with no board redesign.



# 4Tb TLC NAND Flash UT81NDQ512G8T

A target is the unit of memory accessed by a chip enable signal. A target contains one or more NAND Flash die. A NAND Flash die is the minimum unit that can independently execute commands and report status. A NAND Flash die, in the ONFI specification, is referred to as a logical unit (LUN). For further details, see Device and Array Organization.

#### 2 Asynchronous, NV-DDR2, NV-DDR3 Signal Descriptions

#### Table 1: Asynchronous, NV-DDR2, and NV-DDR3 Signal Definitions

| Asynchronous<br>Signal <sup>1</sup> | NV-DDR2/NV-<br>DDR3 Signal <sup>1</sup> | Туре   | Description <sup>2</sup>   |
|-------------------------------------|---|--------|--|
| ALE                                 | ALE                                     | Input  | <b>Address latch enable</b> : Loads an address from DQx into the address register.   |
| CE#                                 | CE#                                     | Input  | <b>Chip enable</b> : Enables or disables one or more die (LUNs) in a target.   |
| CLE                                 | CLE                                     | Input  | <b>Command latch enable</b> : Loads a command from DQx into the command register.  |
| DQx                                 | DQx                                     | I/O    | <b>Data inputs/outputs</b> : The bidirectional I/Os transfer address, data, and command information.   |
| -                                   | DQS, DQS_t                              | I/O    | <b>Data strobe</b> : Provides a synchronous reference for data input and output.   |
| -                                   | DQS_c                                   | I/O    | <b>Data strobe complement</b> : Provides a complementary signal to the data strobe signal optionally used in the NV-DDR2 or NV-DDR3 interface for synchronous reference for data input and output  |
| ENi                                 | ENi                                     | Input  | <b>Enumerate input</b> : Input to a NAND device (if first NAND device on the daisy chain have as NC) from ENo of a previous NAND device to support CE# pin reduction functionality.  |
| ENo                                 | ENo                                     | Output | <b>Enumerate output</b> : Output from a NAND device to the ENi of the next NAND device in the daisy chain to support CE# pin reduction functionality.  |
| RE#                                 | RE#, RE_t                               | Input  | <b>Read enable and write/read</b> : RE# transfers serial data from the NAND Flash to the host system when the asynchronous interface is active.  |
| -                                   | RE_c                                    | Input  | <b>Read enable complement:</b> Provides a complementary signal to the read enable signal optionally used in the NV-DDR2 or NV-DDR3 interface for synchronous reference for data output.  |
| WE#                                 | WE#                                     | Input  | <b>Write enable and clock</b> : WE# transfers commands,<br>addresses when the asynchronous, NV-DDR2, and NV-DDR3<br>interfaces are active, and serial data from the host system<br>to the NAND Flash when the asynchronous interface is<br>active. |
| WP#                                 | WP#                                     | Input  | <b>Write protect</b> : Enables or disables array PROGRAM and ERASE operations.   |
| R/B#                                | R/B#                                    | Output | <b>Ready/busy</b> : An open-drain, active-low output that requires an external pull-up resistor. This signal indicates target array activity.  |





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| Asynchronous<br>Signal <sup>1</sup> | NV-DDR2/NV-<br>DDR3 Signal <sup>1</sup> | Туре   | Description <sup>2</sup>  |
|-------------------------------------|---|--------|---|
| Vcc                                 | Vcc                                     | Supply | Vcc: Core power supply  |
| Vccq                                | Vccq                                    | Supply | Vccq: I/O power supply  |
| Vpp                                 | Vpp                                     | Supply | <b>V</b> <sub>PP</sub> : The V <sub>PP</sub> signal is an optional external high voltage power supply to the device. This high voltage power supply may be used to enhance operations (e.g., improved power efficiency). If V <sub>PP</sub> will not be utilized by a host system, that V <sub>PP</sub> signal location is then defined as a DNU signal location. |
| V <sub>SS</sub>                     | V <sub>SS</sub>                         | Supply | Vss: Core ground connection   |
| Vssq                                | Vssq                                    | Supply | Vssq: I/O ground connection   |
| -                                   | V <sub>REFQ</sub>                       | Supply | $\mathbf{V}_{REFQ}$ : Reference voltage used with NV-DDR2 and NV-DDR3 interfaces  |
| ZQ                                  | ZQ                                      | -      | <b>Reference pin for ZQ calibration</b> : This is used on ZQ calibration. The ZQ signal shall be connected to Vss through $R_{ZQ}$ resistor   |
| NC                                  | NC                                      | -      | <b>No connect</b> : NCs are not internally connected. They can be driven or left unconnected  |
| DNU                                 | DNU                                     | -      | <b>Do not use</b> : DNUs must be left unconnected.  |
| RFU                                 | RFU                                     | -      | Reserved for future use: RFUs must be left unconnected  |

- 1) See Device and Array Organization and Signal Assignment sections for detailed signal connections.
- See User Manual: Bus Operation Asynchronous Interface, Bus Operations NV-DDR2 Interface, and Bus Operation NV-DDR3 Interface for detailed Asynchronous, NV-DDR2, and NV-DDR3 interface signal descriptions





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#### **3** Signal Assignments

| <br>1 | 2   | 3   | 4         | 5   | 6 | 7                     | 8         | 9  | 10   | 11   |  |
|-------|---|---|-----------|---|---|-----------------------|-----------|--|--|--|--|
| NC    | ) (NC)  | (NC)  |           |   |   |                       |           | ( NC )   | (NC)   | (NC)   |  |
| NC    | ) (NC)  | (NC)  |           |   |   |                       |           | (NC)   | (NC)   | (NC)   |  |
| R     | ) ( <mark>R</mark> )  | $\left( \begin{array}{c} R \end{array} \right)$ |           |   |   |                       |           | (R)  | $\left( \begin{array}{c} R \end{array} \right)$          |  |  |
| R     | ) (V <sub>cca</sub> )   | (Vcca)  | (pa3_12)  | $(v_{ss})$                                      |   |                       | (pq4_12)  | (Vcca)   | (Voca)   | $\left( \begin{array}{c} \mathbf{R} \end{array} \right)$ |  |
| R     | $(v_{sso})$   | (DQ2_12)  | (vssq)    | 005_1_1.2<br>(DQS_11.2)                         |   | (RE_1#2)<br>VRE_1_12  | (Vssq)    | (DQ5_12)   | (V_SSQ)  | $\left( \begin{array}{c} R \end{array} \right)$          |  |
|       | (DQ0_12)  | (DQ1_12)  | (pas_1_e) | RE_1_0  |   | (WE_1# <sup>2</sup> ) | (REFQ_1)  | (DQ8_12)   | (DQ7_12)   |  |  |
|       | (Vssa)  | (Vcca)  | (ALE_12)  | (CLE_12)  |   | (NC)                  | (NC)      | (Vcca)   | (Vssa)   |  |  |
|       |   |   | (WP_1#2)  | $\left( \begin{array}{c} R \end{array} \right)$ |   | (E1_1#4)              | (CE0_1#2) | (ZQ_1)<br>(DNU)  | $\left( \begin{array}{c} R \end{array} \right)$          |  |  |
|       | $(v_{ss})$  | $\left( \mathbf{v}_{cc} \right)$                | (R/B0_0#) | (R/B1_0#  |   | (R/B1_1#              | (R/B0_1#) | (Vcc)  | $(v_{ss})$   |  |  |
|       | (R)   | ZQ_0A   | (CE0_0#)  | (CE1_0#)  |   | (V <sub>PP</sub> )    | (WP_0#)   | $\left( \begin{array}{c} \mathbf{R} \end{array} \right)$ | $\left( \begin{array}{c} \mathbf{R} \end{array} \right)$ |  |  |
|       | (Vssa)  | (Vcca)  | (NC)      | (NC)  |   | (CLE_0)               | (ALE_0)   | (Vcca)   | (Vssa)   |  |  |
|       | (DQ7_0)   | (DQ8_0)   | VREFQ_0   | (WE_0#)   |   | RE_0_03               | (as_0_d.) | (DQ1_0)  | (DQ0_0)  |  |  |
| R     | $(v_{sso})$   | (DQ5_0)   | (Vssa)    | (RE_0#)   |   | Das_01                | (Vssa)    | (DQ2_0)  | (Vssa)   | $\left( \begin{array}{c} \mathbf{R} \end{array} \right)$ |  |
| R     | ) (V <sub>cca</sub> )   | (Vcca)  | (DQ4_0)   | $\left( v_{cc} \right)$                         |   | (V <sub>ss</sub> )    | (DQ3_0)   | (Vcca)   | (Voca)   | $\left( \begin{array}{c} \mathbf{R} \end{array} \right)$ |  |
| R     | $\left( \left( \begin{array}{c} \mathbf{R} \end{array} \right) \right)$ | (R)   |           |   |   |                       |           | $\left( \begin{array}{c} \mathbf{R} \end{array} \right)$ | (R)  | (R)  |  |
|       | ) (NC)  | (NC)  |           |   |   |                       |           | (NC)   | (NC)   | (NC)   |  |
| NC    | ) (NC)  |   |           |   |   |                       |           | ( NC )   | ( NC )   | (NC)   |  |

#### Figure 1: 132-Ball BGA (Ball-Down, Top View)

#### Notes:

- 1) N/A: This signal is tri-stated when the asynchronous interface is active.
- 2) These signals are available on dual, quad, and octal die stacked die packages. They are NC for other configurations.
- 3) These signals are available when differential signaling is enabled.
- 4) These signals are available on quad die four CE# or octal die packages. They are NC for other configurations

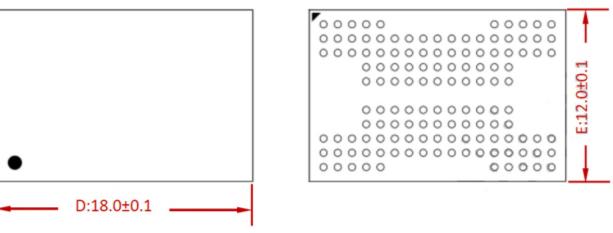
DATASHEET

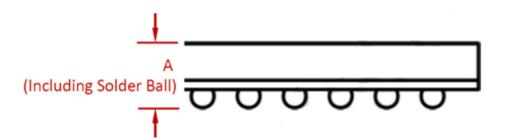


## UT81NDQ512G8T

#### 4 Package Dimensions







| Symbol (Dimension)  | Min               | Norm  | Max   |  |  |  |
|---------------------|-------------------|-------|-------|--|--|--|
| A (Total Thickness) | 1.25              | 1.35  | 1.45  |  |  |  |
| D (Lenth)           | 17.90             | 18.00 | 18.10 |  |  |  |
| E (Width)           | 11.90 12.00 12.10 |       |       |  |  |  |
| Ball Pitch          | 1.0 mm Typical    |       |       |  |  |  |
| Ball Diameter       | 0.45 mm Typical   |       |       |  |  |  |

- 1) All Dimensions in mm
- 2) Solder ball material: Sn-Pb
- 3) Package Mass: 0.534 grams



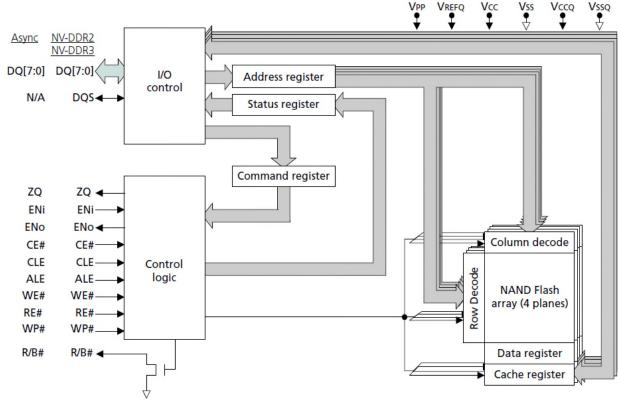
#### 5 Architecture

These devices use NAND Flash electrical and command interfaces. Data, commands, and addresses are multiplexed onto the same pins and received by I/O control circuits. The commands received at the I/O control circuits are latched by a command register and are transferred to control logic circuits for generating internal signals to control device operations. The addresses are latched by an address register and sent to a row decoder to select a row address, or to a column decoder to select a column address.

Data is transferred to or from the NAND Flash memory array, byte by byte, through a data register and a cache register.

The NAND Flash memory array is programmed and read using page-based operations and is erased using block-based operations. During normal page operations, the data and cache registers act as a single register. During cache operations, the data and cache registers operate independently to increase data throughput.

The status register reports the status of die (LUN) operations.





#### Notes:

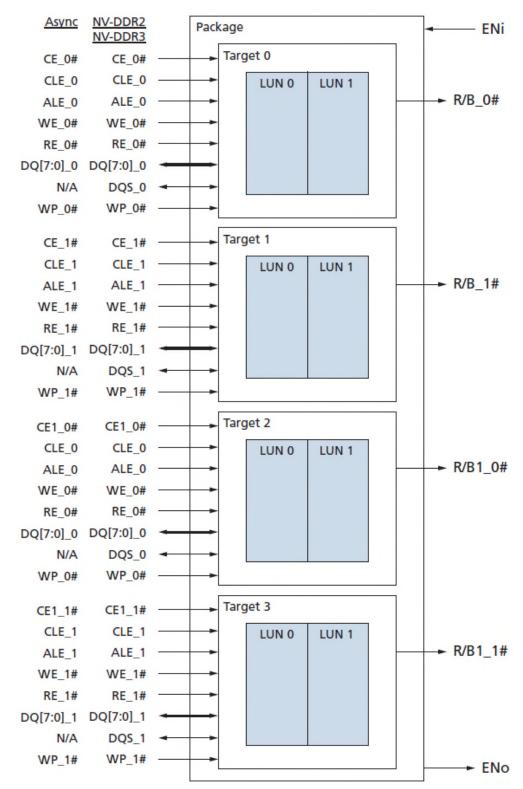
1) N/A: This signal is tri-stated when the asynchronous interface is active.



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#### 6 Device and Array Organization

#### Figure 4: Device Organization for Eight-Die Package with Four CE# (132-ball BGA)



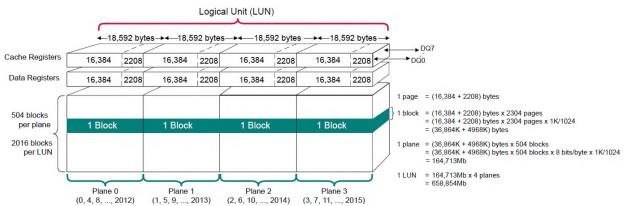




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#### Table 2: Array Addressing for Logical Unit (LUN) in TLC mode

| Cycle  | DQ7                | DQ6               | DQ5               | DQ4               | DQ3               | DQ2  | DQ1  | DQ0              |
|--------|--------------------|-------------------|-------------------|-------------------|-------------------|------|------|------------------|
| First  | CA7                | CA6               | CA5               | CA4               | CA3               | CA2  | CA1  | CA0 <sup>2</sup> |
| Second | LOW                | CA14 <sup>3</sup> | CA13              | CA12              | CA11              | CA10 | CA9  | CA8              |
| Third  | PA7                | PA6               | PA5               | PA4               | PA3               | PA2  | PA1  | PA0              |
| Fourth | BA15               | BA14              | BA13 <sup>5</sup> | BA12 <sup>5</sup> | PA11 <sup>4</sup> | PA10 | PA9  | PA8              |
| Fifth  | LA0 <sup>6,7</sup> | BA22              | BA21              | BA20              | BA19              | BA18 | BA17 | BA16             |

#### Notes:

- CAx = column address, PAx = page address, BAx = block address, LAx = LUN address; the page address, block address, and LUN address are collectively called the row address. Consequently, the first and second cycles containing the column addresses are known as C1 and C2, and the third, fourth, fifth, and sixth cycles containing the row addresses cycles are known as R1, R2, R3, and R4 respectively.
- 2) When using the NV-DDR2/NV-DDR3 interface, CA0 is forced to 0 internally; one data cycle always returns one even byte and one odd byte.
- 3) CA [14:0] address column addresses 0 through 18,591 (16,384 + 2208) (489Fh), therefore column addresses 18,592 (48A0h) through 32,767(7FFFh) are invalid, out of bounds, do not exist in the device, and cannot be addressed.
- 4) PA [11:0] address page addresses 0 through 2303 (8FFh), therefore page addresses 2304 (900h) through 4095 (FFFh) are invalid, out of bounds, do not exist in the device, and cannot be addressed.
- 5) BA[13:12] are the plane-select bits:
  - Plane 0: BA[13:12] = 00b
  - Plane 1: BA[13:12] = 01b
  - Plane 2: BA[13:12] = 10b
  - Plane 3: BA[13:12] = 11b
- 6) LA0 is the LUN-select bit.
  - LUN 0: LA0 = 0

LUN 1: LA0 = 1

7) Block addresses 2016 through 2047 and 4063 through 4095 are invalid, out of bounds, do not exist in the device, and cannot be addressed.





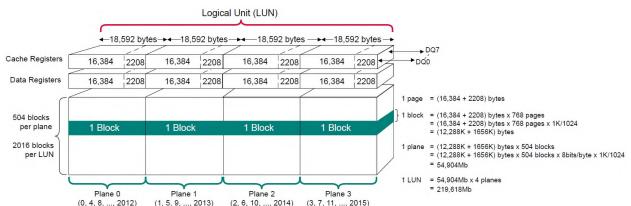


Table 3: Array Addressing for Logical Unit (LUN) in SLC mode

| Cycle  | DQ7                | DQ6               | DQ5               | DQ4               | DQ3  | DQ2  | DQ1  | DQ0              |
|--------|--------------------|-------------------|-------------------|-------------------|------|------|------|------------------|
| First  | CA7                | CA6               | CA5               | CA4               | CA3  | CA2  | CA1  | CA0 <sup>2</sup> |
| Second | LOW                | CA14 <sup>3</sup> | CA13              | CA12              | CA11 | CA10 | CA9  | CA8              |
| Third  | PA7                | PA6               | PA5               | PA4               | PA3  | PA2  | PA1  | PA0              |
| Fourth | BA15               | BA14              | BA13 <sup>5</sup> | BA12 <sup>5</sup> | LOW  | LOW  | PA9⁴ | PA8              |
| Fifth  | LA0 <sup>6,7</sup> | BA22              | BA21              | BA20              | BA19 | BA18 | BA17 | BA16             |

#### Notes:

- CAx = column address, PAx = page address, BAx = block address, LAx = LUN address; the page address, block address, and LUN address are collectively called the row address. Consequently, the first and second cycles containing the column addresses are known as C1 and C2, and the third, fourth, fifth, and sixth cycles containing the row addresses cycles are known as R1, R2, R3, and R4 respectively.
- 2) When using the NV-DDR2/NV-DDR3 interface, CA0 is forced to 0 internally; one data cycle always returns one even byte and one odd byte.
- 3) CA [14:0] address column addresses 0 through 18,591 (16,384 + 2208) (489Fh), therefore column addresses 18,592 (48A0h) through 32,767 (7FFFh) are invalid, out of bounds, do not exist in the device, and cannot be addressed.
- 4) PA [9:0] address page addresses 0 through 767 (2FFh), therefore page addresses 768 (300h) through 1023 (3FFh) are invalid, out of bounds, do not exist in the device, and cannot be addressed.
- 5) BA[13:12] are the plane-select bits:
  - Plane 0: BA[13:12] = 00b
    - Plane 1: BA[13:12] = 01b
  - Plane 2: BA[13:12] = 10b
  - Plane 3: BA[13:12] = 11b
- 6) LA0 is the LUN-select bit.

LUN 0: LA0 = 0

LUN 1: LA0 = 1

7) Block addresses 2016 through 2047 and 4063 through 4095 are invalid, out of bounds, do not exist in the device, and cannot be addressed.



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#### 7 Command Definitions

| Command                                      | Command<br>Cycle #1 | Number<br>of Valid<br>Address<br>Cycles <sup>9</sup><br>#1 | Data<br>Input<br>Cycles | Command<br>Cycle #2 | Number<br>of Valid<br>Address<br>Cycles <sup>9</sup><br>#2 | Command<br>Cycle #3 | Valid<br>While<br>Selected<br>LUN Is<br>Busy <sup>1</sup> | Valid<br>While<br>Other<br>LUNs are<br>Busy <sup>2</sup> | Notes |
|--|---------------------|--|-------------------------|---------------------|--|---------------------|---|--|-------|
| Reset Operations                             |                     |  |                         |                     |  |                     |   |  |       |
| RESET  | FFh                 | 0  | -                       | -                   | -  | -                   | Yes   | Yes  |       |
| HARD RESET                                   | FDh                 | 0  | -                       | -                   | -  | -                   |   | Yes  |       |
| SYNCHRONOUS<br>RESET                         | FCh                 | 0  | -                       | -                   | -  | -                   | Yes   | Yes  |       |
| RESET LUN                                    | FAh                 | 3/4  | -                       | -                   | -  | -                   | Yes   | Yes  |       |
| Identification Ope                           | erations            |  |                         |                     |  | •                   | •   |  |       |
| READ ID                                      | 90h                 | 1  | -                       | -                   | -  | -                   |   |  | 3     |
| READ<br>PARAMETER PAGE                       | ECh                 | 1  | -                       | -                   | -  | -                   |   |  |       |
| READ UNIQUE ID                               | EDh                 | 1  | -                       | -                   | -  | -                   |   |  |       |
| Configuration Op                             | erations            |  |                         |                     |  | •                   | •   |  |       |
| VOLUME SELECT                                | E1h                 | 1  | -                       | -                   | -  | -                   |   |  |       |
| ODT CONFIGURE                                | E2h                 | 1/2  | 4                       | -                   | -  | -                   |   |  |       |
| GET FEATURES                                 | EEh                 | 1  | -                       | -                   | -  | -                   |   |  | 3     |
| SET FEATURE                                  | EFh                 | 1  | 4                       | -                   | -  | -                   |   |  | 4     |
| GET FEATURES<br>BY LUN                       | D4h                 | 2  | -                       | -                   | -  | -                   | -   | Yes  | 3     |
| SET FEATURES BY<br>LUN                       | D5h                 | 2  | 4                       | -                   | -  | -                   | -   | Yes  | 4     |
| ZQ CALIBRATION<br>LONG                       | F9h                 | 1  | -                       | -                   | -  | -                   |   | Yes  |       |
| ZQ CALIBRATION<br>SHORT                      | D9h                 | 1  | -                       | -                   | -  | -                   |   | Yes  |       |
| SLC MODE<br>ENABLE                           | DAh                 | 0  | -                       | -                   | -  | -                   |   | Yes  |       |
| SLC MODE<br>DISABLE                          | DFh                 | 0  | -                       | -                   | -  | -                   |   | Yes  |       |
| Status Operations                            | 5                   |  |                         |                     |  |                     |   |  |       |
| READ STATUS                                  | 70h                 | 0  | -                       | -                   | -  | -                   | Yes   |  |       |
| FIXED ADDRESS<br>READ STATUS<br>ENHANCED     | 71h                 | 1  | -                       | -                   | -  | -                   | Yes   | Yes  |       |
| READ STATUS<br>ENHANCED                      | 78h                 | 3/4  | -                       | -                   | -  | -                   | Yes   | Yes  |       |
| Column Address (                             | Operations          |  |                         |                     |  |                     |   |  |       |
| Change Read<br>Column                        | 05h                 | 2  | -                       | E0h                 | -  | -                   |   | Yes  |       |
| CHANGE READ<br>COLUMN<br>ENHANCED<br>(ONFI)  | 06h                 | 5/6  | -                       | E0h                 | -  | -                   |   | Yes  |       |
| CHANGE READ<br>COLUMN<br>ENHANCED<br>(JEDEC) | 00h                 | 5/6  | -                       | 05h                 | 2  | E0h                 |   | Yes  |       |
| Change Write<br>Column                       | 85h                 | 2  | Optional                | -                   | -  | -                   |   | Yes  |       |



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|  |            | Number                         |               |                   | Number                         |          | Valid              | Valid             |       |
|--|------------|--------------------------------|---------------|-------------------|--------------------------------|----------|--------------------|-------------------|-------|
|  |            | of Valid                       | Dete          |                   | of Valid<br>Address            |          | While              | While<br>Other    |       |
|  | Command    | Address<br>Cycles <sup>9</sup> | Data<br>Input | Command           | Address<br>Cycles <sup>9</sup> | Command  | Selected<br>LUN Is | LUNs are          |       |
| Command  | Cycle #1   | #1                             | Cycles        | Cycle #2          | #2                             | Cycle #3 | Busy <sup>1</sup>  | Busy <sup>2</sup> | Notes |
| CHANGE ROW<br>ADDRESS                            | 85h        | 5/6                            | Optional      | 11h<br>(Optional) | -                              | -        |                    | Yes               | 5     |
| Read Operations                                  | <u> </u>   |                                | <u> </u>      |                   | L                              | <u> </u> | I                  | I                 |       |
| READ MODE  | 00h        | 0                              | -             | -                 | -                              | -        |                    | Yes               |       |
| READ PAGE  | 00h        | 5/6                            | -             | 30h               | -                              | -        |                    | Yes               | 6     |
| SNAP READ  | 00h        | 5/6                            | -             | 20h               | -                              | -        |                    | Yes               |       |
| READ PAGE MULI-<br>PLANE                         | 00h        | 5/6                            | -             | 32h               | -                              | -        |                    | Yes               |       |
| READ PAGE<br>CACHE<br>SEQUENTIAL                 | 31h        | 0                              | -             | -                 | -                              | -        |                    | Yes               | 7     |
| READ PAGE<br>CACHE RANDOM                        | 00h        | 5/6                            | -             | 31h               | -                              | -        |                    | Yes               | 6, 7  |
| READ PAGE<br>CACHE LAST                          | 3Fh        | 0                              | -             | -                 | -                              | -        |                    | Yes               | 7     |
| READ PAGE WITH<br>SOFT<br>INFORMATION            | 33h        | 5/6                            | -             | 30h               | -                              | -        |                    | Yes               |       |
| SOFT<br>INFORMATION<br>READOUT                   | 36h        | 0                              | -             |                   | -                              | -        |                    | Yes               | 10    |
| SINGLE BIT SOFT<br>BIT READ PAGE                 | 00h        | 5/6                            | -             | 34h               | -                              | -        |                    | Yes               |       |
| SINGLE BIT SOFT<br>BIT READ PAGE<br>CACHE RANDOM | 00h        | 5/6                            | -             | 38h               | -                              | -        |                    | Yes               |       |
| Program Operation                                | ons        |                                |               |                   |                                |          |                    |                   |       |
| PROGRAM PAGE                                     | 80h        | 5/6                            | Yes           | 10h               | -                              | -        |                    | Yes               |       |
| PROGRAM PAGE<br>MULTI-PLANE                      | 80h or 81h | 5/6                            | Yes           | 11h               | -                              | -        |                    | Yes               |       |
| PROGRAM PAGE<br>CACHE                            | 80h        | 5/6                            | Yes           | 15h               | -                              | -        |                    | Yes               | 8     |
| PROGRAM<br>SUSPEND                               | 84h        | 5/6                            | -             | -                 | -                              | -        | Yes                | Yes               |       |
| PROGRAM<br>RESUME                                | 13h        | 5/6                            | -             | -                 | -                              | -        |                    | Yes               |       |
| Erase Operations                                 |            |                                |               |                   |                                |          |                    |                   |       |
| ERASE BLOCK                                      | 60h        | 3/4                            | -             | D0h               | -                              | -        |                    | Yes               |       |
| ERASE BLOCK<br>MULTI-PLANE<br>(ONFI)             | 60h        | 3/4                            | -             | D1h               | -                              | -        |                    | Yes               |       |



## UT81NDQ512G8T

| Command                               | Command<br>Cycle #1 | Number<br>of Valid<br>Address<br>Cycles <sup>9</sup><br>#1 | Data<br>Input<br>Cycles | Command<br>Cycle #2 | Number<br>of Valid<br>Address<br>Cycles <sup>9</sup><br>#2 | Command<br>Cycle #3 | Valid<br>While<br>Selected<br>LUN Is<br>Busy <sup>1</sup> | Valid<br>While<br>Other<br>LUNs are<br>Busy <sup>2</sup> | Notes |
|---------------------------------------|---------------------|--|-------------------------|---------------------|--|---------------------|---|--|-------|
| ERASE BLOCK<br>MULTI-PLANE<br>(JEDEC) | 60h                 | 3/4  | -                       | 60h                 | 3  | D0h                 |   | Yes  |       |
| ERASE SUSPEND                         | 61h                 | 3/4  | -                       | -                   | -  | -                   | Yes   | Yes  |       |
| ERASE RESUME                          | D2h                 | -  | -                       | -                   | -  | -                   |   | Yes  |       |
| Copyback Operati                      | ons                 | <u> </u>   |                         |                     | <u> </u>   |                     |   |  |       |
| COPYBACK READ                         | 00h                 | 5/6  | -                       | 35h                 | -  | -                   |   | Yes  | 6     |
| Copyback<br>Program                   | 85h                 | 5/6  | Optional                | 10h                 | -  | -                   |   | Yes  |       |
| COPYBACK<br>PROGRAM MULTI-<br>PLANE   | 85h                 | 5/6  | Optional                | 11h                 | -  | -                   |   | Yes  |       |

- 1) Busy means RDY = 0.
- 2) These commands can be used for interleaved die (multi-LUN) operations.
- The READ ID (90h), GET FEATURES (EEh), and GET FEATUERS by LUN (D4h) commands output identical data on rising and falling DQS edges.
- 4) The SET FEATURES (EFh) and SET FEATURES by LUN (D5h) commands requires data transition prior to the rising edge of DQS, with identical data for the rising and falling edges.
- 5) Command cycle #2 of 11h is conditional. See the User Manual, CHANGE ROW ADDRESS (85h) for more details.
- 6) This command can be preceded by READ PAGE MULTI-PLANE (00h-32h) command to accommodate a maximum simultaneous multi-plane array operation.
- 7) Issuing a READ PAGE CACHE-series (31h, 00h-31h, 00h-32h, 3Fh) command when the array is busy (RDY = 1, ARDY = 0) is supported if the previous command was a READ PAGE (00h-30h) or READ PAGE CACHE-series command; otherwise, it is prohibited.
- 8) Issuing a PROGRAM PAGE CACHE (80h-15h) command when the array is busy (RDY = 1, ARDY = 0) is supported if the previous command was a PROGRAM PAGE CACHE (80h-15h) command; otherwise, it is prohibited.
- 9) Refer to Device and Array Organization section for details of when the additional address cycles is required.
- 10) Refer to the User Manual, Soft Data Read Operations section for details of how this command is used.



#### 8 Output Drive Impedance

Because NAND Flash is designed for use in systems that are typically point-to-point connections, an option to control the drive strength of the output buffers is provided. Drive strength should be selected based on the expected loading of the memory bus. The three supported settings for the output drivers for the Asynchronous, and NVDDR2 interfaces are: 25 ohms, 35 ohms, and 50 ohms. The two supported settings for the output drivers for the NV-DDR3 interface are: 35 ohms and 50 ohms.

The 35 ohms output drive strength setting is the power-on default value in the Asynchronous, and NV-DDR2 interfaces. The 35 ohms output drive strength setting is the power-on default value in the NV-DDR3 interface. The host can select a different drive strength setting using the SET FEATURES (EFh) or SET FEATURES by LUN (D5h) command.

The output impedance range from minimum to maximum covers process, voltage, and temperature variations. Devices are not guaranteed to be at the nominal line.

| Range   | Process         | Voltage | Temperature          |
|---------|-----------------|---------|----------------------|
| Minimum | Fast-Fast       | 1.95V   | T <sub>A</sub> (MIN) |
| Nominal | Typical-Typical | 1.8V    | +25°C                |
| Maximum | Slow-Slow       | 1.7V    | T <sub>A</sub> (MAX) |

#### Table 4: Output Drive Strength Conditions (Vccq=1.7-1.95V)

|                    | -       | • •                  |         | -       | • •     | -    |
|--------------------|---------|----------------------|---------|---------|---------|------|
| Output<br>Strength | Rpd/Rpu | Vout to Vssq         | Minimum | Nominal | Maximum | Unit |
| 25 ohms            | Rpd     | $V_{CCQ} \times 0.2$ | 11.4    | 25.0    | 44.0    | ohms |
|                    |         | $V_{CCQ} \times 0.5$ | 15.0    | 25.0    | 44.0    | ohms |
|                    |         | $V_{CCQ} 	imes 0.8$  | 15.0    | 25.0    | 61.0    | ohms |
|                    | Rpu     | $V_{CCQ} \times 0.2$ | 15.0    | 25.0    | 61.0    | ohms |
|                    |         | $V_{CCQ} \times 0.5$ | 15.0    | 25.0    | 44.0    | ohms |
|                    |         | $V_{CCQ} \times 0.8$ | 11.4    | 25.0    | 44.0    | ohms |
| 35 ohms            | Rpd     | $V_{CCQ} \times 0.2$ | 16.0    | 35.0    | 61.0    | ohms |
|                    |         | $V_{CCQ} \times 0.5$ | 21.0    | 35.0    | 61.0    | ohms |
|                    |         | $V_{CCQ} 	imes 0.8$  | 21.0    | 35.0    | 85.3    | ohms |
|                    | Rpu     | $V_{CCQ} \times 0.2$ | 21.0    | 35.0    | 85.3    | ohms |
|                    |         | $V_{CCQ} \times 0.5$ | 21.0    | 35.0    | 61.0    | ohms |
|                    |         | $V_{CCQ} 	imes 0.8$  | 16.0    | 35.0    | 61.0    | ohms |
| 50 ohms            | Rpd     | $V_{CCQ} \times 0.2$ | 24.0    | 50.0    | 87.0    | ohms |
|                    |         | $V_{CCQ} \times 0.5$ | 30.0    | 50.0    | 87.0    | ohms |
|                    |         | $V_{CCQ} \times 0.8$ | 30.0    | 50.0    | 122.0   | ohms |
|                    | Rpu     | $V_{CCQ} \times 0.2$ | 30.0    | 50.0    | 122.0   | ohms |
|                    |         | $V_{CCQ} \times 0.5$ | 30.0    | 50.0    | 87.0    | ohms |
|                    |         | $V_{CCQ} \times 0.8$ | 24.0    | 50.0    | 87.0    | ohms |

#### Table 5: Output Drive Strength Impedance Values Without ZQ Calibration ( $V_{CCQ} = 1.7-1.95V$ )



#### Table 6: Output Drive Strength Impedance Values With ZQ Calibration ( $V_{CCQ} = 1.7 - 1.95V$ )

| Output<br>Strength | Rpd/Rpu | Vout <b>to</b><br>Vssq     | Minimum | Nominal | Maximum | Unit                 | Note |
|--------------------|---------|----------------------------|---------|---------|---------|----------------------|------|
| 25 ohms            | Rpd     | $V_{CCQ} \times 0.2$       | 11.4    | 20.0    | 32.0    | ohms                 | 1    |
|                    |         | $V_{CCQ} \times 0.5$       | 16.3    | 25.0    | 33.7    | ohms                 |      |
|                    |         | $V_{CCQ} \times 0.8$       | 20.0    | 31.0    | 49.0    | ohms                 |      |
|                    | Rpu     | $V_{CCQ} \times 0.2$       | 20.0    | 31.0    | 49.0    | ohms                 |      |
|                    |         | $V_{CCQ} \times 0.5$       | 16.3    | 25.0    | 33.7    | ohms                 |      |
|                    |         | $V_{\text{CCQ}} 	imes 0.8$ | 11.4    | 20.0    | 32.0    | ohms                 |      |
| 35 ohms            | Rpd     | $V_{CCQ} \times 0.2$       | 0.57    | 1       | 1.15    | R <sub>zQ</sub> /8.5 |      |
|                    |         | $V_{CCQ} \times 0.5$       | 0.85    | 1       | 1.15    | Rzq/8.5              |      |
|                    |         | $V_{CCQ} \times 0.8$       | 0.85    | 1       | 1.47    | Rzq/8.5              |      |
|                    | Rpu     | $V_{CCQ} \times 0.2$       | 0.85    | 1       | 1.47    | Rzq/8.5              |      |
|                    |         | $V_{CCQ} \times 0.5$       | 0.85    | 1       | 1.15    | Rzq/8.5              |      |
|                    |         | $V_{CCQ} \times 0.8$       | 0.57    | 1       | 1.15    | Rzq/8.5              |      |
| 50 ohms            | Rpd     | $V_{CCQ} \times 0.2$       | 0.57    | 1       | 1.15    | R <sub>zQ</sub> /6   |      |
|                    |         | $V_{CCQ} \times 0.5$       | 0.85    | 1       | 1.15    | R <sub>zQ</sub> /6   |      |
|                    |         | $V_{CCQ} \times 0.8$       | 0.85    | 1       | 1.47    | R <sub>zQ</sub> /6   |      |
|                    | Rpu     | $V_{CCQ} \times 0.2$       | 0.85    | 1       | 1.47    | Rzq/6                |      |
|                    |         | $V_{\text{CCQ}} 	imes 0.5$ | 0.85    | 1       | 1.15    | R <sub>ZQ</sub> /6   |      |
|                    |         | $V_{CCQ} \times 0.8$       | 0.57    | 1       | 1.15    | Rzq/6                |      |

- 1) The 25 ohms drive strength does not support ZQ CALIBRATION operations. If ZQ CALIBRATION operations are used when the 25 ohms drive strength is selected, the default NAND drive strength settings are still used.
- 2) Tolerance limits assume RZQ of 300 ohms ±1% and are applicable after proper ZQ calibration has been performed at a stable temperature and voltage.
- 3) Refer to Output Driver Sensitivity if either the temperature or the voltage changes after calibration.
- 4) The minimum values are derated by 6% when the device operates between -40°C and 0°C.

| <b>Table 7: Output Drive Strength</b> | <b>Conditions (V</b> <sub>CCQ</sub> =1.14-1.26V) |
|---------------------------------------|--|
|---------------------------------------|--|

| Range   | Process         | Voltage | Temperature          |
|---------|-----------------|---------|----------------------|
| Minimum | Fast-Fast       | 1.26V   | T <sub>A</sub> (MIN) |
| Nominal | Typical-Typical | 1.2V    | +25°C                |
| Maximum | Slow-Slow       | 1.14V   | T <sub>A</sub> (MAX) |



#### Table 8: Output Drive Strength Impedance Values Without ZQ Calibration (V<sub>CCQ</sub> = 1.14–1.26V)

| Output<br>Strength | Rpd/Rpu | Vout <b>to</b><br>Vssq | Minimum | Nominal | Maximum | Unit |
|--------------------|---------|------------------------|---------|---------|---------|------|
| 35 ohms            | Rpd     | $V_{CCQ} \times 0.2$   | 16.0    | 35.0    | 61.0    | ohms |
|                    |         | $V_{CCQ} \times 0.5$   | 21.0    | 35.0    | 61.0    | ohms |
|                    |         | $V_{CCQ} \times 0.8$   | 21.0    | 35.0    | 85.3    | ohms |
|                    | Rpu     | $V_{CCQ} \times 0.2$   | 21.0    | 35.0    | 85.3    | ohms |
|                    |         | $V_{CCQ} \times 0.5$   | 21.0    | 35.0    | 61.0    | ohms |
|                    |         | $V_{CCQ} \times 0.8$   | 16.0    | 35.0    | 61.0    | ohms |
| 50 ohms            | Rpd     | $V_{CCQ} \times 0.2$   | 24.0    | 50.0    | 87.0    | ohms |
|                    |         | $V_{CCQ} \times 0.5$   | 30.0    | 50.0    | 87.0    | ohms |
|                    |         | $V_{CCQ} \times 0.8$   | 30.0    | 50.0    | 122.0   | ohms |
|                    | Rpu     | $V_{CCQ} \times 0.2$   | 30.0    | 50.0    | 122.0   | ohms |
|                    |         | $V_{CCQ} \times 0.5$   | 30.0    | 50.0    | 87.0    | ohms |
|                    |         | $V_{CCQ} \times 0.8$   | 24.0    | 50.0    | 87.0    | ohms |

#### Table 9: Output Drive Strength Impedance Values With ZQ Calibration (V<sub>CCQ</sub> = 1.14–1.26V)

| Output<br>Strength | Rpd/Rpu | V <sub>OUT</sub> to<br>V <sub>SSQ</sub> | Minimum | Nominal | Maximum | Unit                 |
|--------------------|---------|---|---------|---------|---------|----------------------|
| 35 ohms            | Rpd     | $V_{CCQ} \times 0.2$                    | 0.57    | 1       | 1.15    | Rzq/8.5              |
|                    |         | $V_{CCQ} \times 0.5$                    | 0.85    | 1       | 1.15    | Rzq/8.5              |
|                    |         | $V_{CCQ} \times 0.8$                    | 0.85    | 1       | 1.47    | Rzq/8.5              |
|                    | Rpu     | $V_{CCQ} \times 0.2$                    | 0.85    | 1       | 1.47    | R <sub>ZQ</sub> /8.5 |
|                    |         | $V_{CCQ} \times 0.5$                    | 0.85    | 1       | 1.15    | R <sub>ZQ</sub> /8.5 |
|                    |         | $V_{CCQ} \times 0.8$                    | 0.57    | 1       | 1.15    | Rzq/8.5              |
| 50 ohms            | Rpd     | $V_{CCQ} \times 0.2$                    | 0.57    | 1       | 1.15    | Rzq/6                |
|                    |         | $V_{CCQ} \times 0.5$                    | 0.85    | 1       | 1.15    | Rzq/6                |
|                    |         | $V_{CCQ} \times 0.8$                    | 0.85    | 1       | 1.47    | Rzq/6                |
|                    | Rpu     | $V_{CCQ} \times 0.2$                    | 0.85    | 1       | 1.47    | R <sub>zQ</sub> /6   |
|                    |         | $V_{CCQ} \times 0.5$                    | 0.85    | 1       | 1.15    | Rzq/6                |
|                    |         | $V_{CCQ} \times 0.8$                    | 0.57    | 1       | 1.15    | Rzq/6                |

#### Notes:

- 1) Tolerance limits assume RZQ of 300 ohms ±1% and are applicable after proper ZQ calibration has been performed at a stable temperature and voltage.
- 2) Refer to Output Driver Sensitivity if either the temperature or the voltage changes after calibration.
- 3) The minimum values are derated by 6% when the device operates between -40°C and 0°C.

If either the temperature or the voltage changes after the ZQ CALIBRATION operation, then output drive strength impedance tolerance limits can be expected to widen according to Table 10 and Table 11.





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#### Table 10: Output Drive Sensitivity With ZQ Calibration

| Output<br>Strength | Rpd/Rpu | V <sub>OUT</sub> to V <sub>SSQ</sub> | Minimum  | Maximum  | Unit                 |
|--------------------|---------|--------------------------------------|--|--|----------------------|
| 35 ohms            | Rpd     | $V_{CCQ} \times 0.2$                 | $0.57 - dR_{ON}dT \times \Delta T - dR_{ON}dV \times \Delta V$ | $1.15 + dR_{ON}dT \times \Delta T + dR_{ON}dV \times \Delta V$ | R <sub>ZQ</sub> /8.5 |
|                    |         | V <sub>CCQ</sub> × 0.5               | $0.85 - dR_{ON}dT \times \Delta T - dR_{ON}dV \times \Delta V$ | $1.15 + dR_{ON}dT \times \Delta T + dR_{ON}dV \times \Delta V$ | R <sub>ZQ</sub> /8.5 |
|                    |         | V <sub>CCQ</sub> × 0.8               | 0.85 – dRondT x ΔT–<br>dRondV x ΔV                             | $1.47 + dR_{ON}dT \times \Delta T + dR_{ON}dV \times \Delta V$ | R <sub>ZQ</sub> /8.5 |
|                    | Rpu     | V <sub>CCQ</sub> × 0.2               | $0.85 - dR_{ON}dT \times \Delta T - dR_{ON}dV \times \Delta V$ | $1.47 + dR_{ON}dT \times \Delta T + dR_{ON}dV \times \Delta V$ | R <sub>ZQ</sub> /8.5 |
|                    |         | V <sub>CCQ</sub> × 0.5               | $0.85 - dR_{ON}dT \times \Delta T - dR_{ON}dV \times \Delta V$ | $1.15 + dR_{ON}dT \times \Delta T + dR_{ON}dV \times \Delta V$ | Rzq/8.5              |
|                    |         | $V_{CCQ} \times 0.8$                 | $0.57 - dR_{ON}dT \times \Delta T - dR_{ON}dV \times \Delta V$ | $1.15 + dR_{ON}dT \times \Delta T + dR_{ON}dV \times \Delta V$ | R <sub>ZQ</sub> /8.5 |
| 50 ohms            | Rpd     | V <sub>CCQ</sub> × 0.2               | $0.57 - dR_{ON}dT \times \Delta T - dR_{ON}dV \times \Delta V$ | $1.15 + dR_{ON}dT \times \Delta T + dR_{ON}dV \times \Delta V$ | Rzq/6                |
|                    |         | V <sub>CCQ</sub> × 0.5               | $0.85 - dR_{ON}dT \times \Delta T - dR_{ON}dV \times \Delta V$ | $1.15 + dR_{ON}dT \times \Delta T + dR_{ON}dV \times \Delta V$ | Rzq/6                |
|                    |         | $V_{CCQ} \times 0.8$                 | $0.85 - dR_{ON}dT \times \Delta T - dR_{ON}dV \times \Delta V$ | $1.47 + dR_{ON}dT \times \Delta T + dR_{ON}dV \times \Delta V$ | R <sub>ZQ</sub> /6   |
|                    | Rpu     | V <sub>CCQ</sub> × 0.2               | $0.85 - dR_{ON}dT \times \Delta T - dR_{ON}dV \times \Delta V$ | $1.47 + dR_{ON}dT \times \Delta T + dR_{ON}dV \times \Delta V$ | Rzq/6                |
|                    |         | V <sub>CCQ</sub> × 0.5               | $0.85 - dR_{ON}dT \times \Delta T - dR_{ON}dV \times \Delta V$ | $1.15 + dR_{ON}dT \times \Delta T + dR_{ON}dV \times \Delta V$ | Rzq/6                |
|                    |         | $V_{CCQ} \times 0.8$                 | $0.57 - dR_{ON}dT \times \Delta T - dR_{ON}dV \times \Delta V$ | $1.15 + dR_{ON}dT \times \Delta T + dR_{ON}dV \times \Delta V$ | R <sub>ZQ</sub> /6   |

#### Table 11: Output Driver Voltage and Temperature Sensitivity With ZQ Calibration

| Change | Minimum | Maximum | Unit |
|--------|---------|---------|------|
| dRondT | 0       | 0.5     | %/°C |
| dRondV | 0       | 0.2     | %/mV |

#### Table 12: Output Driver Voltage and Temperature Sensitivity With ZQ Calibration

| Drive Strength | Minimum | Maximum | Unit | Notes |
|----------------|---------|---------|------|-------|
| 25 ohms        | 0       | 4.4     | ohms | 1, 2  |
| 35 ohms        | 0       | 6.2     | ohms | 1, 2  |
| 50 ohms        | 0       | 8.8     | ohms | 1, 2  |

- 1) Mismatch is the absolute value between pull-up and pull-down impedances. Both are measured at the same temperature and voltage.
- 2) Test conditions:  $V_{CCQ} = V_{CCQ}$  (MIN),  $V_{OUT} = V_{CCQ} \times 0.5$ ,  $T_{OPER}$ .



#### Table 13: Pull-Up and Pull-Down Output Impedance Mismatch With ZQ Calibration for NV-DDR2

| Drive Strength | Minimum | Maximum | Unit | Notes   |
|----------------|---------|---------|------|---------|
| 25 ohms        | 0       | 3.75    | ohms | 1, 2, 3 |
| 35 ohms        | 0       | 5.25    | ohms | 2, 3    |
| 50 ohms        | 0       | 7.5     | ohms | 2, 3    |

Notes:

- 1) The 25 ohms drive strength does not support ZQ CALIBRATION operations. If ZQ CALIBRATION operations are used when the 25 ohms drive strength is selected, the default NAND drive strength settings are still used.
- 2) Mismatch is the absolute value between pull-up and pull-down impedances. Both are measured at the same temperature and voltage.
- 3) Test conditions:  $V_{CCQ} = V_{CCQ}$  (MIN),  $V_{OUT} = V_{CCQ} \times 0.5$ ,  $T_{OPER}$ .

#### Table 14: Pull-Up and Pull-Down Output Impedance Mismatch Without ZQ calibration for NV-DDR3

| Drive Strength | Minimum | Maximum | Unit | Notes |
|----------------|---------|---------|------|-------|
| 35 ohms        | 0       | 6.2     | ohms | 1, 2  |
| 50 ohms        | 0       | 8.8     | ohms | 1, 2  |

Notes:

- 1) Mismatch is the absolute value between pull-up and pull-down impedances. Both are measured at the same temperature and voltage.
- 2) Test conditions:  $V_{CCQ} = V_{CCQ}$  (MIN),  $V_{OUT} = V_{CCQ} \times 0.5$ ,  $T_{OPER}$ .

#### Table 15: Pull-Up and Pull-Down Output Impedance Mismatch With ZQ calibration for NV-DDR3

| Drive Strength | Minimum | Maximum | Unit | Notes |
|----------------|---------|---------|------|-------|
| 35 ohms        | 0       | 5.25    | ohms | 1, 2  |
| 50 ohms        | 0       | 7.5     | ohms | 1, 2  |

Notes:

- 1) Mismatch is the absolute value between pull-up and pull-down impedances. Both are measured at the same temperature and voltage.
- 2) Test conditions:  $V_{CCQ} = V_{CCQ}$  (MIN),  $V_{OUT} = V_{CCQ} \times 0.5$ ,  $T_{OPER}$ .

DATASHEET



#### 9 AC overshoot/undershoot specifications

The supported AC overshoot and undershoot area depends on the timing mode selected by the host. NAND devices may have different maximum amplitude requirements for overshoot and undershoot than the host controller. If the host controller has more stringent requirements, termination or other means of reducing overshoot or undershoot may be required beyond the NAND requirements.

| Table 16: Asynchronous Over | rshoot/Undershoot Parameters |
|-----------------------------|------------------------------|
|-----------------------------|------------------------------|

|   |   | Timing Mode |   |   |   |   |      |
|---|---|-------------|---|---|---|---|------|
| Parameter   | 0 | 1           | 2 | 3 | 4 | 5 | Unit |
| Maximum peak amplitude provided for overshoot area  | 1 | 1           | 1 | 1 | 1 | 1 | V    |
| Maximum peak amplitude provided for undershoot area | 1 | 1           | 1 | 1 | 1 | 1 | V    |
| Maximum overshoot area above V <sub>CCQ</sub>       | 3 | 3           | 3 | 3 | 3 | 3 | V-ns |
| Maximum undershoot area below V <sub>SSQ</sub>      | 3 | 3           | 3 | 3 | 3 | 3 | V-ns |

#### Table 17: NV-DDR2 Overshoot/Undershoot Parameters

|   |                   |   | Timing Mode |      |     |     |     |     |      |      |
|---|-------------------|---|-------------|------|-----|-----|-----|-----|------|------|
| Parameter   | Signals           | 0 | 1           | 2    | 3   | 4   | 5   | 6   | 7    | Unit |
| Maximum peak amplitude provided for overshoot area  | -                 | 1 | 1           | 1    | 1   | 1   | 1   | 1   | 1    | V    |
| Maximum peak amplitude provided for undershoot area | -                 | 1 | 1           | 1    | 1   | 1   | 1   | 1   | 1    | V    |
| Maximum overshoot area                              | DQ[7:0], DQS, RE# | 3 | 3           | 2.25 | 1.8 | 1.5 | 1.1 | 0.9 | 0.75 | V-ns |
| above Vccq  | ALE, CLE, WE#     | 3 | 3           | 3    | 3   | 3   | 3   | 3   | 3    |      |
| Maximum undershoot area                             | DQ[7:0], DQS, RE# | 3 | 3           | 2.25 | 1.8 | 1.5 | 1.1 | 0.9 | 0.75 | V-ns |
| below V <sub>SSQ</sub>                              | ALE, CLE, WE#     | 3 | 3           | 3    | 3   | 3   | 3   | 3   | 3    |      |

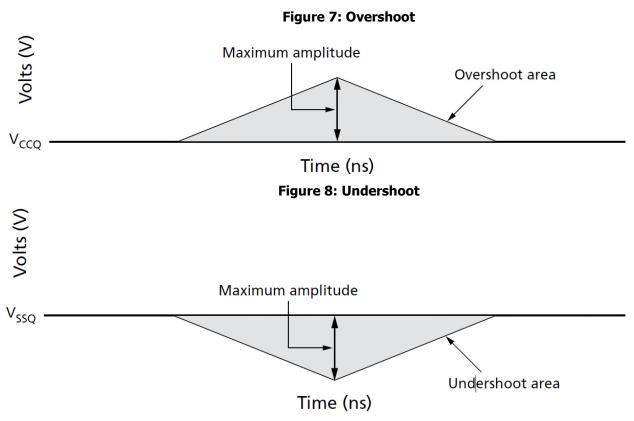
#### Table 18: NV-DDR3 Overshoot/Undershoot Parameters

|   |                      |     |     |      |     | Tir | ning | Mode |      |      |      |      |      |
|---|----------------------|-----|-----|------|-----|-----|------|------|------|------|------|------|------|
| Parameter   | Signals              | 0   | 1   | 2    | 3   | 4   | 5    | 6    | 7    | 8    | 9    | 10   | Unit |
| Maximum peak<br>amplitude provided<br>for overshoot area  | -                    | 0.8 | 0.8 | 0.8  | 0.8 | 0.8 | 0.8  | 0.8  | 0.8  | 0.8  | 0.8  | 0.8  | V    |
| Maximum peak<br>amplitude provided<br>for undershoot area | -                    | 0.8 | 0.8 | 0.8  | 0.8 | 0.8 | 0.8  | 0.8  | 0.8  | 0.8  | 0.8  | 0.8  | V    |
| Maximum overshoot<br>area above V <sub>CCQ</sub>          | DQ[7:0],<br>DQS, RE# | 3   | 3   | 2.25 | 1.8 | 1.5 | 1.1  | 0.9  | 0.75 | 0.56 | 0.45 | 0.38 | V-ns |
|   | ALE, CLE,<br>WE#     | 3   | 3   | 3    | 3   | 3   | 3    | 3    | 3    | 3    | 3    | 3    |      |
| Maximum undershoot<br>area below V <sub>SSQ</sub>         | DQ[7:0],<br>DQS, RE# | 3   | 3   | 2.25 | 1.8 | 1.5 | 1.1  | 0.9  | 0.75 | 0.56 | 0.45 | 0.38 | V-ns |
|   | ALE, CLE,<br>WE#     | 3   | 3   | 3    | 3   | 3   | 3    | 3    | 3    | 3    | 3    | 3    |      |









#### 10 Input slew rate

Though all AC timing parameters are tested with a nominal input slew rate of 1 V/ns, it is possible to run the device at a slower slew rate. The input slew rates shown below are sampled, and not 100% tested. When using slew rates slower than the minimum values, timing must be derated by the host.

| Parameter                 | Value  |
|---------------------------|--|
| Rising edge for<br>setups | The last crossing of $V_{\text{REFQ(DC)}}$ and the first crossing of $V_{\text{IH(AC)}}$ min for NV-DDR2 and NV-DDR3 |
| Falling edge for setups   | The last crossing of $V_{\text{REFQ(DC)}}$ and the first crossing of $V_{\text{IL(AC)}}$ max for NV-DDR2 and NV-DDR3 |
| Rising edge for holds     | The first crossing of $V_{\rm IL(AC)}$ max and the first crossing of $V_{\rm REFQ(DC)}$ for NV-DDR2 and NV-DDR3      |
| Falling edge for<br>holds | The first crossing of $V_{\rm IH(AC)}$ min and the first crossing of $V_{\rm REFQ(DC)}$ for NV-DDR2 and NV-DDR3      |
| Temperature range         | T <sub>A</sub>   |

Table 19: Test Conditions for Input Slew Rate

The minimum and maximum input slew rate requirements that the device shall comply with below for NV-DDR2 and NV-DDR3 operations. If the input slew rate falls below the minimum value, then derating shall be applied.



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|                       |              | •            |      |
|-----------------------|--------------|--------------|------|
| Description           | Single Ended | Differential | Unit |
| Input slew rate (min) | 1.0          | 2.0          | V/ns |
| Input slew rate (max) | 4.5          | 9.0          | V/ns |

#### Table 20: NV-DDR2/NV-DDR3 Maximum and Minimum Input Slew Rate

For DQ signals when used for input, the total data setup time (<sup>t</sup>DS) and data hold time (<sup>t</sup>DH) required is calculated by adding a derating value to the <sup>t</sup>DS and <sup>t</sup>DH values indicated for the timing mode. To calculate the total data setup time, <sup>t</sup>DS is incremented by the appropriate  $\Delta$ set derating value. To calculate the total data hold time, <sup>t</sup>DH is incremented by the appropriate  $\Delta$ hold derating value. Table 21 and Table 23 provides the derating values when single-ended DQS is used. Table 22 and Table 24 provides the derating values when differential DQS (DQS\_t/DQS\_c) is used.

The setup nominal slew rate for a rising signal is defined as the slew rate between the last crossing of  $V_{REFQ(DC)}$  and the first crossing of  $V_{IH(AC)}$  min. The setup nominal slew rate for a falling signal is defined as the slew rate between the last crossing of  $V_{REFQ(DC)}$  and the first crossing of  $V_{IL(AC)}$  max. If the actual signal is always earlier than the nominal slew rate line between the shaded ' $V_{REFQ(DC)}$  to AC region', then the derating value uses the nominal slew rate shown in Figure 9. If the actual signal is later than the nominal slew rate line anywhere between shaded ' $V_{REFQ(DC)}$  to AC region', then the derating value uses the clevel to the DC region', then the derating value uses the slew rate of a tangent line to the actual signal from the AC level to the DC level shown in Figure 10.

The hold nominal slew rate for a rising signal is defined as the slew rate between the first crossing of  $V_{IL(DC)}$  max and the first crossing of  $V_{REFQ(DC)}$ . The hold nominal slew rate for a falling signal is defined as the slew rate between the first crossing of  $V_{IH(DC)}$  min and the first crossing of  $V_{REFQ(DC)}$ . If the actual signal is always later than the nominal slew rate line between shaded 'DC to  $V_{REFQ(DC)}$  region', then the derating value uses the nominal slew rate shown in Figure 11. If the actual signal is earlier than the nominal slew rate line anywhere between the shaded 'DC to  $V_{REFQ(DC)}$  region', then the derating value uses the slew rate of a tangent line to the actual signal from the DC level to the  $V_{REFQ(DC)}$  level shown in Figure 12.

If the tangent line is used for derating, the setup and hold values shall be derated from where the tangent line crosses  $V_{REFQ(DC)}$ , not the actual signal (refer to Figure 10 and Figure 12).

For slew rates not explicitly listed in Table 21 and Table 22, the derating values should be obtained by linear interpolation. These values are typically not subject to production test; the values are verified by design and characterization.

|              |                 | $\Delta^{t}DS, \Delta^{t}DH \text{ Derating (ps)}$ $V_{IH(AC)} / V_{IL(AC)} = V_{REF} + / - 250mV , V_{IH(DC)} / V_{IL(DC)} = V_{REF} + / - 125mV$ |  |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |      |
|--------------|-----------------|--|--|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|------|
| DQ           |                 | DQS Slew Rate  |  |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |      |
| slew<br>rate | 2 V,            | /ns  | s 1.5V/ns 1 V/ns 0.9V/ns 0.8V/ns 0.7V/ns 0.6V/ns 0.5V/ns 0.4V/ns 0.3V/ns |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |      |
| V/ns         | <sup>t</sup> DH | <sup>t</sup> DH  | <sup>t</sup> DH  | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | Unit |
| 2            | 0               | 0  | 0  | 0               | 0               | 0               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 1.5          | 0               | 0  | 0  | 0               | 0               | 0               | 14              | 0               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 1            | 0               | 0  | 0  | 0               | 0               | 0               | 14              | 0               | 31              | 0               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 0.9          | -               | -  | 14   | 0               | 14              | 0               | 28              | 0               | 45              | 0               | 67              | 0               | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 0.8          | -               | -  | -  | -               | 31              | 0               | 45              | 0               | 63              | 0               | 85              | 0               | 115             | 0               | -               | -               | -               | -               | -               | -               | ps   |
| 0.7          | -               | -  | -  | -               | -               | -               | 67              | 0               | 85              | 0               | 107             | 0               | 137             | 0               | 179             | 0               | -               | -               | -               | -               | ps   |
| 0.6          | -               | -  | -  | -               | -               | -               | -               | -               | 115             | 0               | 137             | 0               | 167             | 0               | 208             | 0               | 271             | 0               | -               | -               | ps   |
| 0.5          | -               | -  | -  | -               | -               | -               | -               | -               | -               | -               | 179             | 0               | 208             | 0               | 250             | 0               | 313             | 0               | 418             | 0               | ps   |
| 0.4          | -               | -  | -  | -               | -               | -               | -               | -               | -               | -               | -               | -               | 271             | 0               | 313             | 0               | 375             | 0               | 480             | 0               | ps   |
| 0.3          | -               | -  | -  | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | 418             | 0               | 480             | 0               | 594             | 0               | ps   |

#### Table 21: Input Slew Rate derating for NV-DDR2 single-ended (V<sub>CCQ</sub> = 1.7–1.95V)

**Note**: Shaded area indicates the slew rate combinations not supported.



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|         |                 |  |                 |                 |                 |                 | Atos            |  | oratir          |                 | <b>`</b>        |                 |                 |                 |                 |                 |      |
|---------|-----------------|--|-----------------|-----------------|-----------------|-----------------|-----------------|--|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|------|
|         |                 | $\Delta^{t}DS$ , $\Delta^{t}DH$ Derating (ps)<br>V <sub>IH(AC)</sub> / V <sub>IL(AC)</sub> = V <sub>REF</sub> + / - 250mV , V <sub>IH(DC)</sub> / V <sub>IL(DC)</sub> = V <sub>REF</sub> + / - 125mV |                 |                 |                 |                 |                 |  |                 |                 |                 |                 |                 |                 |                 |                 |      |
|         |                 | $V_{IH(AC)} / V_{IL(AC)} - V_{REF} + / 230110 / V_{IL(DC)} / V_{IL(DC)} - V_{REF} + / 230110 / V_{IL(DC)}$<br>DQS_t/DQS_c Slew Rate  |                 |                 |                 |                 |                 |  |                 |                 |                 |                 |                 |                 |                 |                 |      |
| DQ slew | 2 1/            | /ns  | 101             | V/ns            | 161             | V/ns            |                 | ////////////////////////////////////// | _               | V/ns            |                 | /ns             | 0 0 1           | V/ns            | 0.61            | //ns            |      |
| rate    |                 | -  |                 | -               |                 | -               |                 | -                                      |                 | -               |                 | -               |                 | -               |                 | -               |      |
| V/ns    | <sup>t</sup> DH | <sup>t</sup> DH  | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH                        | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | Unit |
| 2       | 0               | 0  | -               | -               | -               | -               | -               | -                                      | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 1.5     | 0               | 0  | 7               | 7               | -               | -               | -               | -                                      | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 1       | 0               | 0  | 7               | 7               | 16              | 16              | -               | -                                      | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 0.9     | 14              | 14   | 21              | 21              | 30              | 30              | 41              | 41                                     | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 0.8     | 31              | 31   | 38              | 38              | 47              | 47              | 58              | 58                                     | 73              | 73              | -               | -               | -               | -               | -               | -               | ps   |
| 0.7     | -               | -  | 61              | 61              | 69              | 69              | 80              | 80                                     | 90              | 90              | 116             | 116             | -               | -               | -               | -               | ps   |
| 0.6     | -               | -  | -               | -               | 99              | 99              | 100             | 100                                    | 100             | 100             | 100             | 100             | 100             | 100             | -               | -               | ps   |
| 0.5     | -               | -  | -               | -               | -               | -               | 150             | 150                                    | 150             | 150             | 150             | 150             | 150             | 150             | 150             | 150             | ps   |
| 0.4     | -               | -  | -               | -               | -               | -               | -               | -                                      | 200             | 200             | 200             | 200             | 200             | 200             | 200             | 200             | ps   |
| 0.3     | -               | -  | -               | -               | -               | -               | -               | -                                      | -               | -               | 225             | 225             | 225             | 225             | 225             | 225             | ps   |

Note: Shaded area indicates the slew rate combinations not supported.

#### Table 23: Input Slew Rate derating for NV-DDR3 single-ended ( $V_{CCQ} = 1.14-1.26V$ )

|            |                 | $\Delta^{t}DS, \Delta^{t}DH \text{ Derating (ps)}$ $V_{IH(AC)} / V_{IL(AC)} = V_{REF} + / - 150mV, V_{IH(DC)} / V_{IL(DC)} = V_{REF} + / - 100mV$   |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |      |
|------------|-----------------|---|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|------|
| DQ<br>slew |                 |   |                 |                 |                 |                 |                 |                 |                 |                 | ew Rat          |                 |                 |                 |                 |                 |                 |                 |                 |                 |      |
| rate       | 2 V             | V/ns         1.5V/ns         1 V/ns         0.9V/ns         0.8V/ns         0.7V/ns         0.6V/ns         0.5V/ns         0.4V/ns         0.3V/ns |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |      |
| V/ns       | <sup>t</sup> DH | <sup>t</sup> DH   | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | Unit |
| 2          | 0               | 0   | 0               | 0               | 0               | 0               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 1.5        | 0               | 0   | 0               | 0               | 0               | 0               | 11              | 0               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 1          | 0               | 0   | 0               | 0               | 0               | 0               | 11              | 0               | 25              | 0               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 0.9        | -               | -   | 0               | 0               | 11              | 0               | 22              | 0               | 36              | 0               | 54              | 0               | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 0.8        | -               | -   | -               | -               | 25              | 0               | 39              | 0               | 50              | 0               | 68              | 0               | 92              | 0               | -               | -               | -               | -               | -               | -               | ps   |
| 0.7        | -               | -   | -               | -               | -               | -               | 54              | 0               | 68              | 0               | 86              | 0               | 110             | 0               | 143             | 0               | -               | -               | -               | -               | ps   |
| 0.6        | -               | -   | -               | -               | -               | -               | -               | -               | 92              | 0               | 110             | 0               | 133             | 0               | 167             | 0               | 217             | 0               | -               | -               | ps   |
| 0.5        | -               | -   | -               | -               | -               | -               | -               | -               | -               | -               | 143             | 0               | 167             | 0               | 200             | 0               | 250             | 0               | 333             | 0               | ps   |
| 0.4        | -               | -   | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | 217             | 0               | 250             | 0               | 300             | 0               | 383             | 0               | ps   |
| 0.3        | -               | -   | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | 333             | 0               | 383             | 0               | 467             | 0               | ps   |

Note: Shaded area indicates the slew rate combinations not supported.



|                 |                 | $\Delta^{t}DS, \Delta^{t}DH \text{ Derating (ps)}$ $V_{IH(AC)} / V_{IL(AC)} = V_{REF} + / - 250mV, V_{IH(DC)} / V_{IL(DC)} = V_{REF} + / - 125mV$           |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |      |
|-----------------|-----------------|---|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|------|
| DQ slew<br>rate | 2 V             | DQS_t/DQS_c Slew Rate           2 V/ns         1.8 V/ns         1.6 V/ns         1.4 V/ns         1.2 V/ns         1 V/ns         0.8 V/ns         0.6 V/ns |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |                 |      |
| V/ns            | <sup>t</sup> DH | <sup>t</sup> DH   | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | <sup>t</sup> DH | Unit |
| 2               | 0               | 0   | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 1.5             | 0               | 0   | 6               | 6               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 1               | 0               | 0   | 6               | 6               | 13              | 13              | -               | -               | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 0.9             | 11              | 11  | 17              | 17              | 24              | 24              | 33              | 33              | -               | -               | -               | -               | -               | -               | -               | -               | ps   |
| 0.8             | 25              | 25  | 31              | 31              | 38              | 38              | 46              | 46              | 58              | 58              | -               | -               | -               | -               | -               | -               | ps   |
| 0.7             | -               | -   | 48              | 48              | 55              | 55              | 64              | 64              | 75              | 75              | 75              | 75              | -               | -               | -               | -               | ps   |
| 0.6             | -               | -   | -               | -               | 79              | 79              | 88              | 88              | 100             | 100             | 100             | 100             | 100             | 100             | -               | -               | ps   |
| 0.5             | -               | -   | -               | -               | -               | -               | 121             | 121             | 125             | 125             | 125             | 125             | 125             | 125             | 125             | 125             | ps   |
| 0.4             | -               | -   | -               | -               | -               | -               | -               | -               | 150             | 150             | 150             | 150             | 150             | 150             | 150             | 150             | ps   |
| 0.3             | -               | -   | -               | -               | -               | -               | -               | -               | -               | -               | 175             | 175             | 175             | 175             | 175             | 175             | ps   |

Note: Shaded area indicates the slew rate combinations not supported.

#### Figure 9: Nominal Slew Rate for Data Setup Time (<sup>t</sup>DS), NV-DDR2/NV-DDR3 only

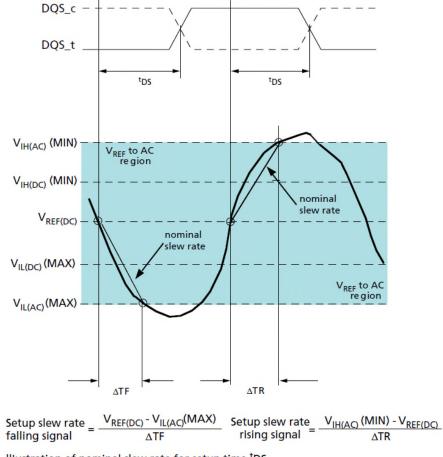


Illustration of nominal slew rate for setup time <sup>t</sup>DS

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#### Figure 10: Tangent Line for Data Setup Time (<sup>t</sup>DS), NV-DDR2/NV-DDR3 only

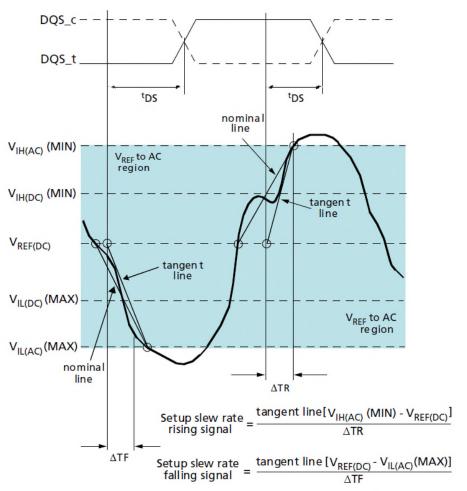


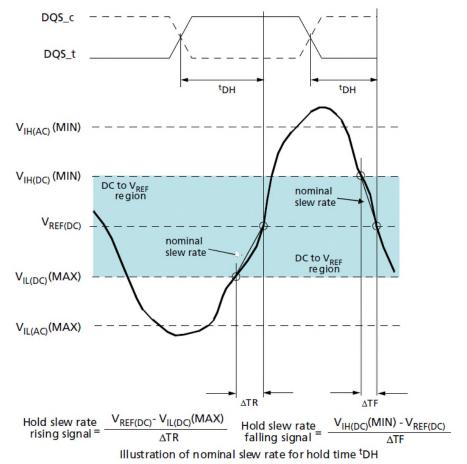
Illustration of tangent line for setup time <sup>t</sup>DS



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#### Figure 11: Nominal Slew Rate for Data Hold Time (<sup>t</sup>DH), NV-DDR2/NV-DDR3 only



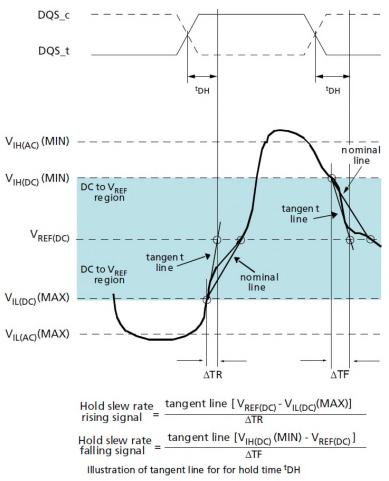


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#### Figure 12: Tangent Line for Data Hold Time (<sup>t</sup>DH), NV-DDR2/NV-DDR3 only



#### 11 Output slew rate

The output slew rate is tested using the following setup with only one die per DQ channel.

| Parameter   | Asynchronous<br>Interface <sup>1</sup> | NV-DDR2/NV-DDR3<br>Single-Ended <sup>1, 2</sup> | NV-DDR2/NV-DDR3<br>Differential <sup>1, 2</sup> |
|---|--|---|---|
| Vol(DC)   | 0.4 × Vccq                             | -   | -   |
| Voh(dc)   | 0.6 × Vccq                             | -   | _   |
| VOL(AC) <sup>3</sup>                                  | 0.3 × Vccq                             | Vπ - (Vccq × 0.10)                              | _   |
| VOH(AC) <sup>3</sup>                                  | 0.7 × Vccq                             | VTT + (Vccq × 0.10)                             | -   |
| Voldiff(AC)   | _                                      | -   | -0.2 × Vccq                                     |
| VOHdiff(AC)   | _                                      | -   | 0.2 × Vccq                                      |
| Rising edge ( <sup>t</sup> RISE)                      | Vol(dc) to Voh(ac)                     | VOL(AC) to VOH(AC)                              | -   |
| Falling edge ( <sup>t</sup> FALL)                     | Voh(dc) to Vol(ac)                     | Voh(ac) to Vol(ac)                              | _   |
| Differential rising edge<br>( <sup>t</sup> RISEdiff)  | -                                      | -   | Voldiff(AC) to Vohdiff(AC)                      |
| Differential falling edge<br>( <sup>t</sup> FALLdiff) | -                                      | -   | VOHdiff(AC) to VOLdiff(AC)                      |



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| Parameter                          | Asynchronous<br>Interface <sup>1</sup> | NV-DDR2/NV-DDR3<br>Single-Ended <sup>1, 2</sup> | NV-DDR2/NV-DDR3<br>Differential <sup>1, 2</sup>    |
|------------------------------------|--|---|--|
| Output slew rate rising edge       | [VOH(AC) - VOL(DC)]/ <sup>t</sup> RISE | [VOH(AC) - VOL(AC)]/ <sup>t</sup> RISE          | [VOHdiff(AC) - VOLdiff(AC)]/ <sup>t</sup> RISEdiff |
| Output slew rate falling edge      | [Voh(dc) - Vol(ac)]/ <sup>t</sup> FALL | [Voh(ac) - Vol(ac)]/ <sup>t</sup> FALL          | [VOHdiff(AC) - VOLdiff(AC)]/ <sup>t</sup> FALLdiff |
| Output reference load <sup>3</sup> |  | 5pf to Vss                                      |  |
| Temperature range                  |  | T <sub>A</sub>                                  |  |

#### Notes:

- 1) 1.8V  $V_{CCQ}$  is required for Asynchronous and NV-DDR2 operations.
- 2) 1.2V  $V_{CCQ}$  is required for NV-DDR3 operations.
- 3)  $V_{TT}$  is 0.5 x  $V_{CCQ}$ .

#### Table 25: Output Slew Rate for Single-Ended Asynchronous, or NV-DDR2 ( $V_{CCQ} = 1.7-1.95V$ ) WithoutZQ Calibration

| Output Drive Strength | Min  | Max | Unit |
|-----------------------|------|-----|------|
| 25 ohms               | 0.85 | 5   | V/ns |
| 35 ohms               | 0.75 | 4   | V/ns |
| 50 ohms               | 0.6  | 4   | V/ns |

#### Table 26: Output Slew Rate for Differential NV-DDR2 (V<sub>CCQ</sub> = 1.7–1.95V) Without ZQ Calibration

| Output Drive Strength | Min | Max  | Unit |
|-----------------------|-----|------|------|
| 25 ohms               | 1.7 | 10.0 | V/ns |
| 35 ohms               | 1.5 | 8.0  | V/ns |
| 50 ohms               | 1.2 | 8.0  | V/ns |

#### Table 27: Output Slew Rate for Differential NV-DDR2 (Vccq = 1.7–1.95V) With ZQ Calibration

| Output Drive Strength | Min  | Max  | Unit |
|-----------------------|------|------|------|
| 25 ohms               | 2.4  | 10.0 | V/ns |
| 35 ohms               | 2.16 | 8.0  | V/ns |
| 50 ohms               | 1.8  | 7.0  | V/ns |

#### Table 28: Output Slew Rate Matching Ratio for NV-DDR2/NV-DDR3 Without ZQ Calibration

| Drive Strength   | Min | Max |
|--|-----|-----|
| Output slew rate matching ratio (pull-up to pull-down) | 0.7 | 1.4 |

- 1) The output slew rate mismatch is determined by the ratio of fast slew rate and slow slew rate. If the rising edge is faster than the falling edge, then divide the rising slew rate by the falling slew rate. If the falling edge is faster than the rising edge, then divide the falling slew rate by the rising slew rate.
- 2) The output slew rate mismatch is verified by design and characterization; it may not be subject to production testing.



#### Table 29: Output Slew Rate for Single-Ended NV-DDR3 (V<sub>CCQ</sub> = 1.14–1.26V) With ZQ Calibration

| Output Drive Strength | Min  | Max | Unit |
|-----------------------|------|-----|------|
| 35 ohms               | 0.72 | 4   | V/ns |
| 50 ohms               | 0.6  | 3.5 | V/ns |

#### Table 30: Output Slew Rate for Differential NV-DDR3 (V<sub>CCQ</sub> = 1.14–1.26V) With ZQ Calibration

| Output Drive Strength | Min  | Мах | Unit |
|-----------------------|------|-----|------|
| 35 ohms               | 1.44 | 8.0 | V/ns |
| 50 ohms               | 1.2  | 7.0 | V/ns |

Table 31: Output Slew Rate Matching Ratio for NV-DDR2/NV-DDR3 Without ZQ Calibration

| Drive Strength   | Min | Max |
|--|-----|-----|
| Output slew rate matching ratio (pull-up to pull-down) | 0.7 | 1.3 |

#### Notes:

1) The output slew rate mismatch is determined by the ratio of fast slew rate and slow slew rate. If the rising edge is faster than the falling edge, then divide the rising slew rate by the falling slew rate. If the falling edge is faster than the rising edge, then divide the falling slew rate by the rising slew rate.

2) The output slew rate mismatch is verified by design and characterization; It may not be subject to production testing.

Slew rates are measured under normal SSO conditions with a half of the DQ signals per data byte driving HIGH and a half of the DQ signals per data byte driving LOW. The output slew rate is measured per individual DQ signal.



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#### **12 Electrical specifications**

Stresses greater than those listed can cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not guaranteed. Exposure to absolute maximum rating conditions for extended periods can affect reliability.

#### 12.1 Absolute Maximum DC Ratings<sup>(1,2)</sup>

| Parameter   |                                 | Symbol           | Min <sup>1</sup> | Max <sup>1</sup> | Unit |
|---|---------------------------------|------------------|------------------|------------------|------|
| $V_{CC}$ =3.3V and $V_{CCQ}$ =1.8V nominal        | V <sub>cc</sub> supply voltage  | V <sub>CC</sub>  | -0.6             | 4.6              | V    |
|   | Voltage Input                   | V <sub>IN</sub>  | -0.2             | 2.4              | V    |
|   | V <sub>CCQ</sub> supply voltage | V <sub>CCQ</sub> | -0.2             | 2.4              | V    |
| $V_{CC}$ =3.3V and $V_{CCQ}$ =1.2V                | V <sub>cc</sub> supply voltage  | Vcc              | -0.6             | 4.6              | V    |
| nominal   | Voltage Input                   | $V_{IN}$         | -0.2             | 1.5              | V    |
|   | V <sub>CCQ</sub> supply voltage | V <sub>CCQ</sub> | -0.2             | 1.5              | V    |
| V <sub>PP</sub> supply voltage                    |                                 | V <sub>PP</sub>  | -0.6             | 16.0             | V    |
| V <sub>REFQ</sub> supply voltage                  |                                 | $V_{REFQ}$       | -0.2             | 2.4              | V    |
| Storage temperature                               |                                 | T <sub>STG</sub> | -65              | +150             | °C   |
| Maximum Junction temperature                      |                                 | $T_{J max}$      |                  | 125              | °C   |
| Thermal impedance – Junction to Case <sup>3</sup> |                                 | Θις              |                  | 2.68             | °C/W |
| Maximum Power Dissipation                         | n Allowed⁴                      | P <sub>d</sub>   |                  | 14.9             | W    |

- 1. Stresses outside the listed absolute maximum ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond limits indicated in the operational sections of this specification are not recommended. Exposure to absolute maximum rating conditions for extended periods may affect device reliability and performance.
- 2. Voltage on any pin relative to  $V_{\text{SS}}.$
- 3. Thermal impedance junction-to-case is taken from the worst case die in the module to the center/top of the package.
- 4. Per MIL-STD-883, method 1012.1, section 3.4.1, PD=[TJ(max)-TC(max))/θJC]. Using TC = 85°C.



#### **12.2 Recommended Operating Conditions**

| Parameter                                     | Symbol            | Min              | Тур                  | Max              | Unit |
|---|-------------------|------------------|----------------------|------------------|------|
| Operating temperature <sup>1</sup>            | T <sub>OPER</sub> | -40              | -                    | +85              | °C   |
| V <sub>CC</sub> supply voltage <sup>2</sup>   | V <sub>CC</sub>   | 2.7              | 3.3                  | 3.6              | V    |
| $V_{CCQ}$ supply voltage (1.8V) <sup>2</sup>  | V <sub>CCQ</sub>  | 1.7              | 1.8                  | 1.95             | V    |
| $V_{CCQ}$ supply voltage (1.2V) <sup>2</sup>  |                   | 1.14             | 1.2                  | 1.26             | V    |
| V <sub>PP</sub> 12V (10.8V Min) configuration | V <sub>PP</sub>   | 10.8             | 12.0                 | 13.2             | V    |
| V <sub>REFQ</sub> supply voltage              | $V_{REFQ}$        | 0.49 x           | $0.5 \times V_{CCQ}$ | 0.51 x           | V    |
|   |                   | V <sub>CCQ</sub> |                      | V <sub>CCQ</sub> |      |
| V <sub>ss</sub> ground voltage                | $V_{SS}$          | 0                | 0                    | 0                | V    |

#### Notes:

- 1) Operating temperature (T<sub>OPER</sub>) is the case surface temperature on the center/top of the NAND.
- AC Noise on the supply voltages shall not exceed +/- 3% (10kHz to 800MHz). AC and DC noise together shall stay
  within the Min-Max range specified in this table.

#### 12.3 Operational Environment<sup>4</sup>

| Symbol             | Parameter                                    | Limit           | Units                   |
|--------------------|--|-----------------|-------------------------|
| TID <sup>1,5</sup> | Total Ionizing Dose                          | 30 to 50        | krad(Si)                |
| SEL <sup>2</sup>   | Single Event Latchup Immunity                | ≤60             | MeV-cm <sup>2</sup> /mg |
| SEU <sup>3</sup>   | SEU <sup>3</sup> Single Event Upset Immunity |                 | MeV-cm <sup>2</sup> /mg |
| SER <sup>3</sup>   | Soft Error Rate                              | Contact Factory | Errors/bit-day          |
| SEFI               | Single Event Functional Interrupt            | Contact Factory | MeV-cm <sup>2</sup> /mg |

#### Notes:

- For devices procured with a total ionizing dose tolerance guarantee, post-irradiation performance is guaranteed at 25°C per MIL-STD-883 Method 1019, Condition A at an effective dose rate of 0.1 rad(Si)/sec up to maximum TID level procured.
- 2) Performed at  $V_{CC}$  = 3.6 V,  $V_{CCQ}$  = 1.95V and 85°C.
- 3) Performed at  $V_{CC} = 2.7 \text{ V}$ ,  $V_{CCQ} = 1.7 \text{V}/1.14 \text{V}$  and 25°C.
- 4) Radiation testing is performed without V<sub>PP</sub>. V<sub>PP</sub> operations should not be used in a radiation environment. Devices using V<sub>PP</sub> operations in a radiation environment will not be warrantied.
- 5) TID performance may vary from wafer lot to wafer lot. Contact factory for bit error performance and availability at specific TID levels from 30 to 50 krad(Si).

#### 12.4 Valid Block per LUN

| Parameter          | Symbol | Min  | Max  | Unit   | Notes |
|--------------------|--------|------|------|--------|-------|
| Valid block number | NVB    | 1912 | 2016 | Blocks | 1     |

Notes:

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 Invalid blocks are blocks that contain one or more bad bits beyond ECC. The device may contain bad blocks upon shipment. Additional bad blocks may develop over time; however, the total number of available blocks will not drop below NVB during the endurance life of the device. Do not erase or program blocks marked invalid from the factory.



#### 4Tb TLC NAND Flash UT81NDQ512G8T

#### 12.5 Package Electrical Specification and Pad Capacitance

The capacitance delta values in Table 32 measure the pin-to-pin capacitance for all LUNs within a package, including across data buses if the package has the same number of LUNs per x8 data bus (i.e. package channel). The capacitance delta values are not measured across data buses if the package has a different number of LUNs per x8 data bus.

For Table 33, Z<sub>IO</sub> applies to DQ[7:0], DQS\_t, DQS\_c, RE\_t and RE\_c. TdIO RE applies to RE\_t and RE\_c. Td<sub>IO</sub> and Td<sub>IO\_Mismatch</sub> applies to DQ[7:0], DQS\_t and DQS\_c. Mismatch and Delta values are required to be met across same data bus on given package (that is package channel), but not required across all channels on a given package. All other pins only need meet requirements described in Table 32. The DQ[7:0], DQS\_t, DQS\_c, RE\_t and RE\_c pins only need to meet the requirements in Table 33.

For each signal group defined below for Table 32, a typical capacitance value is defined and reported for each NAND Target within a package. The signal groups include all signal group pins in a single package even if the pins belong to separate I/O channels unless the package has a different number of LUNs per x8 data bus. If the package has a different number of LUNs per x8 data bus.

| Description                       | Symbol | Min | Тур  | Max  | Unit | Notes |
|-----------------------------------|--------|-----|------|------|------|-------|
| Input capacitance (ALE, CLE, WE#) | CIN    | 8.0 | 10.0 | 12.0 | pF   | 3     |
| Input capacitance (CE#, WP#)      | COTHER | -   | -    | 12.0 | pF   |       |
| Delta input capacitance           | DCIN   | -   | -    | 2    | pF   |       |

#### Table 32: Input Capacitance: 132-Ball BGA Package

Notes:

1) Verified in device characterization; not 100% tested.

2) Test conditions: TA =  $25^{\circ}$ C, f = 100 MHz, VIN = 0V.

3) Values for  $C_{IN}$  (TYP) are estimates.





# 4Tb TLC NAND Flash UT81NDQ512G8T

#### **Table 33: Package Electrical Specifications**

|   |                             | <=400 MT/s |     | 533 MT/s |     |     | 667 MT/s |     |     |     |      |       |
|---|-----------------------------|------------|-----|----------|-----|-----|----------|-----|-----|-----|------|-------|
| Description                                   | Symbol                      | Min        | Тур | Max      | Min | Тур | Max      | Min | Тур | Max | Unit | Notes |
| Input/Output Z <sub>PKG</sub>                 | ZIO                         | 35         | -   | 90       | 35  | -   | 90       | 35  | -   | 90  | Ohms | 1     |
| Delta Z <sub>PKG</sub> for<br>DQS_t and DQS_c | DZIO DQS                    | -          | -   | 10       | -   | -   | 10       | -   | -   | 10  | Ohms | 8     |
| Input/Output<br>Package delay                 | Τd <sub>IO</sub>            | -          | -   | 160      | -   | -   | 160      | -   | -   | 145 | ps   | 1     |
| Input/Output<br>Package delay                 | Td <sub>IO RE</sub>         | -          | -   | 160      | -   | -   | 160      | -   | -   | 145 | ps   | 1     |
| Input/Output<br>Package delay<br>mismatch     | $Td_{\mathrm{IO}}$ Mismatch | -          | -   | 50       | -   | -   | 40       | -   | -   | 40  | ps   | 6     |
| Delta package<br>delay for DQS_t<br>and DQS_c | DZd10 dqs                   | -          | -   | 10       | -   | -   | 10       | -   | -   | 10  | ps   |       |
| Delta Z <sub>PKG</sub> for<br>RE_t and RE_c   | DZIO DE                     | -          | -   | 10       | -   | -   | 10       | -   | -   | 10  | Ohms |       |
| Delta package<br>delay for RE_t<br>and RE_c   | DC <sub>IO</sub>            | -          | -   | 10       | -   | -   | 10       | -   | -   | 10  | ps   |       |

- 1) Z<sub>IO</sub> and Td<sub>IO</sub> apply to DQ[7:0], DQS\_t, DQS\_c, RE\_t and RE\_c. All other pins only need to meet Table 32 requirements.
- 2) Td<sub>10</sub> apply to DQ[7:0], DQS\_t, and DQS\_c. All other pins only need to meet Table 32 requirements.
- 3) Test conditions:  $T_A = 25^{\circ}C$ , f = 100 MHz,  $V_{IN} = 0V$ .
- 4) Verified in device characterization; not 100% tested. The package parasitic (L & C) are validated using package only samples. The capacitance is measured with V<sub>CC</sub>, V<sub>CCQ</sub>, V<sub>SS</sub>, V<sub>SSQ</sub> shorted with all other signal pins floating. The inductance is measured with V<sub>CC</sub>, V<sub>CCQ</sub>, V<sub>SS</sub>, and V<sub>SSQ</sub> shorted and all other signal pins shorted at the die side (not pin).
- 5) Package only impedance ( $Z_{PKG}$ ) is calculated based on the  $L_{PKG}$  and  $C_{PKG}$  total for a given pin where:  $Z_{PKG}$  (total per pin) = SQRT( $L_{PKG}/C_{PKG}$ ).
- 6) Mismatch for  $Td_{IO}$  ( $Td_{IO}$  Mismatch) is calculated based on  $L_{PKG}$  and  $C_{PKG}$  total for a given pin where:  $Td_{PKG}$ (total per pin) =  $SQRT(L_{PKG} * C_{PKG})$ .
- Package only delay (T<sub>PKG</sub>) is calculated based on L<sub>PKG</sub> and C<sub>PKG</sub> total for a given pin where: Td<sub>PKG</sub>(total per pin) = SQRT(L<sub>PKG</sub>\*C<sub>PKG</sub>).
- 8) Delta for DQS is Absolute value of  $Z_{IO}(DQS_t Z_{IO}(DQS_c))$  for impedance (Z) or absolute value of  $Td_{IO}(DQS_t) Td_{IO}(DQS_c)$  for delay (Td).
- Delta for RE is Absolute value of Z<sub>IO</sub>(RE\_t Z<sub>IO</sub>(RE\_c)) for impedance (Z) or absolute value of Td<sub>IO</sub>(RE\_t) Td<sub>IO</sub>(RE\_c) for delay (Td).



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#### **Table 34: LUN Pad Specifications**

|  |                           | <=400 MT/s |     | 5    | 533 MT/s |     |      | 667 MT/s |     |      |      |       |
|--|---------------------------|------------|-----|------|----------|-----|------|----------|-----|------|------|-------|
| Description  | Symbol                    | Min        | Тур | Max  | Min      | Тур | Max  | Min      | Тур | Max  | Unit | Notes |
| Input/Output Pad<br>capacitance                              | $C_Pad_{IO}$              | -          | -   | 1.6  | -        | -   | 1.6  | -        | -   | 1.6  | pF   | 1     |
| ZQ Pad capacitance   | C_Pad <sub>ZQ</sub>       | I          | -   | 1.84 | -        | -   | 1.84 | I        | -   | 1.84 | рF   | 1     |
| Delta Input/Output<br>Pad capacitance for<br>DQS_t and DQS_c | D_C_Pad <sub>IO DQS</sub> | 0          | -   | 0.2  | 0        | -   | 0.2  | 0        | -   | 0.2  | pF   | 4     |
| Delta Input/Output<br>Pad capacitance for<br>RE_t and RE_c   | D_C_Pad <sub>IO RE</sub>  | 0          | -   | 0.2  | 0        | -   | 0.2  | 0        | -   | 0.2  | pF   | 5     |

Notes:

1) LUN Pad capacitances apply to DQ[7:0], DQS\_t, DQS\_c, RE\_t, and RE\_c. All other LUN pads only need to meet ONFI legacy capacitance requirements.

2) Verified in device characterization; not 100% tested. These parameters are not subject to a production test. They are verified by design and characterization. The capacitance is measured according to JEP147("PROCEDURE FOR MEASURING INPUT CAPACITANCE USING A VECTOR NETWORK ANALYZER(VNA)") with V<sub>CC</sub>, V<sub>CCQ</sub>, V<sub>SS</sub>, and V<sub>SSQ</sub> applied and all other pins floating (except the pin under test). V<sub>CCQ</sub> = 1.2V, VBIAS = V<sub>CCQ</sub>/2 and on-die termination off.

3) These parameters apply to monolithic LUN, obtained by de-embedding the package L & C parasitics.

4) Delta for DQS is Absolute value of C\_PAD<sub>I0</sub>(DQS\_t) - C\_PAD<sub>I0</sub>(DQS\_c).

5) Delta for RE is Absolute value of C\_PAD<sub>IO</sub>(RE\_t) - C\_PAD<sub>IO</sub>(RE\_c).

#### 12.6 DC Characteristics and Operating Conditions (Asynchronous Interface) 1.8 $V_{CCQ}$

| Parameter                         | Conditions  | Symbol                       | Single<br>plane<br>Typ <sup>1</sup> | Two<br>plane<br>Typ <sup>1</sup> | Four<br>plane<br>Typ <sup>1</sup> | Max<br>ave-<br>rage <sup>1</sup> | Max<br>single<br>operation <sup>1</sup> | Unit |  |
|-----------------------------------|---|------------------------------|-------------------------------------|----------------------------------|-----------------------------------|----------------------------------|---|------|--|
|                                   | SLC Mode Snap Read<br>operation –without V <sub>PP</sub>      | $I_{CC1\_A}{}^5$             | 33                                  | -                                | -                                 | 38                               | 38                                      |      |  |
|                                   | SLC Mode operation -<br>Without V <sub>PP</sub>               | $I_{CC1\_A}$                 | 35                                  | 51                               | 66                                | 80                               | 80                                      |      |  |
| Array read<br>current (active)    | TLC Mode Snap Read<br>operation – without V <sub>PP</sub>     | $I_{CC1\_A}{}^5$             | 26                                  | -                                | -                                 | 33                               | 37                                      | mA   |  |
|                                   | TLC Mode operation -<br>without V <sub>PP</sub>               | $I_{CC1\_A}$                 | 29                                  | 42                               | 56                                | 62                               | 68                                      |      |  |
|                                   | -   | $I_{\text{CCQ1}\_\text{A}}$  |                                     | 1.5                              |                                   | 5                                |   |      |  |
| Array program<br>current (active) | SLC Mode operation -<br>without V <sub>PP</sub>               | $I_{CC2\_A}$                 | 31                                  | 40                               | 50                                | 60                               | 61                                      |      |  |
|                                   | TLC Mode operation -<br>without V <sub>PP</sub>               | I <sub>CC2_A</sub>           | 30                                  | 42                               | 53                                | 58                               | 65                                      | mA   |  |
|                                   | -   | $I_{CCQ2\_A}$                |                                     | 2                                |                                   |                                  | 8                                       |      |  |
| Erase current<br>(active)         | without V <sub>PP</sub>                                       | $I_{\text{CC3}\_\text{A}}$   | 25                                  | 25 30                            |                                   | 55 (90 post TID)                 |   |      |  |
|                                   | -   | $I_{CCQ3\_A}$                | 1.5                                 |                                  |                                   | 5                                |   | mA   |  |
| I/O burst read                    | <sup>t</sup> RC= <sup>t</sup> RC (MIN); I <sub>OUT</sub> =0mA | $I_{CC4R\_A}$                |                                     | 8                                |                                   |                                  | 10                                      |      |  |
| current                           |   | $I_{\text{CCQ4R}\_\text{A}}$ |                                     | 6                                |                                   |                                  | 10                                      |      |  |



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| Parameter  | Conditions                                   | Symbol                                  | Single<br>plane<br>Typ <sup>1</sup> | Two<br>plane<br>Typ <sup>1</sup> | Four<br>plane<br>Typ <sup>1</sup> | Max<br>ave-<br>rage <sup>1</sup> | Max<br>single<br>operation <sup>1</sup> | Unit |  |    |
|--|--|---|-------------------------------------|----------------------------------|-----------------------------------|----------------------------------|---|------|--|----|
| I/O burst write  | <sup>t</sup> WC= <sup>t</sup> WC (MIN)       | I <sub>CC4w_A</sub>                     |                                     | 10                               |                                   |                                  | 13                                      | mA   |  |    |
| current  |  | $I_{CCQ4w\_A}$                          |                                     | 6                                |                                   |                                  | ША                                      |      |  |    |
| Bus idle current   | -  | $I_{\text{CC5}\_\text{A}}$              |                                     | 5                                |                                   |                                  | 7                                       |      |  |    |
|  |  | I <sub>CCQ5_A</sub>                     |                                     | 1                                |                                   |                                  | mA                                      |      |  |    |
| Current during<br>first RESET<br>command after<br>power-on | _  | I <sub>CC6</sub>                        |                                     | 38                               |                                   |                                  | mA                                      |      |  |    |
| Power-up peak<br>current (V <sub>cc</sub> )                | -  | ${\rm I}_{\rm CC\_Peak\_Up}^4$          | -                                   |                                  | 20                                |                                  | mA                                      |      |  |    |
| Power-down<br>peak current<br>(V <sub>CC</sub> )           | -  | $I_{CC\_Peak\_Down}^4$                  | -                                   |                                  | 20                                |                                  | mA                                      |      |  |    |
| Power-up peak<br>current (V <sub>CCQ</sub> )               | -  | $\mathrm{I}_{\mathrm{CCQ\_Peak\_Up}}^4$ |                                     | -                                | -                                 |                                  | 10                                      | mA   |  |    |
| Power-down<br>peak current<br>(V <sub>CCQ</sub> )          | -  | $I_{CCQ\_Peak\_Down}^4$                 |                                     | -                                |                                   | -                                |   | - 15 |  | mA |
| Standby current<br>V <sub>CC</sub>                         | $CE\# = V_{CCQ} - 0.2V;$ $WP\# = 0V/V_{CCQ}$ | $\mathrm{I}_{SB}$                       |                                     | 15                               |                                   | 75 (162.5 post TID)              |   | μA   |  |    |
| Standby current $V_{CCQ}$                                  | $CE\# = V_{CCQ} - 0.2V;$ $WP\# = 0V/V_{CCQ}$ | $I_{SBQ}$                               |                                     | 10                               | 50                                |                                  | 50                                      | μA   |  |    |
| Staggered<br>power-up<br>current                           | <sup>t</sup> RISE = 1ms; $C_{LINE} = 0.1 uF$ | I <sub>ST</sub>                         |                                     | -                                |                                   | 10                               |   | mA   |  |    |

#### Notes:

1) All values are per die (LUN) unless otherwise specified.

2) During  $I_{SBQ}$  testing, DQS\_t/DQS\_c, RE\_t/RE\_c, and DQ[7:0] are floating.

3) During  $I_{CC}$  testing, on-die termination (ODT) is not enabled.

4) For the I<sub>CC\_Peak</sub> and I<sub>CCQ\_Peak</sub> currents the entire duration of the operation should be considered when calculating the maximum average current of the worst case 1µs subset of the operation.

5) These Snap Read operations are measured based on SR[5] busy time.



#### 12.7 DC Characteristics (NV-DDR2, NV-DDR3)

#### Table 35: DC Characteristics and Operating Conditions (NV-DDR2 Interface) 1.8V $V_{\text{CCQ}}$

|   |   |                                   |                                     | -                                |                                   | -                                | -                                       |      |
|---|---|-----------------------------------|-------------------------------------|----------------------------------|-----------------------------------|----------------------------------|---|------|
| Parameter                                       | Conditions  | Symbol                            | Single<br>plane<br>Typ <sup>1</sup> | Two<br>plane<br>Typ <sup>1</sup> | Four<br>plane<br>Typ <sup>1</sup> | Max<br>ave-<br>rage <sup>1</sup> | Max<br>single<br>operation <sup>1</sup> | Unit |
|   | SLC Mode Snap Read<br>operation -without V <sub>PP</sub>  | I <sub>CC1_S</sub>                | 33                                  | -                                | -                                 | 38                               | 38                                      |      |
|   | SLC Mode operation -<br>without V <sub>PP</sub>           | I <sub>CC1_S</sub>                | 35                                  | 51                               | 66                                | 80                               | 80                                      |      |
| Array read current<br>(active)                  | TLC Mode Snap Read<br>operation - without V <sub>PP</sub> | I <sub>CC1_S</sub>                | 26                                  | -                                | -                                 | 33                               | 37                                      | mA   |
|   | TLC Mode operation -<br>without V <sub>PP</sub>           | I <sub>CC1_S</sub>                | 29                                  | 42                               | 56                                | 62                               | 68                                      |      |
|   | -   | I <sub>CCQ1_S</sub>               |                                     | 1.5                              |                                   |                                  | 5                                       |      |
| Array program<br>current (active) <sup>10</sup> | SLC Mode operation -<br>without V <sub>PP</sub>           | I <sub>CC2_S</sub>                | 31                                  | 40                               | 50                                | 60                               | 61                                      |      |
|   | TLC Mode operation -<br>without V <sub>PP</sub>           | I <sub>CC2_S</sub>                | 30                                  | 42                               | 53                                | 58                               | 65                                      | mA   |
|   | -   | I <sub>CCQ2_S</sub>               | 2                                   |                                  |                                   |                                  | 8                                       |      |
| Erase current                                   | without V <sub>PP</sub>                                   | I <sub>CC3_S</sub>                | 25                                  | 25 30                            |                                   | 55 (90 post TID)                 |   |      |
| (active)  | -   | I <sub>CCQ3_S</sub>               | 1.5                                 |                                  |                                   | 5                                |   | - mA |
| I/O burst read                                  | <sup>t</sup> RC= <sup>t</sup> RC (MIN);                   | I <sub>CC4R_S</sub>               |                                     | 13 <sup>3</sup>                  |                                   | 17 <sup>3</sup>                  |   | -    |
| current   | I <sub>OUT</sub> =0mA                                     |                                   |                                     | 20 <sup>4</sup>                  |                                   | 26 <sup>4</sup>                  |   |      |
|   |   |                                   |                                     | <b>28</b> ⁵                      |                                   |                                  | <b>37</b> <sup>5</sup>                  |      |
|   |   | I <sub>CCQ4R_S</sub>              |                                     | 18 <sup>3,9</sup>                |                                   | 24 <sup>3,9</sup>                |   | - mA |
|   |   |                                   |                                     | 34 <sup>4,9</sup>                |                                   | 404,9                            |   |      |
|   |   |                                   |                                     | 45 <sup>5,9</sup>                |                                   |                                  | 55 <sup>5,9</sup>                       | 1    |
| I/O burst write                                 | <sup>t</sup> DSC= <sup>t</sup> DSC (MIN)                  | I <sub>CC4W_S</sub>               |                                     | 15 <sup>3</sup>                  |                                   |                                  | -<br>-<br>- mA                          |      |
| current   |   |                                   |                                     | 20 <sup>4</sup>                  |                                   |                                  |   |      |
|   |   |                                   |                                     | 25⁵                              |                                   | 335                              |   |      |
|   |   | I <sub>CCQ4W_S</sub>              |                                     | 13 <sup>3</sup>                  |                                   | 17 <sup>3</sup>                  |   |      |
|   |   |                                   |                                     | 19 <sup>4</sup>                  |                                   | 25 <sup>4</sup>                  |   |      |
|   |   |                                   |                                     | 25⁵                              |                                   |                                  | <b>33</b> <sup>5</sup>                  | 1    |
| Bus idle current                                | $CE\# = V_{IL}$   | I <sub>CC5_S</sub>                |                                     | 5                                |                                   |                                  | 7                                       | mA   |
|   |   | I <sub>CCQ5_S</sub>               | 5                                   |                                  |                                   | 7                                |   | mA   |
| Power-up peak<br>current (V <sub>cc</sub> )     | -   | ${\rm I}_{\rm CC\_Peak\_Up}^7$    | -                                   |                                  | 20                                |                                  | mA                                      |      |
| Power-down peak<br>current (V <sub>cc</sub> )   | -   | $I_{CC\_Peak\_Down}^7$            |                                     | -                                |                                   |                                  | 20                                      | mA   |
| Power-up peak<br>current (V <sub>CCQ</sub> )    | -   | ${\rm I}_{\rm CCQ\_Peak\_Up}{}^7$ |                                     | -                                |                                   | 10                               |   | mA   |





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4Tb TLC NAND Flash

## UT81NDQ512G8T

| Parameter                                      | Conditions                                   | Symbol                  | Single<br>plane<br>Typ <sup>1</sup> | Two<br>plane<br>Typ <sup>1</sup> | Four<br>plane<br>Typ <sup>1</sup> | Max<br>ave-<br>rage <sup>1</sup> | Max<br>single<br>operation <sup>1</sup> | Unit |
|--|--|-------------------------|-------------------------------------|----------------------------------|-----------------------------------|----------------------------------|---|------|
| Power-down peak<br>current (V <sub>CCQ</sub> ) | -  | $I_{CCQ\_Peak\_Down}^7$ |                                     | -                                |                                   | 15                               |   | mA   |
| Standby current<br>V <sub>cc</sub>             | $CE\# = V_{CCQ} - 0.2V;$ $WP\# = 0V/V_{CCQ}$ | I <sub>SB</sub>         | 15                                  |                                  | 75 (162                           | .5 post TID)                     | μA                                      |      |
| Standby current $V_{CCQ}$                      | $CE\# = V_{CCQ} - 0.2V;$ $WP\# = 0V/V_{CCQ}$ | I <sub>SBQ</sub>        |                                     | 10                               |                                   |                                  | 50                                      | μA   |

- 1) All values are per die (LUN) unless otherwise specified.
- 2) During  $I_{SBQ}$  testing, DQS\_t/DQS\_c, RE\_t/RE\_c, and DQ[7:0] are floating.
- 3) For speeds up to 200 MT/s.
- 4) For speeds greater than 200 MT/s up to 400 MT/s.
- 5) For speeds greater than 400 MT/s.
- 6) During  $I_{CC}$  testing, on-die termination (ODT) is not enabled.
- 7) For the  $I_{CC\_Peak}$  and  $I_{CCQ\_Peak}$  currents the entire duration of the operation should be considered when calculating the maximum average current of the worst case 1µs subset of the operation.
- 8) N/A
- 9) For speeds up to 200 MT/s, speeds greater than 200 MT/s up to 400 MT/s and speeds greater than 400 MT/s, two-LUN-per-channel's I<sub>CCQ4R</sub> MAX may increase by 10% when comparing with one LUN-per-channel's.



### Table 36: DC Characteristics and Operating Conditions (NV-DDR3 Interface) 1.2V $V_{\text{CCQ}}$

|  |   |                              | -                | -                 |                  |                   |                        |       |
|--|---|------------------------------|------------------|-------------------|------------------|-------------------|------------------------|-------|
|  |   |                              | Single<br>plane  | Two<br>plane      | Four<br>plane    | Max<br>ave-       | Max<br>single          |       |
| Parameter  | Conditions  | Symbol                       | Typ <sup>1</sup> | Typ <sup>1</sup>  | Typ <sup>1</sup> | rage <sup>1</sup> | operation <sup>1</sup> | Unit  |
|  | SLC Mode Snap Read<br>operation -without V <sub>PP</sub>  | I <sub>CC1_S</sub>           | 33               | -                 | -                | 38                | 38                     |       |
|  | SLC Mode operation -<br>without V <sub>PP</sub>           | I <sub>CC1_S</sub>           | 35               | 51                | 66               | 80                | 80                     |       |
| Array read<br>current (active)                   | TLC Mode Snap Read<br>operation - without V <sub>PP</sub> | I <sub>CC1_S</sub>           | 26               | -                 | -                | 33                | 37                     | mA    |
|  | TLC Mode operation -<br>without V <sub>PP</sub>           | I <sub>CC1_S</sub>           | 29               | 42                | 56               | 62                | 68                     |       |
|  | -   | $I_{CCQ1\_S}$                |                  | 1.5               |                  |                   | 5                      |       |
| Array program<br>current (active)                | SLC Mode operation -<br>without V <sub>PP</sub>           | I <sub>CC2_S</sub>           | 31               | 40                | 50               | 60                | 61                     |       |
|  | TLC Mode operation -<br>without V <sub>PP</sub>           | I <sub>CC2_S</sub>           | 30               | 42                | 53               | 58                | 65                     | mA    |
|  | -   | I <sub>CCQ2_S</sub>          |                  | 2                 |                  |                   | 8                      |       |
| Erase current                                    | without VPP   | I <sub>CC3_S</sub>           | 25               | 30                | 36               | 55 (90 post TID)  |                        | mA    |
| (active)   | -   | $I_{CCQ3_S}$                 |                  | 1.5               |                  | 5                 |                        | ША    |
| I/O burst read                                   | <sup>t</sup> RC= <sup>t</sup> RC (MIN);                   | $I_{CC4R_S}$                 |                  | 13 <sup>3</sup>   |                  | 17 <sup>3</sup>   |                        |       |
| current  | I <sub>OUT</sub> =0mA                                     |                              |                  | 20 <sup>4</sup>   |                  |                   | 26 <sup>4</sup>        |       |
|  |   |                              | 285              |                   | 37 <sup>5</sup>  |                   | mA                     |       |
|  |   | $I_{\text{CCQ4R}\_\text{S}}$ |                  | 18 <sup>3,9</sup> |                  |                   | 24 <sup>3,9</sup>      | 110 ( |
|  |   |                              |                  | 34 <sup>4,9</sup> |                  |                   | 34 <sup>4,9</sup>      |       |
|  |   |                              |                  | 45 <sup>5,9</sup> |                  |                   | 55 <sup>5,9</sup>      |       |
| I/O burst write                                  | <sup>t</sup> DSC= <sup>t</sup> DSC (MIN)                  | $I_{CC4W_S}$                 |                  | 15 <sup>3</sup>   |                  |                   | 20 <sup>3</sup>        |       |
| current  |   |                              |                  | 20 <sup>4</sup>   |                  |                   | 26 <sup>4</sup>        |       |
|  |   |                              |                  | <b>25</b> ⁵       |                  |                   | 335                    | mA    |
|  |   | $I_{CCQ4W_S}$                |                  | 13 <sup>3</sup>   |                  |                   | 17 <sup>3</sup>        |       |
|  |   |                              |                  | 19 <sup>4</sup>   |                  |                   | 25 <sup>4</sup>        |       |
|  |   |                              |                  | 25 <sup>5</sup>   |                  |                   | 33 <sup>5</sup>        |       |
| Bus idle current                                 | $CE\# = V_{IL}$   | I <sub>CC5_S</sub>           |                  | 5                 |                  |                   | 7                      | mA    |
|  |   | I <sub>CCQ5_S</sub>          |                  | 5                 |                  |                   | 7                      | mA    |
| Power-up peak<br>current (V <sub>cc</sub> )      | -   | I <sub>CC_Peak_Up</sub> 7    | -                |                   |                  | 20                | mA                     |       |
| Power-down<br>peak current<br>(V <sub>cc</sub> ) | -   | $I_{CC\_Peak\_Down}^7$       |                  | -                 |                  |                   | 20                     | mA    |
| Power-up peak<br>current (V <sub>CCQ</sub> )     | -   | $I_{\rm CCQ\_Peak\_Up}{}^7$  |                  | -                 |                  |                   | 10                     | mA    |



# UT81NDQ512G8T

| Parameter   | Conditions                                   | Symbol                      | Single<br>plane<br>Typ <sup>1</sup> | Two<br>plane<br>Typ <sup>1</sup> | Four<br>plane<br>Typ <sup>1</sup> | Max<br>ave-<br>rage <sup>1</sup> | Max<br>single<br>operation <sup>1</sup> | Unit |
|---|--|-----------------------------|-------------------------------------|----------------------------------|-----------------------------------|----------------------------------|---|------|
| Power-down<br>peak current<br>(V <sub>ccq</sub> ) | -  | $I_{CCQ\_Peak\_Down}^7$     |                                     | -                                |                                   |                                  | 15                                      | mA   |
| Standby current<br>V <sub>cc</sub>                | $CE\# = V_{CCQ} - 0.2V;$ $WP\# = 0V/V_{CCQ}$ | $I_{\text{SB}}$             |                                     | 15                               |                                   | 75 (162.5 post TID)              |   | μA   |
| Standby current<br>V <sub>CCQ</sub>               | $CE\# = V_{CCQ} - 0.2V;$ $WP\# = 0V/V_{CCQ}$ | $\mathrm{I}_{\mathrm{SBQ}}$ |                                     | 10                               |                                   |                                  | 50                                      | μA   |

Notes:

- 1) All values are per die (LUN) unless otherwise specified.
- 2) During I<sub>SBQ</sub> testing, DQS\_t/DQS\_c, RE\_t/RE\_c, and DQ[7:0] are floating.
- 3) For speeds up to 200MT/s.
- 4) For speeds greater than 200MT/s up to 400MT/s.
- 5) For speeds greater than 400MT/s up to 667MT/s.
- 6) During  $I_{CC}$  testing, on-die termination (ODT) is not enabled.
- 7) For the I<sub>CC\_Peak</sub> and I<sub>CCQ\_Peak</sub> currents the entire duration of the operation should be considered when calculating the maximum average current of the worst case 1µs subset of the operation.
- 8) N/A
- 9) For speeds up to 200MT/s, speeds greater than 200MT/s up to 400MT/s and speeds greater than 400MT/s, two-LUNper-channel's I<sub>CCQ4R</sub> MAX may increase by 10% when comparing with one-LUN-per-channel's.



### 12.8 DC Characteristics (V<sub>CCQ</sub>)

#### Table 37: Asynchronous DC Characteristics and Operating Conditions (1.8V Vccq)

| Parameter                 | Conditions  | Symbol                     | Min      | Тур | Max                   | Unit | Notes |
|---------------------------|---|----------------------------|----------|-----|-----------------------|------|-------|
| AC input high voltage     | CE#, DQ[7:0], DQS, ALE, CLE,                            | VIH(AC)                    | 0.8xVccq | -   | V <sub>CCQ</sub> +0.3 | V    |       |
| AC input low voltage      | WE#, RE#, WP#   | VIL(AC)                    | -0.3     | -   | 0.2xVccq              | V    |       |
| DC input high voltage     | DQ[7:0], DQS, ALE, CLE,                                 | VIH(DC)                    | 0.7xVccq | -   | V <sub>CCQ</sub> +0.3 | V    |       |
| DC input low voltage      | WE#, RE#  | VIL(DC)                    | -0.3     | -   | 0.3xVccq              | V    |       |
| Input leakage current     | Any input $V_{IN} = 0V$ to $V_{CCQ}$                    | ILI                        | -        | -   | ±10                   | μA   | 1     |
| Output leakage current    | DQ are disabled; $V_{OUT} = V_{CCQ}$                    | $I_{\text{LO}\_\text{PD}}$ | -        | 0.3 | 1                     | μA   | 4     |
|                           | DQ are disabled; V <sub>OUT</sub> = 0V;<br>ODT disabled | Ilo_pu                     | -        | 0.9 | 5                     | μA   | 4     |
| Output low current (R/B#) | $V_{OL} = 0.2V$   | IoL (R/B#)                 | 3        | 4   | -                     | mA   | 2     |

#### Notes:

- 1) All leakage currents are per die (LUN). For example, four die (LUNs) have a maximum leakage current of ±40µA.
- DC characteristics may need to be relaxed if R/B# pull-down strength is not set to full strength. See the User Manual, Feature Address 81h: Programmable R/B# Pull-Down Strength table, in the Configuration Operations section, for additional details.
- 3) See the Overshoot/Undershoot Parameters table in the AC Overshoot / Undershoot Specifications section.
- 4) Absolute leakage value per I/O per NAND LUN (DQ[7:0], DQS\_t, DQS\_c, RE\_t, RE\_c).

#### Table 38: NV-DDR2 DC Characteristics and Operating Conditions for Single-Ended Signals (1.8V Vccq)

| Parameter                         | Conditions  | Symbol                      | Min                      | Тур | Max                      | Unit | Notes |
|-----------------------------------|---|-----------------------------|--------------------------|-----|--------------------------|------|-------|
| AC input high voltage             | DQ[7:0], DQS, ALE, CLE,                                   | VIH(AC)                     | V <sub>REFQ</sub> +0.250 | -   | -                        | V    | 4     |
| AC input low voltage              | WE#, RE#  | VIL(AC)                     | -                        | -   | V <sub>REFQ</sub> +0.250 | V    | 4     |
| AC input high voltage             | CE#, WP#  | V <sub>IH(AC)</sub>         | 0.8xV <sub>CCQ</sub>     | -   | V <sub>CCQ</sub> +0.3    | V    | 4     |
| AC input low voltage              |   | VIL(AC)                     | -0.3                     |     | 0.2xVccq                 | V    | 4     |
| DC input high voltage             | DQ[7:0], DQS, ALE, CLE,                                   | VIH(DC)                     | V <sub>REFQ</sub> +0.125 | -   | Vccq+0.3                 | V    | 2     |
| DC input low voltage              | WE#, RE#  | VIL(DC)                     | -0.3                     | -   | VREFQ-0.125              | V    | 2     |
| DC input high voltage             | CE#, WP#  | V <sub>IH(DC)</sub>         | 0.7xV <sub>CCQ</sub>     | -   | V <sub>CCQ</sub> +0.3    | V    |       |
| DC input low voltage              |   | V <sub>IL(DC)</sub>         | -0.3                     |     | 0.3xV <sub>CCQ</sub>     | V    |       |
| Input leakage current             | Any input $V_{IN} = 0V$ to $V_{CCQ}$                      | $\mathbf{I}_{LI}$           | -                        | -   | ±10                      | μA   | 1     |
| Output leakage current            | DQ are disabled; $V_{OUT} = V_{CCQ}$                      | $I_{\text{LO}\_\text{PD}}$  | -                        | 0.3 | 1                        | μA   | 5     |
|                                   | DQ are disabled; V <sub>OUT</sub> =<br>0V; ODT disabled   | $I_{\text{LO}_{\text{PU}}}$ | -                        | 0.9 | 5                        | μA   | 5     |
| Output low current<br>(R/B#)      | $V_{OL} = 0.2V$   | I <sub>OL</sub><br>(R/B#)   | 3                        | 4   | -                        | mA   | 3     |
| V <sub>REFQ</sub> leakage current | $V_{REFQ} = V_{CCQ}/2$ (all other pins not under test=0V) | $I_{VREFQ}$                 | -                        | -   | ±5                       | μA   |       |

#### Notes:

- 1) All leakage currents are per die (LUN). For example, four die (LUNs) have a maximum leakage current of  $\pm 40 \mu$ A.
- 2) These values are not defined. However, the single-ended signals (RE\_t, RE\_c, DQS\_t, and DQS\_c) need to be within the respective limits [V<sub>IH(DC)</sub> Max, V<sub>IL(DC)</sub> Min] for single-ended signals as well as the limitations for overshoot and



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undershoot.

- 3) DC characteristics may need to be relaxed if R/B# pull-down strength is not set to full strength. See the User Manual, Feature Address 81h: Programmable R/B# Pull-Down Strength table, in the Configuration Operations section, for additional details.
- 4) See the Overshoot/Undershoot Parameters table in the AC Overshoot / Undershoot Specifications section.
- 5) Absolute leakage value per I/O per NAND LUN (DQ[7:0], DQS\_t, DQS\_c, RE\_t, RE\_c).

#### Table 39: NV-DDR2 DC Characteristics and Operating Conditions for Differential Signals (1.8V Vccq)

| Parameter                          | Conditions   | Symbol                 | Min  | Тур | Max  | Unit | Notes |
|------------------------------------|--|------------------------|--|-----|--|------|-------|
| Differential AC input high voltage | DQS_t, DSQ_c, RE_t, RE_c   | $V_{IHdiff(AC)}$       | 2x[V <sub>IH(AC)</sub> -<br>V <sub>REF</sub> ] | -   | See<br>Note                                    | V    | 2     |
| Differential AC input low voltage  |  | $V_{ILdiff(AC)}$       | See Note                                       | -   | 2x[V <sub>REF</sub> -<br>V <sub>IL(AC)</sub> ] | V    | 2     |
| Differential DC input high voltage | DQS_t, DSQ_c, RE_t, RE_c   | $V_{IHdiff(DC)}$       | 2x[V <sub>IH(AC)</sub> -<br>V <sub>REF</sub> ] | -   | See<br>Note                                    | V    | 2     |
| Differential DC input low voltage  |  | $V_{ILdiff(DC)}$       | See Note                                       | -   | 2x[V <sub>REF</sub> -<br>Vil(ac)]              | V    | 2     |
| Input leakage current              | Any input $V_{IN} = 0V$ to $V_{CCQ}$   | $\mathbf{I}_{LI}$      | -  | -   | ±10  | μA   | 1     |
| Output leakage current             | DQ are disabled; Vout = Vccq   | Ilo_pd                 | -  | 0.3 | 1  | μA   | 5     |
|                                    | DQ are disabled; $V_{OUT} = 0V$ ;<br>ODT disabled                            | Ilo_pu                 | -  | 0.9 | 5  | μA   | 5     |
| Output low current (R/B#)          | $V_{OL} = 0.2V$  | I <sub>OL</sub> (R/B#) | 3  | 4   | -  | mA   | 3     |
| V <sub>REFQ</sub> leakage current  | V <sub>REFQ</sub> =V <sub>CCQ</sub> /2 (all other pins<br>not under test=0V) | Ivrefq                 | -  | -   | ±5   | μA   |       |

#### Notes:

1) All leakage currents are per die (LUN). For example, four die (LUNs) have a maximum leakage current of ±40µA.

 These values are not defined. However, the single-ended signals (RE\_t, RE\_c, DQS\_t, and DQS\_c) need to be within the respective limits [V<sub>IH(DC)</sub> Max, V<sub>IL(DC)</sub> Min] for single-ended signals as well as the limitations for overshoot and undershoot.

- 3) DC characteristics may need to be relaxed if R/B# pull-down strength is not set to full strength. See the User Manual, Feature Address 81h: Programmable R/B# Pull-Down Strength table, in the Configuration Operations section, for additional details.
- 4) See the Overshoot/Undershoot Parameters table in the AC Overshoot / Undershoot Specifications section.
- 5) Absolute leakage value per I/O per NAND LUN (DQ[7:0], DQS\_t, DQS\_c, RE\_t, RE\_c).



#### Table 40: NV-DDR3 DC Characteristics and Operating Conditions for Single-Ended Signals (1.2V $V_{CCQ}$ )

| Parameter                         | Conditions  | Symbol                    | Min                      | Тур   | Max                      | Unit | Notes |
|-----------------------------------|---|---------------------------|--------------------------|-------|--------------------------|------|-------|
| AC input high voltage             | DQ[7:0], DQS, ALE, CLE,                                   | V <sub>IH(AC)</sub>       | V <sub>REFQ</sub> +0.150 | - 7 P | -                        | V    | 4     |
| AC input low voltage              | WE#, RE#  | V <sub>IL(AC)</sub>       | -                        | -     | $V_{REFQ}$ +0.150        | V    | 4     |
| AC input high voltage             | CE#, WP#  | V <sub>IH(AC)</sub>       | 0.8xV <sub>CCQ</sub>     | -     | V <sub>CCQ</sub> +0.3    | V    | 4     |
| AC input low voltage              |   | VIL(AC)                   | -0.3                     |       | 0.2xVccq                 | V    | 4     |
| DC input high voltage             | DQ[7:0], DQS, ALE, CLE,                                   | V <sub>IH(DC)</sub>       | V <sub>REFQ</sub> +0.100 | -     | Vccq                     | V    | 2     |
| DC input low voltage              | WE#, RE#  | VIL(DC)                   | Vssq                     | -     | V <sub>REFQ</sub> -0.100 | V    | 2     |
| DC input high voltage             | CE#, WP#  | V <sub>IH(DC)</sub>       | 0.7xV <sub>CCQ</sub>     | -     | V <sub>CCQ</sub> +0.3    | V    |       |
| DC input low voltage              |   | VIL(DC)                   | -0.3                     |       | 0.3xVccq                 | V    |       |
| Input leakage current             | Any input $V_{IN} = 0V$ to $V_{CCQ}$                      | ILI                       | -                        | -     | ±10                      | μA   | 1     |
| Output leakage current            | DQ are disabled; $V_{OUT} = V_{CCQ}$                      | Ilo_pd                    | -                        | 0.3   | 1                        | μA   | 5     |
|                                   | DQ are disabled; V <sub>OUT</sub> =<br>0V; ODT disabled   | Ilo_pu                    | -                        | 0.9   | 5                        | μA   | 5     |
| Output low current<br>(R/B#)      | $V_{OL} = 0.2V$   | I <sub>OL</sub><br>(R/B#) | 3                        | 4     | -                        | mA   | 3     |
| V <sub>REFQ</sub> leakage current | $V_{REFQ} = V_{CCQ}/2$ (all other pins not under test=0V) | Ivrefq                    | -                        | -     | ±5                       | μA   |       |

#### Notes:

- 1) All leakage currents are per die (LUN). For example, four die (LUNs) have a maximum leakage current of ±40µA.
- These values are not defined. However, the single-ended signals (RE\_t, RE\_c, DQS\_t, and DQS\_c) need to be within the respective limits [V<sub>IH(DC)</sub> Max, V<sub>IL(DC)</sub> Min] for single-ended signals as well as the limitations for overshoot and undershoot.
- 3) DC characteristics may need to be relaxed if R/B# pull-down strength is not set to full strength. See the User Manual, Feature Address 81h: Programmable R/B# Pull-Down Strength table, in the Configuration Operations section, for additional details.
- 4) See the Overshoot/Undershoot Parameters table in the AC Overshoot / Undershoot Specifications section.
- 5) Absolute leakage value per I/O per NAND LUN (DQ[7:0], DQS\_t, DQS\_c, RE\_t, RE\_c).



DATASHEET



#### Table 41: NV-DDR3 DC Characteristics and Operating Conditions for Differential Signals (1.2V $V_{CCQ}$ )

|                                    | •  | -                  |  |     |  | -<br> |       |
|------------------------------------|--|--------------------|--|-----|--|-------|-------|
| Parameter                          | Conditions   | Symbol             | Min  | Тур | Max  | Unit  | Notes |
| Differential AC input high voltage | DQS_t, DSQ_c, RE_t, RE_c   | VIHdiff(AC)        | 2x[V <sub>IH(AC)</sub> -<br>V <sub>REF</sub> ] | -   | See<br>Note                                    | V     | 2     |
| Differential AC input low voltage  |  | VILdiff(AC)        | See Note                                       | -   | 2x[V <sub>REF</sub> -<br>V <sub>IL(AC)</sub> ] | V     | 2     |
| Differential DC input high voltage | DQS_t, DSQ_c, RE_t, RE_c   | VIHdiff(DC)        | 2x[V <sub>IH(AC)</sub> -<br>V <sub>REF</sub> ] | -   | See<br>Note                                    | V     | 2     |
| Differential DC input low voltage  |  | VILdiff(DC)        | See Note                                       | -   | 2x[V <sub>REF</sub> -<br>V <sub>IL(DC)</sub> ] | V     | 2     |
| Input leakage current              | Any input $V_{IN} = 0V$ to $V_{CCQ}$   | ILI                | -  | -   | ±10  | μA    | 1     |
| Output leakage current             | DQ are disabled; $V_{OUT} = V_{CCQ}$   | I <sub>LO_PD</sub> | -  | 0.3 | 1  | μA    | 5     |
|                                    | DQ are disabled; V <sub>OUT</sub> = 0V;<br>ODT disabled                      | I <sub>LO_PU</sub> | -  | 0.9 | 5  | μA    | 5     |
| Output low current (R/B#)          | $V_{OL} = 0.2V$  | IoL (R/B#)         | 3  | 4   | -  | mA    | 3     |
| V <sub>REFQ</sub> leakage current  | V <sub>REFQ</sub> =V <sub>CCQ</sub> /2 (all other pins<br>not under test=0V) | Ivrefq             | -  | -   | ±5   | μA    |       |

#### Notes:

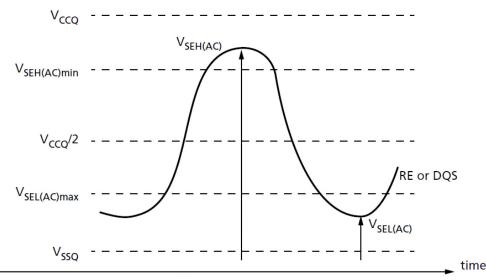
- 1) All leakage currents are per die (LUN). For example, four die (LUNs) have a maximum leakage current of  $\pm 40\mu$ A.
- These values are not defined. However, the single-ended signals (RE\_t, RE\_c, DQS\_t, and DQS\_c) need to be within the respective limits [V<sub>IH(DC)</sub> Max, V<sub>IL(DC)</sub> Min] for single-ended signals as well as the limitations for overshoot and undershoot.
- 3) DC characteristics may need to be relaxed if R/B# pull-down strength is not set to full strength. See the User Manual, Feature Address 81h: Programmable R/B# Pull-Down Strength table, in the Configuration Operations section, for additional details.
- 4) See the Overshoot/Undershoot Parameters table in the AC Overshoot / Undershoot Specifications section.
- 5) Absolute leakage value per I/O per NAND LUN (DQ[7:0], DQS\_t, DQS\_c, RE\_t, RE\_c).

#### 12.8.1 Single-Ended Requirements for Differential Signals

Each individual component of a differential signal (RE\_t, RE\_c, DQS\_t, or DQS\_c) shall comply with requirements for single-ended signals. RE\_t and RE\_c shall meet  $V_{SEH(AC)}$  Min /  $V_{SEL(AC)}$  Max in every half-cycle. DQS\_t and DQS\_c shall meet  $V_{SEH(AC)}$  Min/ $V_{SEL(AC)}$  Max in every half-cycle preceding and following a valid transition.







While control (e.g., ALE, CLE) and DQ signal requirements are with respect to  $V_{REF}$ , the single-ended components of differential signals have a requirement with respect to  $V_{CCQ}/2$ ; this is nominally the same. The transition of single-ended signals through the AC-levels is used to measure setup time. For single-ended components of differential signals the requirement to reach  $V_{SEL(AC)}$  Max,  $V_{SEH(AC)}$  Min has no bearing on timing, but adds a restriction on the common mode characteristics of these signals.

#### Table 42: Single-Ended Levels for RE\_t, RE\_c, DQS\_t, DQS\_c for NV-DDR2 (1.8V V<sub>CCQ</sub>)

| Parameter               | Symbol               | Min                         | Max            | Unit | Notes |
|-------------------------|----------------------|-----------------------------|----------------|------|-------|
| Single-Ended high level | $V_{\text{SEH(AC)}}$ | V <sub>CCQ</sub> /2 + 0.250 | See Note       | V    | 1     |
| Single-Ended low level  | V <sub>SEL(AC)</sub> | See Note                    | Vccq/2 - 0.250 | V    | 1     |

#### Note:

 These values are not defined. However, the single-ended signals (RE\_t, RE\_c, DQS\_t, and DQS\_c) need to be within the respective limits [V<sub>IH(DC)</sub> Max, V<sub>IL(DC)</sub> Min] for single-ended signals as well as the limitations for overshoot and undershoot.

#### Table 43: Single-Ended Levels for RE\_t, RE\_c, DQS\_t, DQS\_c for NV-DDR3 (1.2V V<sub>CCQ</sub>)

| Parameter               | Symbol               | Min                         | Max            | Unit | Notes |
|-------------------------|----------------------|-----------------------------|----------------|------|-------|
| Single-Ended high level | V <sub>SEH(AC)</sub> | V <sub>CCQ</sub> /2 + 0.150 | See Note       | V    | 1     |
| Single-Ended low level  | V <sub>SEL(AC)</sub> | See Note                    | Vccq/2 - 0.150 | V    | 1     |

#### Note:

 These values are not defined. However, the single-ended signals (RE\_t, RE\_c, DQS\_t, and DQS\_c) need to be within the respective limits [V<sub>IH(DC)</sub> Max, V<sub>IL(DC)</sub> Min] for single-ended signals as well as the limitations for overshoot and undershoot.

| Parameter   | Symbol              | Min                            | Max                            | Unit | Notes |
|---|---------------------|--------------------------------|--------------------------------|------|-------|
| AC differential input cross-point voltage relative to $V_{CCQ}/2$ : NV-DDR2 interface | V <sub>IX(AC)</sub> | 0.5 x V <sub>CCQ</sub> – 0.175 | 0.5 x V <sub>CCQ</sub> + 0.175 | V    | 1     |
| AC differential input cross-point voltage relative to $V_{CCQ}/2$ : NV-DDR3 interface | VIX(AC)             | 0.5 x V <sub>CCQ</sub> – 0.120 | 0.5 x V <sub>CCQ</sub> + 0.120 | V    | 1     |
| AC differential output cross-point voltage without ZQ calibration                     | V <sub>OX(AC)</sub> | 0.5 x V <sub>CCQ</sub> – 0.2   | 0.5 x V <sub>CCQ</sub> + 0.2   | V    | 2,3,4 |



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| Parameter  | Symbol              | Min                            | Max                            | Unit | Notes |
|--|---------------------|--------------------------------|--------------------------------|------|-------|
| AC differential output cross-point voltage with ZQ calibration | V <sub>OX(AC)</sub> | 0.5 x V <sub>CCQ</sub> – 0.150 | 0.5 x V <sub>CCQ</sub> + 0.150 | V    | 2,3,4 |

Note:

- 1) The typical value of  $V_{IX(AC)}$  is expected to be 0.5 x  $V_{CCQ}$  of the transmitting device.  $V_{IX(AC)}$  is expected to track variations in  $V_{CCQ}$ .  $V_{IX(AC)}$  indicates the voltage at which differential input signals shall cross.
- 2) The typical value of  $V_{OX(AC)}$  is expected to be 0.5 x  $V_{CCQ}$  of the transmitting device.  $V_{OX(AC)}$  is expected to track variations in  $V_{CCQ}$ .  $V_{OX(AC)}$  indicates the voltage at which differential input signals shall cross.
- V<sub>DX(AC)</sub> is measured with <sup>1</sup>/<sub>2</sub> DQ signals per data byte driving logic HIGH and <sup>1</sup>/<sub>2</sub> DQ signals per data byte driving logic LOW.
- 4) V<sub>OX(AC)</sub> is verified by design and characterization; it may not be subject to production testing.

### 12.8.2 Testing Conditions

The following table is to be used for the testing conditions of all the Electrical Specifications – AC Characteristics and Operating Conditions parameters.

### Table 45: Test Conditions<sup>1</sup>

| Parameter                      | Asynchronous                 | NV-DDR2 and NV-<br>DDR3 single-ended | NV-DDR2 and NV-<br>DDR3 differential                          | Notes |
|--------------------------------|------------------------------|--------------------------------------|---|-------|
| Rising input transition        | $V_{IL(DC)}$ to $V_{IH(AC)}$ | $V_{IL(DC)}$ to $V_{IH(AC)}$         | V <sub>ILdiff(DC)</sub> max to<br>V <sub>IHdiff(AC)</sub> min | 2     |
| Falling input transition       | $V_{IH(DC)}$ to $V_{IL(AC)}$ | $V_{IH(DC)}$ to $V_{IL(AC)}$         | V <sub>IHdiff(DC)</sub> max to<br>V <sub>ILdiff(AC)</sub> min | 2     |
| Input rise and fall slew rates | 1 V/ns                       | 1 V/ns                               | 2 V/ns  | -     |
| Input timing levels            | Vccq/2                       | V <sub>REFQ</sub>                    | cross-point   | -     |
| Output timing levels           | Vccq/2                       | Vπ                                   | cross-point   | 5     |
| Drive strength                 | 35 Ohms                      | 35 Ohms                              | 35 Ohms   |       |
| Output reference load          | 50 Ohms to $V_{TT}$          | 50 Ohms to VTT                       | 50 Ohms to $V_{\rm TT}$                                       | 4, 5  |

Notes:

1) Test conditions that shall be used to verify compliance with a particular timing mode for devices

2) The receiver will effectively switch as a result of the signal crossing the AC input level; it will remain in that status as long as the signal does not ring back above (below) the DC input LOW (HIGH) level.

- 3) Transmission line delay is assumed to be very small.
- 4) This test setup applies to all package configurations.

5)  $V_{TT}$  is 0.5 x  $V_{CCQ}$ .

### 12.9 AC Characteristics (Asynchronous)

|                   |                  | Мо  | de O | Мо  | de 1 | Мо  | de 2 | Мо  | de 3 | Мо  | le 4 | Мо  | de 5 |      |       |
|-------------------|------------------|-----|------|-----|------|-----|------|-----|------|-----|------|-----|------|------|-------|
| Parameter         | Symbol           | Min | Max  | Unit | Notes |
| Clock period      |                  | 1(  | 00   | 5   | 0    | 3   | 5    | 3   | 0    | 2   | 5    | 2   | 0    | ns   |       |
| Frequency         |                  | 8   | 10   | ~   | 20   | ~   | 28   | *   | 33   | ä   | 40   | 8   | 50   | MHz  |       |
| ALE to data start | <sup>t</sup> ADL | 150 | _    | 150 | _    | 150 | _    | 150 | _    | 150 | _    | 150 | _    | ns   | 1     |
| ALE hold time     | <sup>t</sup> ALH | 20  | -    | 10  | _    | 10  | -    | 5   | _    | 5   | Ι    | 5   | -    | ns   |       |
| ALE setup time    | <sup>t</sup> ALS | 50  | -    | 25  | _    | 15  | -    | 10  | -    | 10  | _    | 10  | _    | ns   |       |
| ALE to RE# delay  | <sup>t</sup> AR  | 25  | -    | 10  | _    | 10  | -    | 10  | _    | 10  | Ι    | 10  | -    | ns   |       |
| CE# access time   | <sup>t</sup> CEA | _   | 100  | _   | 45   | _   | 30   | -   | 25   | _   | 25   | -   | 25   | ns   |       |



|   |                                  | Мо  | de O | Мос | le 1 | Мо  | de 2 | Мо  | de 3 | Мо  | de 4 | Мо  | de 5 |      |       |
|---|----------------------------------|-----|------|-----|------|-----|------|-----|------|-----|------|-----|------|------|-------|
| Parameter   | Symbol                           | Min | Max  | Unit | Notes |
| CE# HIGH hold<br>time prior to<br>VOLUME SELECT<br>(E1h)                    | <sup>t</sup> CEH                 | 20  | _    | 20  | _    | 20  | Ι    | 20  | _    | 20  | _    | 20  | _    | ns   |       |
| CE# hold time   | <sup>t</sup> CH                  | 20  | _    | 10  | _    | 10  | -    | 5   | -    | 5   | -    | 5   | _    | ns   |       |
| Delay before CE#<br>HIGH for any<br>volume after a<br>volume is<br>selected | <sup>t</sup> CEVDLY              | 50  | -    | 50  | -    | 50  | -    | 50  | -    | 50  | -    | 50  | -    | ns   |       |
| CE#HIGH to<br>output High-Z   | <sup>t</sup> CHZ                 | -   | 100  | -   | 50   | -   | 50   | Ι   | 50   | -   | 30   | -   | 30   | ns   | 2     |
| CLE hold time   | <sup>t</sup> CLH                 | 20  | -    | 10  | -    | 10  | -    | 5   | -    | 5   | -    | 5   | -    | ns   |       |
| CLE to RE# delay  | <sup>t</sup> CLR                 | 20  | _    | 10  | Ι    | 10  | Ι    | 10  | _    | 10  | _    | 10  | _    | ns   |       |
| CLE setup time  | <sup>t</sup> CLS                 | 50  | _    | 25  | -    | 15  | _    | 10  | _    | 10  | _    | 10  | _    | ns   |       |
| CE# HIGH to output hold   | <sup>t</sup> COH                 | 0   | _    | 15  | Ι    | 15  | Ι    | 15  | _    | 15  | _    | 15  | _    | ns   |       |
| CE# setup time  | <sup>t</sup> CS                  | 70  | _    | 35  | -    | 25  | -    | 25  | _    | 20  | _    | 15  | _    | ns   |       |
| CE# to RE# LOW<br>or RE_t/RE_c  | <sup>t</sup> CR                  | 10  | _    | 10  | -    | 10  | -    | 10  | _    | 10  | _    | 10  | _    | ns   |       |
| CE# to RE# LOW  | <sup>t</sup> CR2                 | 100 | _    | 100 | -    | 100 | -    | 100 | -    | 100 | -    | 100 | _    | ns   |       |
| after<br>CE# has been<br>HIGH for >1µs                                      | <sup>t</sup> CR2<br>(Read<br>ID) | 150 | -    | 150 | -    | 150 | _    | 150 | -    | 150 | -    | 150 | -    | ns   | 5     |
| CE# setup time<br>for data input<br>after CE# has<br>been HIGH for<br>>1µs  | <sup>t</sup> CR3                 | 100 | _    | 100 | Η    | 100 | Η    | 100 | _    | 100 | _    | 100 | _    | ns   |       |
| Data hold time  | ťDH                              | 20  | -    | 10  | -    | 5   | -    | 5   | -    | 5   | -    | 5   | -    | ns   |       |
| Data setup time   | <sup>t</sup> DS                  | 40  | -    | 20  | -    | 15  | -    | 10  | -    | 10  | -    | 7   | -    | ns   |       |
| ENi LOW until<br>any issued<br>command is<br>ignored                        | <sup>t</sup> ENi                 | _   | 15   | _   | 15   | _   | 15   | Ι   | 15   | _   | 15   | _   | 15   | ns   |       |
| CE#LOW until<br>ENo LOW   | <sup>t</sup> ENo                 | -   | 50   | _   | 50   | -   | 50   | Ι   | 50   | -   | 50   | -   | 50   | ns   |       |
| Output High-Z to<br>RE# LOW   | <sup>t</sup> IR                  | 10  | -    | 0   | -    | 0   | Ι    | 0   | -    | 0   | -    | 0   | -    | ns   |       |
| RE# cycle time  | <sup>t</sup> RC                  | 100 | _    | 50  | Ι    | 35  | -    | 30  | -    | 25  | -    | 20  | _    | ns   |       |
| RE# access time   | <sup>t</sup> REA                 | _   | 40   | _   | 30   | -   | 25   | -   | 20   | _   | 20   | -   | 16   | ns   | 3     |
| RE# HIGH hold<br>time   | <sup>t</sup> REH                 | 30  | -    | 15  | -    | 15  | -    | 10  | -    | 10  | -    | 7   | -    | ns   | 3     |



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|   |                   | Мо  | de 0 | Мос | de 1 | Мо  | de 2 | Мо  | de 3 | Мо  | de 4 | Мо  | de 5 |      |       |
|---|-------------------|-----|------|-----|------|-----|------|-----|------|-----|------|-----|------|------|-------|
| Parameter   | Symbol            | Min | Max  | Unit | Notes |
| RE# HIGH to<br>output hold                                    | <sup>t</sup> RHOH | 0   | -    | 15  | -    | 15  | -    | 15  | -    | 15  | -    | 15  | -    | ns   | 3     |
| RE# HIGH to<br>WE# LOW  | <sup>t</sup> RHW  | 200 | -    | 100 | -    | 100 | -    | 100 | -    | 100 | -    | 100 | -    | ns   |       |
| RE# HIGH to<br>output High-Z                                  | <sup>t</sup> RHZ  | -   | 200  | -   | 100  | -   | 100  | -   | 100  | -   | 100  | -   | 100  | ns   | 2, 3  |
| RE# LOW to<br>output Hold                                     | <sup>t</sup> RLOH | 0   | -    | 0   | -    | 0   | -    | 0   | -    | 5   | -    | 5   | -    | ns   | 3     |
| RE# pulse width   | <sup>t</sup> RP   | 50  | _    | 25  | -    | 17  | -    | 15  | -    | 12  | -    | 10  | -    | ns   |       |
| Ready to RE#<br>LOW   | <sup>t</sup> RR   | 40  | -    | 20  | -    | 20  | _    | 20  | -    | 20  | -    | 20  | -    | ns   |       |
| WE# HIGH to<br>R/B# LOW                                       | <sup>t</sup> WB   | -   | 200  | -   | 100  | -   | 100  | -   | 100  | -   | 100  | -   | 100  | ns   | 4     |
| WE# cycle time  | tWC               | 100 | -    | 45  | -    | 35  | -    | 30  | -    | 25  | -    | 20  | -    | ns   |       |
| WE# HIGH hold<br>time   | tWH               | 30  | -    | 15  | -    | 15  | -    | 10  | -    | 10  | -    | 7   | -    | ns   |       |
| WE# HIGH to<br>RE# LOW  | tWHR              | 120 | _    | 80  | _    | 80  | _    | 60  | _    | 60  | _    | 60  | _    | ns   |       |
| WE# pulse width   | <sup>t</sup> WP   | 50  | _    | 25  | -    | 17  | -    | 15  | -    | 12  | -    | 10  | -    | ns   |       |
| WP# transition to<br>WE# LOW                                  | <sup>t</sup> WW   | 100 | -    | 100 | -    | 100 | -    | 100 | -    | 100 | -    | 100 | -    | ns   |       |
| Delay before next<br>command after a<br>volume is<br>selected | <sup>t</sup> VDLY | 50  | _    | 50  | _    | 50  | -    | 50  | -    | 50  | -    | 50  | -    | ns   |       |

#### Notes:

1) Timing for <sup>t</sup>ADL begins in the address cycle, on the final rising edge of WE# and ends with the first rising edge of WE# for data input. <sup>t</sup>ADL SPEC for SET FEATURES operations is 70ns.

- Data transition is measured ±200mV from steady-steady voltage with load. This parameter is sampled and not 100
  percent tested.
- 3) AC characteristics may need to be relaxed if output drive strength is not set to at least nominal.
- 4) Any command (including READ STATUS commands) cannot be issued during <sup>t</sup>WB, even if R/B# or RDY is ready.
- 5) <sup>t</sup>CR2 (MIN) is 150ns for read ID sequence only. For all other command sequences <sup>t</sup>CR2 (MIN) requirement is 100ns.

### 12.10 AC Characteristics (NV-DDR2, NV-DDR3)

#### Table 46: AC Characteristics: NV-DDR2/NV-DDR3 Command, Address, and Data for Modes 0–4

|  |                     | Мос | Mode 0 |     | de 1 | Мос | le 2 | Мос | le 3 | Мос | de 4 |      |       |
|--|---------------------|-----|--------|-----|------|-----|------|-----|------|-----|------|------|-------|
| Parameter  | Symbol              | Min | Max    | Min | Max  | Min | Max  | Min | Max  | Min | Max  | Unit | Notes |
| Clock period   |                     | 3   | 0      | 2   | 25   | 1   | 5    | 1   | 2    | 1   | 0    | ns   |       |
| Frequency  |                     | ≈   | 33     | *   | 40   | ≈   | 66   | ×   | 83   | ≈1  | .00  | MHz  |       |
| Command and Addr   | Command and Address |     |        |     |      |     |      |     |      |     |      |      |       |
| Access window of<br>DQ[7:0] from RE#<br>LOW or RE_t/RE_c | <sup>t</sup> AC     | 3   | 25     | 3   | 25   | 3   | 25   | 3   | 25   | 3   | 25   | ns   |       |





|  |                               | Мос | le 0 | Мо  | de 1 | Мос | le 2 | Мос | de 3 | Мо  | de 4 |      |       |
|--|-------------------------------|-----|------|-----|------|-----|------|-----|------|-----|------|------|-------|
| Parameter  | Symbol                        | Min | Max  | Unit | Notes |
| ALE to data loading time   | <sup>t</sup> ADL              | 150 | -    | 150 | -    | 150 | Ι    | 150 | -    | 150 | _    | ns   | 13    |
| ALE to RE# LOW or<br>RE_t/RE_c   | <sup>t</sup> AR               | 10  | -    | 10  | _    | 10  | Ι    | 10  | _    | 10  | _    | ns   |       |
| DQ hold – command,<br>address  | <sup>t</sup> CAH              | 5   | -    | 5   | -    | 5   | Ι    | 5   | -    | 5   | -    | ns   |       |
| ALE, CLE hold  | <sup>t</sup> CALH             | 5   | -    | 5   | -    | 5   | -    | 5   | -    | 5   | -    | ns   |       |
| ALE, CLE setup with ODT disabled   | <sup>t</sup> CALS             | 15  | _    | 15  | _    | 15  | Ι    | 15  | _    | 15  | _    | ns   |       |
| ALE, CLE setup with ODT enabled  | <sup>t</sup> CALS2            | 25  | -    | 25  | -    | 25  | Ι    | 25  | -    | 25  | -    | ns   |       |
| DQ setup –<br>command, address   | <sup>t</sup> CAS              | 5   | -    | 5   | -    | 5   | -    | 5   | -    | 5   | -    | ns   |       |
| CE# HIGH hold time<br>prior to VOLUME<br>SELECT (E1h)                      | <sup>t</sup> CEH              | 20  | _    | 20  | _    | 20  | -    | 20  | _    | 20  | _    | ns   |       |
| Delay before CE#<br>HIGH for any volume<br>after a volume is<br>selected   | <sup>t</sup> CEVDLY           | 50  | -    | 50  | -    | 50  | -    | 50  | _    | 50  | -    | ns   |       |
| CE# hold   | <sup>t</sup> CH               | 5   | -    | 5   | -    | 5   | -    | 5   | -    | 5   | -    | ns   |       |
| CE# HIGH to output<br>High-Z   | <sup>t</sup> CHZ              | -   | 30   | -   | 30   | -   | 30   | -   | 30   | -   | 30   | ns   | 1     |
| CLE HIGH to output<br>High-Z   | <sup>t</sup> CLHZ             | _   | 30   | _   | 30   | _   | 30   | _   | 30   | _   | 30   | ns   | 1     |
| CLE to RE# LOW or<br>RE_t/RE_c   | <sup>t</sup> CLR              | 10  | -    | 10  | -    | 10  | -    | 10  | -    | 10  | _    | ns   |       |
| CE# to RE# LOW or<br>RE_t/RE_c   | <sup>t</sup> CR               | 10  | -    | 10  | -    | 10  | Ι    | 10  | _    | 10  | _    | ns   |       |
| CE# to RE# LOW or  | <sup>t</sup> CR2              | 100 | -    | 100 | _    | 100 | 1    | 100 | _    | 100 | -    | ns   |       |
| RE_t/RE_c if CE#<br>has been HIGH for<br>>1µs                              | <sup>t</sup> CR2<br>(Read ID) | 150 | -    | 150 | -    | 150 | -    | 150 | -    | 150 | -    | ns   | 14    |
| CE# setup  | tCS                           | 20  | -    | 20  | _    | 20  | -    | 20  | -    | 20  | -    | ns   |       |
| CE# setup for data<br>output with ODT<br>disabled                          | <sup>t</sup> CS1              | 30  | -    | 30  | -    | 30  | Ι    | 30  | -    | 30  | -    | ns   |       |
| CE# setup for<br>DQS/DQ[7:0] with<br>ODT enabled                           | <sup>t</sup> CS2              | 40  | -    | 40  | -    | 40  | -    | 40  | -    | 40  | -    | ns   | 17    |
| CE# setup time to<br>DQS (DQS_t) low<br>after CE# has been<br>HIGH for>1µs | <sup>t</sup> CD               | 100 | _    | 100 | _    | 100 | _    | 100 | _    | 100 | -    | ns   |       |



|   |                              | Мос  | le 0 | Мо   | de 1 | Мос  | de 2 | Мо        | de 3 | Мо   | de 4 |      |            |
|---|------------------------------|------|------|------|------|------|------|-----------|------|------|------|------|------------|
| Parameter   | Symbol                       | Min  | Max  | Min  | Max  | Min  | Max  | Min       | Max  | Min  | Max  | Unit | Notes      |
| ALE, CLE, WE#, hold time from CE# HIGH  | <sup>t</sup> CSD             | 10   | -    | 10   | -    | 10   | -    | 10        | -    | 10   | -    | ns   |            |
| ENi LOW until any<br>issued command is<br>ignored   | <sup>t</sup> ENi             | _    | 15   | _    | 15   | Ι    | 15   | _         | 15   | Ι    | 15   | ns   |            |
| CE_# LOW until ENo<br>LOW   | <sup>t</sup> ENo             | -    | 50   | -    | 50   | -    | 50   | -         | 50   | -    | 50   | ns   |            |
| Ready to data output  | <sup>t</sup> RR              | 20   | -    | 20   | _    | 20   | _    | 20        | _    | 20   | -    | ns   |            |
| WE# HIGH to R/B#<br>LOW   | tWB                          | _    | 100  | -    | 100  | -    | 100  | -         | 100  | -    | 100  | ns   | 16         |
| WE# cycle time  | <sup>t</sup> WC              | 25   | -    | 25   | -    | 25   | -    | 25        | -    | 25   | -    | ns   |            |
| WE# pulse width   | <sup>t</sup> WH              | 11   | -    | 11   | -    | 11   | -    | 11        | -    | 11   | -    | ns   |            |
| Command cycle to data output  | tWHR                         | 80   | -    | 80   | -    | 80   | -    | 80        | -    | 80   | -    | ns   |            |
| WE# pulse width   | <sup>t</sup> WP              | 11   | -    | 11   | -    | 11   | -    | 11        | -    | 11   | -    | ns   |            |
| WP# transition to<br>command cycle  | <sup>t</sup> WW              | 100  | -    | 100  | -    | 100  | -    | 100       | -    | 100  | -    | ns   |            |
| Delay before next<br>command after a<br>volume is selected  | <sup>t</sup> VDLY            | 50   | _    | 50   | _    | 50   | _    | 50        | _    | 50   | _    | ns   |            |
| Jitter  |                              | 1    |      | 1    | 1    |      | 1    |           |      |      | 1    |      |            |
| The deviation of a<br>given<br><sup>t</sup> DQS(abs)/ <sup>t</sup> DSC(abs)<br>from a <sup>t</sup> DQS(avg)/<br><sup>t</sup> DSC(avg) | <sup>t</sup> JITper<br>(DQS) | -2.4 | 2.4  | -2.0 | 2.0  | -1.2 | 1.2  | -1.0      | 1.0  | -0.8 | 0.8  | ns   | 3, 5,<br>7 |
| The deviation of a<br>given<br><sup>t</sup> RC(abs)/ <sup>t</sup> DSC(abs)<br>from a <sup>t</sup> RC(avg)/<br>tDSC(avg)               | <sup>t</sup> JITper<br>(RE#) | -1.8 | 1.8  | -1.5 | 1.5  | -0.9 | 0.9  | -<br>0.75 | 0.75 | -0.6 | 0.6  | ns   | 3, 5,<br>7 |
| Cycle to cycle jitter<br>for DQS  | <sup>t</sup> JITcc<br>(DQS)  | -    | 4.8  | -    | 4.0  | Ι    | 2.4  | -         | 2.0  | -    | 1.6  | ns   | 3, 6       |
| Cycle to cycle jitter for RE#   | <sup>t</sup> JITcc<br>(RE#)  | _    | 3.6  | -    | 3.0  | -    | 1.8  | -         | 1.5  | -    | 1.2  | ns   | 3, 6       |
| Data Input  |                              | r    | r    | ſ    | ſ    | r    | ſ    | I         | I    | r    | T    |      |            |
| DQS setup time for<br>data input start  | <sup>t</sup> CDQSS           | 30   | _    | 30   | -    | 30   | -    | 30        | -    | 30   | -    | ns   |            |
| DQS hold time for<br>data input burst end   | <sup>t</sup> CDQSH           | 100  | -    | 100  | -    | 100  | -    | 100       | -    | 100  | -    | ns   |            |





|  |  | Мос  | le <u>0</u> | Moo  | de 1 | Mod  | le 2 | Мос  | le 3 | Мо   | le 4 |                       |       |
|--|--|------|-------------|------|------|------|------|--|------|------|------|-----------------------|-------|
| Parameter  | Symbol                                       | Min  | Max         | Min  | Max  | Min  | Max  | Min  | Max  | Min  | Max  | Unit                  | Notes |
| DQS (DQS_t) HIGH<br>and RE# (RE_t)<br>HIGH setup<br>to ALE, CLE and CE#<br>LOW during data<br>burst  | <sup>t</sup> DBS                             | 5    | _           | 5    | _    | 5    | -    | 5  | _    | 5    | -    | ns                    |       |
| Data In hold   | <sup>t</sup> DH                              | 4.0  | _           | 3.3  | —    | 2.0  | _    | 1.1  | -    | 0.7  | -    | ns                    | 10    |
| Data In setup  | <sup>t</sup> DS                              | 4.0  | -           | 3.3  | _    | 2.0  | -    | 1.1  | -    | 0.7  | -    | ns                    | 10    |
| DQ input pulse width   | <sup>t</sup> DIPW                            | 0.31 | _           | 0.31 | _    | 0.31 | -    | 0.31   | _    | 0.31 | -    | <sup>t</sup> DCS(avg) | 12    |
| DQS input high pulse width   | <sup>t</sup> DQSH                            | 0.43 | -           | 0.43 | -    | 0.43 | Ι    | 0.43   | -    | 0.43 | Ι    | <sup>t</sup> DCS(avg) |       |
| DQS input low pulse width  | <sup>t</sup> DQSL                            | 0.43 | -           | 0.43 | -    | 0.43 | Ι    | 0.43   | -    | 0.43 | Ι    | <sup>t</sup> DCS(avg) |       |
| Average DQS cycle time   | <sup>t</sup> DCS(avg)<br>or <sup>t</sup> DCS | 30   | -           | 25   | -    | 15   | Ι    | 12   | -    | 10   | Ι    | ns                    | 2     |
| Absolute DQS cycle<br>time, from rising<br>edge to rising edge                                       | <sup>t</sup> DCS(abs)                        |      |             |      |      | •    |      | <sup>t</sup> JITper(<br><sup>t</sup> JITper( |      |      |      | ns                    |       |
| ENi LOW until any<br>issued command is<br>ignored  | <sup>t</sup> ENi                             | _    | 15          | _    | 15   | _    | 15   | _  | 15   | _    | 15   | ns                    |       |
| CE# LOW until ENo<br>LOW   | <sup>t</sup> ENo                             | -    | 50          | -    | 50   | -    | 50   | -  | 50   | -    | 50   | ns                    |       |
| DQS write preamble with ODT disabled   | tWPRE  | 15   | _           | 15   | -    | 15   | -    | 15   | -    | 15   | -    | ns                    |       |
| DQS write preamble with ODT enabled  | <sup>t</sup> WPRE2                           | 25   | _           | 25   | _    | 25   | Ι    | 25   | _    | 25   | Ι    | ns                    |       |
| DQS write postamble  | tWPST  | 6.5  | -           | 6.5  | -    | 6.5  | -    | 6.5  | -    | 6.5  | -    | ns                    |       |
| DQS write postamble<br>hold time   | tWPSTH                                       | 25   | _           | 25   | _    | 25   | _    | 25   | _    | 25   | _    | ns                    |       |
| Data Output  |  |      |             |      |      |      |      |  |      |      |      |                       |       |
| Access window of DQ[7:0] from CLK  | <sup>t</sup> AC                              | 3    | 25          | 3    | 25   | 3    | 25   | 3  | 25   | 3    | 25   | ns                    |       |
| DQS (DQS_t) HIGH<br>and RE# (RE_t)<br>HIGH setup<br>to ALE, CLE, and<br>CE# LOW during<br>data burst | <sup>t</sup> DBS                             | 5    | -           | 5    | -    | 5    | Ι    | 5  | _    | 5    | Η    | ns                    |       |
| DQS-DQ skew  | <sup>t</sup> DQSQ                            | _    | 2.5         | -    | 2.0  | -    | 1.4  | -  | 1.0  | _    | 0.8  | ns                    |       |
| Access window of<br>DQS from RE# or<br>RE_t/RE_c   | <sup>t</sup> DQSRE                           | 3    | 25          | 3    | 25   | 3    | 25   | 3  | 25   | 3    | 25   | ns                    |       |
| RE# LOW to DQS or DQ[7:0] driven   | <sup>t</sup> DQSD                            | 6    | 18          | 6    | 18   | 6    | 18   | 6  | 18   | 6    | 18   | ns                    |       |



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|  |   | Мос   | le 0 | Мо    | de 1 | Мо     | de 2                 | Мос                | le 3 | Мо   | de 4 |                       |       |
|--|---|---|------|-------|------|--------|----------------------|--------------------|------|------|------|-----------------------|-------|
| Parameter  | Symbol                                      | Min   | Max  | Min   | Max  | Min    | Max                  | Min                | Max  | Min  | Max  | Unit                  | Notes |
| DQS hold time after<br>RE# LOW or<br>RE_t/RE_c<br>crosspoint     | <sup>t</sup> DQSRH                          | 5   | Ι    | 5     | _    | 5      | _                    | 5                  | _    | 5    | _    | ns                    | 15    |
| Data valid window  | <sup>t</sup> DVW                            |   |      |       | ťD∖  | W = tQ | )H - <sup>t</sup> D0 | QSQ 🛛              |      |      |      | ns                    |       |
| DQ-DQS hold, DQS<br>to first DQ to go<br>nonvalid,<br>per access | <sup>t</sup> QH                             | 0.37  | -    | 0.37  | _    | 0.37   | _                    | 0.37               | _    | 0.37 | _    | <sup>t</sup> RC (avg) | 9, 11 |
| DQS (DQS_t/DQS_c)<br>output HIGH time                            | <sup>t</sup> QSH                            | 0.37  | _    | 0.37  | -    | 0.37   | -                    | 0.37               | -    | 0.37 | -    | <sup>t</sup> RC (avg) | 9, 11 |
| DQS (DQS_t/DQS_c)<br>output LOW time                             | <sup>t</sup> QSL                            | 0.37  | Ι    | 0.37  | _    | 0.37   | _                    | 0.37               | _    | 0.37 | _    | <sup>t</sup> RC (avg) | 9, 11 |
| Average RE# cycle time   | <sup>t</sup> RC (avg)<br>or <sup>t</sup> RC | 30  | Ι    | 25    | -    | 15     | -                    | 12                 | -    | 10   | -    | ns                    | 2     |
| Absolute RE# cycle time  | <sup>t</sup> RC (abs)                       |   |      | . , . |      | •      | 5,                   | ITper(R<br>ITper(R | , ,  | ,    |      | ns                    |       |
| Average RE# HIGH<br>hold time                                    | <sup>t</sup> REH<br>(avg)                   | 0.45  | 0.55 | 0.45  | 0.55 | 0.45   | 0.55                 | 0.45               | 0.55 | 0.45 | 0.55 | <sup>t</sup> RC (avg) | 4     |
| Absolute RE# HIGH hold time                                      | <sup>t</sup> REH<br>(abs)                   | 0.43  | -    | 0.43  | -    | 0.43   | _                    | 0.43               | -    | 0.43 | -    | <sup>t</sup> RC (avg) |       |
| Data output to<br>command, address,<br>or data input             | <sup>t</sup> RHW                            | 100   | -    | 100   | _    | 100    | _                    | 100                | _    | 100  | _    | ns                    |       |
| Average RE# pulse<br>width                                       | <sup>t</sup> RP (avg)                       | 0.45  | 0.55 | 0.45  | 0.55 | 0.45   | 0.55                 | 0.45               | 0.55 | 0.45 | 0.55 | <sup>t</sup> RC (avg) | 4     |
| Absolute RE# pulse<br>width                                      | <sup>t</sup> RP (abs)                       | 0.43  | -    | 0.43  | -    | 0.43   | -                    | 0.43               | -    | 0.43 | -    | <sup>t</sup> RC (avg) |       |
| Read preamble with ODT disabled                                  | <sup>t</sup> RPRE                           | 15  | -    | 15    | -    | 15     | -                    | 15                 | -    | 15   | -    | ns                    |       |
| Read preamble with ODT enabled                                   | <sup>t</sup> RPRE2                          | 25  | _    | 25    | _    | 25     | -                    | 25                 | _    | 25   | _    | ns                    |       |
| Read postamble   | <sup>t</sup> RPST                           | 1.11       1.11 <th1.11< th="">       1.11       1.11</th1.11<> |      |       |      |        |                      |                    |      |      |      | ns                    |       |
| Read postamble hold time   | <sup>t</sup> RPSTH                          | 15  | -    | 15    | -    | 15     | -                    | 15                 | -    | 15   | -    | ns                    |       |

#### Notes:

1) <sup>t</sup>CHZ and <sup>t</sup>CLHZ are not referenced to a specific voltage level, but specify when the device output is no longer driving.

2) The parameters <sup>t</sup>RC(avg) and <sup>t</sup>DSC(avg) are the average over any 200 consecutive periods and <sup>t</sup>RC(avg)/<sup>t</sup>DSC(avg) min are the smallest rates allowed, with the exception of a deviation due to <sup>t</sup>JIT (per).

3) Input jitter is allowed provided it does not exceed values specified.

4) <sup>t</sup>REH(avg) and <sup>t</sup>RP(avg) are the average half clock period over any 200 consecutive clocks and is the smallest half period allowed, expect a deviation due to the allowed clock jitter. Input clock jitter is allowed provided it does not exceed values specified.

5) The period jitter <sup>t</sup>JIT (per) is the maximum deviation in the <sup>t</sup>RC or <sup>t</sup>DSC period from the average or nominal <sup>t</sup>RC or



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<sup>t</sup>DSC period. It is allowed in either the positive or negative direction.

- 6) The cycle-to-cycle jitter <sup>t</sup>JITcc is the amount the clock period can deviate from one cycle to the next.
- 7) The duty cycle jitter applies to either the high pulse or low pulse; however, the two cumulatively cannot exceed <sup>t</sup>JITper. As long as the absolute minimum half period <sup>t</sup>RP(abs), <sup>t</sup>REH(abs), <sup>t</sup>DQSH, or <sup>t</sup>DQSL is not less than 43 percent of the average cycle.
- 8) All timing parameter values assume differential signaling for RE# and DQS is used.
- 9) When the device is operated with input clock jitter, <sup>t</sup>QSL, <sup>t</sup>QSH, and <sup>t</sup>QH need to be derated by the actual <sup>t</sup>JITper in the input clock. (output deratings are relative to the NAND input RE pulse that generated the DQS pulse).
- 10) The <sup>t</sup>DS and <sup>t</sup>DH times listed are based on an input slew rate greater than or equal to 1 V/ns for single-ended signal, and based on an input slew rate greater than or equal to 2 V/ns for differential signal. If the input slew rate is less than 1 V/ns for single-ended signal, or less than 2 V/ns for differential signal, then the derating methodology should be used.
- 11) When the device is operated with input RE (RE\_t/RE\_c) jitter, <sup>t</sup>QSL, <sup>t</sup>QSH, and <sup>t</sup>QH need to be derated by the actual input duty cycle jitter beyond 0.45 × <sup>t</sup>RC(avg) but not exceeding 0.43 × <sup>t</sup>RC(avg). Output deratings are relative to the device input RE pulse that generated the DQS pulse.
- 12) The parameter <sup>t</sup>DIPW is defined as the pulse width of the input signal between the first crossing of  $V_{REFQ(DC)}$  and the consecutive crossing of  $V_{REFQ(DC)}$ .
- 13) <sup>t</sup>ADL SPEC for SET FEATURES operations is 70ns.
- 14) <sup>t</sup>CR2 (MIN) is 150ns for Read ID sequence only. For all other command sequences <sup>t</sup>CR2 (MIN) requirement is 100ns.
- 15) <sup>t</sup>DQSRH is only required if Matrix ODT is enabled.
- 16) Any command (including READ STATUS commands) cannot be issued during tWB, even if R/B# or RDY is ready.
- 17) <sup>t</sup>CS2 should be applied when the device has any type of ODT enabled including ODT only enabled for data input.

#### Table 47: AC Characteristics: NV-DDR2/NV-DDR3 Command, Address, and Data for Timing Modes 5–7

|   |                     | Мо  | de 5 | Мос | de 6 | Мо  | de 7 |      |       |
|---|---------------------|-----|------|-----|------|-----|------|------|-------|
| Parameter   | Symbol              | Min | Max  | Min | Max  | Min | Max  | Unit | Notes |
| Clock period  |                     | 7   | .5   | e   | 5    |     | 5    | ns   |       |
| Frequency   |                     | ≈1  | .33  | ≈1  | .66  | ×2  | 200  | MHz  |       |
| Command and Address   |                     |     |      |     |      |     |      |      |       |
| Access window of DQ[7:0] from RE#<br>LOW or RE_t/RE_c           | <sup>t</sup> AC     | 3   | 25   | 3   | 25   | 3   | 25   | ns   |       |
| ALE to data loading time  | <sup>t</sup> ADL    | 150 | -    | 150 | -    | 150 | -    | ns   | 13    |
| ALE to RE# LOW or RE_t/RE_c                                     | <sup>t</sup> AR     | 10  | -    | 10  | -    | 10  | -    | ns   |       |
| DQ hold – command, address                                      | <sup>t</sup> CAH    | 5   | -    | 5   | -    | 5   | -    | ns   |       |
| ALE, CLE hold   | <sup>t</sup> CALH   | 5   | -    | 5   | -    | 5   | -    | ns   |       |
| ALE, CLE setup with ODT disabled                                | <sup>t</sup> CALS   | 15  | _    | 15  | _    | 15  | -    | ns   |       |
| ALE, CLE setup with ODT enabled                                 | <sup>t</sup> CALS2  | 25  | _    | 25  | _    | 25  | -    | ns   |       |
| DQ setup – command, address                                     | <sup>t</sup> CAS    | 5   | -    | 5   | -    | 5   | -    | ns   |       |
| CE# HIGH hold time  | <sup>t</sup> CEH    | 20  | _    | 20  | _    | 20  | -    | ns   |       |
| Delay before CE# HIGH for any volume after a volume is selected | <sup>t</sup> CEVDLY | 50  | -    | 50  | -    | 50  | -    | ns   |       |
| CE# hold  | <sup>t</sup> CH     | 5   | -    | 5   | -    | 5   | -    | ns   |       |
| CE# HIGH to output High-Z                                       | <sup>t</sup> CHZ    | -   | 30   | -   | 30   | -   | 30   | ns   | 1     |
| CLE HIGH to output High-Z                                       | <sup>t</sup> CLHZ   | -   | 30   | -   | 30   | -   | 30   | ns   | 1     |
| CLE to RE# LOW or RE_t/RE_c                                     | <sup>t</sup> CLR    | 10  | _    | 10  | -    | 10  | -    | ns   |       |
| CE# to RE# LOW or RE_t/RE_c                                     | <sup>t</sup> CR     | 10  | -    | 10  | -    | 10  | -    | ns   |       |
|   | <sup>t</sup> CR2    | 100 | -    | 100 | -    | 100 | -    | ns   |       |



|   |                            | Мо    | le 5     | Мос   | le 6   | Мо       | de 7     |                       |          |
|---|----------------------------|-------|----------|-------|--|----------|----------|-----------------------|----------|
| Parameter   | Symbol                     | Min   | Max      | Min   | Max  | Min      | Max      | Unit                  | Notes    |
| CE# to RE# LOW or RE_t/RE_c if<br>CE# has been HIGH for >1µs  | <sup>t</sup> CR2 (Read ID) | 150   | _        | 150   | -  | 150      | -        | ns                    | 14       |
| CE# setup   | tCS                        | 20    | -        | 20    | -  | 20       | -        | ns                    |          |
| CE# setup for data output with ODT disabled   | <sup>t</sup> CS1           | 30    | -        | 30    | -  | 30       | -        | ns                    |          |
| CE# setup for DQS/DQ[7:0] with ODT enabled  | <sup>t</sup> CS2           | 40    | -        | 40    | -  | 40       | -        | ns                    | 17       |
| CE# setup time to DQS (DQS_t) low<br>after CE# has been HIGH for>1µs  | <sup>t</sup> CD            | 100   | _        | 100   | Ι  | 100      | Ι        | ns                    |          |
| ALE, CLE, WE#, hold time from CE#<br>HIGH   | <sup>t</sup> CSD           | 10    | -        | 10    | Ι  | 10       | Ι        | ns                    |          |
| ENi LOW until any issued command is ignored   | <sup>t</sup> ENi           | -     | 15       | -     | 15   | -        | 15       | ns                    |          |
| CE_# LOW until ENo LOW  | <sup>t</sup> ENo           | _     | 50       | _     | 50   | -        | 50       | ns                    |          |
| Ready to data output  | <sup>t</sup> RR            | 20    | _        | 20    | _  | 20       | _        | ns                    |          |
| WE# HIGH to R/B# LOW  | <sup>t</sup> WB            | _     | 100      | _     | 100  | _        | 100      | ns                    | 16       |
| WE# cycle time  | tWC                        | 25    | _        | 25    | _  | 25       | _        | ns                    |          |
| WE# pulse width   | <sup>t</sup> WH            | 11    | _        | 11    | _  | 11       | _        | ns                    |          |
| Command cycle to data output  | tWHR                       | 80    | _        | 80    | _  | 80       | _        | ns                    |          |
| WE# pulse width   | <sup>t</sup> WP            | 11    | _        | 11    | _  | 11       | _        | ns                    |          |
| WP# transition to command cycle   | tWW                        | 100   | _        | 100   | _  | 100      | _        | ns                    |          |
| Delay before next command after a volume is selected  | <sup>t</sup> VDLY          | 50    | -        | 50    | _  | 50       | _        | ns                    |          |
| Jitter  |                            | I     | <u> </u> | I     | <u>.                                    </u> | <u> </u> | <u> </u> |                       | <u> </u> |
| The deviation of a given <sup>t</sup> DQS(abs)/<br><sup>t</sup> DSC(abs) from a <sup>t</sup> DQS(avg)/<br><sup>t</sup> DSC(avg) | <sup>t</sup> JITper (DQS)  | -0.6  | 0.6      | -0.48 | 0.48   | -0.40    | 0.40     | ns                    | 3,5,7    |
| The deviation of a given <sup>t</sup> RC(abs)/<br><sup>t</sup> DSC(abs) from a <sup>t</sup> RC(avg)/ <sup>t</sup> DSC(avg)      | <sup>t</sup> JITper (RE#)  | -0.45 | 0.45     | -0.36 | 0.36   | -0.30    | 0.30     | ns                    | 3,5,7    |
| Cycle to cycle jitter for DQS   | <sup>t</sup> JITcc (DQS)   | -     | 1.2      | -     | 0.96   | -        | 0.80     | ns                    | 3,6      |
| Cycle to cycle jitter for RE#   | <sup>t</sup> JITcc (RE#)   | _     | 0.9      | _     | 0.72   | -        | 0.60     | ns                    | 3,6      |
| Data Input  |                            |       |          |       |  |          |          |                       |          |
| DQS setup time for data input start   | <sup>t</sup> CDQSS         | 30    | _        | 30    | Ι  | 30       | Ι        | ns                    |          |
| DQS hold time for data input burst end  | <sup>t</sup> CDQSH         | 100   | _        | 100   | -  | 100      | Ι        | ns                    |          |
| DQS (DQS_t) HIGH and RE# (RE_t)<br>HIGH setup to ALE, CLE and CE#<br>LOW during data burst                                      | <sup>t</sup> DBS           | 5     | _        | 5     | -  | 5        | -        | ns                    |          |
| Data In hold  | <sup>t</sup> DH            | 0.6   | -        | 0.55  | -  | 0.40     | -        | ns                    | 10       |
| Data In setup   | <sup>t</sup> DS            | 0.6   | -        | 0.55  | -  | 0.40     | -        | ns                    | 10       |
| DQ input pulse width  | <sup>t</sup> DIPW          | 0.31  | -        | 0.31  | -  | 0.31     | -        | <sup>t</sup> DCS(avg) | 12       |



|   |  | Мо   | de 5 | Мос     | de 6                 | Mo                     | de 7 |                       |       |
|---|--|------|------|---------|----------------------|------------------------|------|-----------------------|-------|
| Parameter   | Symbol                                       | Min  | Max  | Min     | Max                  | Min                    | Max  | Unit                  | Notes |
| DQS input high pulse width  | <sup>t</sup> DQSH                            | 0.43 | -    | 0.43    | -                    | 0.43                   | -    | <sup>t</sup> DCS(avg) |       |
| DQS input low pulse width   | <sup>t</sup> DQSL                            | 0.43 | -    | 0.43    | 1                    | 0.43                   | -    | <sup>t</sup> DCS(avg) |       |
| Average DQS cycle time  | <sup>t</sup> DCS(avg) or<br><sup>t</sup> DCS | 7.5  | -    | 6       | Ι                    | 5                      | -    | ns                    | 2     |
| Absolute DQS cycle time, from rising edge to rising edge                                    | <sup>t</sup> DCS(abs)                        | •    | ,    | •       | 0,                   | IITper(D0<br>IITper(D0 | • /  | ns                    |       |
| ENi LOW until any issued command is ignored   | <sup>t</sup> ENi                             | -    | 15   | -       | 15                   | -                      | 15   | ns                    |       |
| CE# LOW until ENo LOW   | <sup>t</sup> ENo                             | -    | 50   | -       | 50                   | -                      | 50   | ns                    |       |
| DQS write preamble with ODT disabled  | tWPRE  | 15   | -    | 15      | -                    | 15                     | -    | ns                    |       |
| DQS write preamble with ODT enabled   | <sup>t</sup> WPRE2                           | 25   | -    | 25      | -                    | 25                     | -    | ns                    |       |
| DQS write postamble   | tWPST  | 6.5  | -    | 6.5     | 1                    | 6.5                    | -    | ns                    |       |
| DQS write postamble hold time   | tWPSTH                                       | 25   | -    | 25      | -                    | 25                     | -    | ns                    |       |
| Data Output   |  |      |      |         |                      |                        |      |                       |       |
| Access window of DQ[7:0] from CLK   | <sup>t</sup> AC                              | 3    | 25   | 3       | 25                   | 3                      | 25   | ns                    |       |
| DQS (DQS_t) HIGH and RE# (RE_t)<br>HIGH setup to ALE, CLE, and CE#<br>LOW during data burst | <sup>t</sup> DBS                             | 5    | -    | 5       | -                    | 5                      | -    | ns                    |       |
| DQS-DQ skew   | <sup>t</sup> DQSQ                            | _    | 0.6  | -       | 0.5                  | -                      | 0.4  | ns                    |       |
| Access window of DQS from RE# or<br>RE_t/RE_c   | <sup>t</sup> DQSRE                           | 3    | 25   | 3       | 25                   | 3                      | 25   | ns                    |       |
| RE# LOW to DQS or DQ[7:0] driven  | <sup>t</sup> DQSD                            | 6    | 18   | 6       | 18                   | 6                      | 18   | ns                    |       |
| DQS hold time after RE# LOW or<br>RE_t/RE_c crosspoint                                      | <sup>t</sup> DQSRH                           | 5    | _    | 5       | -                    | 5                      | _    | ns                    | 15    |
| Data valid window   | <sup>t</sup> DVW                             |      | ťĽ   | VW = tC | QH - <sup>t</sup> DC | ĮSQ                    |      | ns                    |       |
| DQ-DQS hold, DQS to first DQ to go nonvalid, per access                                     | <sup>t</sup> QH                              | 0.37 | -    | 0.37    | -                    | 0.37                   | -    | <sup>t</sup> RC (avg) | 9,11  |
| DQS (DQS_t/DQS_c) output HIGH time  | <sup>t</sup> QSH                             | 0.37 | _    | 0.37    | _                    | 0.37                   | _    | <sup>t</sup> RC (avg) | 9,11  |
| DQS (DQS_t/DQS_c) output LOW time   | <sup>t</sup> QSL                             | 0.37 | _    | 0.37    | _                    | 0.37                   | _    | <sup>t</sup> RC (avg) | 9,11  |
| Average RE# cycle time  | <sup>t</sup> RC (avg) or <sup>t</sup> RC     | 7.5  | _    | 6       | I                    | 5                      | _    | ns                    | 2     |
| Absolute RE# cycle time   | <sup>t</sup> RC (abs)                        | •    |      | •       |                      | Tper(RE                |      | ns                    |       |
| Average RE# HIGH hold time  | <sup>t</sup> REH (avg)                       | 0.45 | 0.55 | 0.45    | 0.55                 | 0.45                   | 0.55 | <sup>t</sup> RC(avg)  | 4     |
| Absolute RE# HIGH hold time   | <sup>t</sup> REH (abs)                       | 0.43 | -    | 0.43    | -                    | 0.43                   | -    | <sup>t</sup> RC(avg)  |       |
| Data output to command, address, or data input  | <sup>t</sup> RHW                             | 100  | -    | 100     | -                    | 100                    | -    | ns                    |       |
| Average RE# pulse width   | <sup>t</sup> RP (avg)                        | 0.45 | 0.55 | 0.45    | 0.55                 | 0.45                   | 0.55 | <sup>t</sup> RC(avg)  | 4     |



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|                                 |                       | Mode 5  |     | Mode 6 |     | e 6 Mode 7 |     |                      |       |
|---------------------------------|-----------------------|---|-----|--------|-----|------------|-----|----------------------|-------|
| Parameter                       | Symbol                | Min   | Max | Min    | Max | Min        | Max | Unit                 | Notes |
| Absolute RE# pulse width        | <sup>t</sup> RP (abs) | 0.43  | -   | 0.43   | -   | 0.43       | -   | <sup>t</sup> RC(avg) |       |
| Read preamble with ODT disabled | <sup>t</sup> RPRE     | 15  | -   | 15     | -   | 15         | -   | ns                   |       |
| Read preamble with ODT enabled  | <sup>t</sup> RPRE2    | 25  | -   | 25     | -   | 25         | -   | ns                   |       |
| Read postamble                  | <sup>t</sup> RPST     | <sup>t</sup> RPST (MIN) = <sup>t</sup> DQSRE + 0.5 × <sup>t</sup> RC<br><sup>t</sup> RPST (MAX) = - |     |        |     |            |     | ns                   |       |
| Read postamble hold time        | <sup>t</sup> RPSTH    | 15  | -   | 15     | -   | 15         | -   | ns                   |       |

#### Notes:

- 1) <sup>t</sup>CHZ and <sup>t</sup>CLHZ are not referenced to a specific voltage level, but specify when the device output is no longer driving.
- 2) The parameters <sup>t</sup>RC(avg) and <sup>t</sup>DSC(avg) are the average over any 200 consecutive periods and <sup>t</sup>RC(avg)/<sup>t</sup>DSC(avg) min are the smallest rates allowed, with the exception of a deviation due to <sup>t</sup>JIT (per).
- 3) Input jitter is allowed provided it does not exceed values specified.
- 4) tREH(avg) and tRP(avg) are the average half clock period over any 200 consecutive clocks and is the smallest half period allowed, expect a deviation due to the allowed clock jitter. Input clock jitter is allowed provided it does not exceed values specified.
- 5) The period jitter <sup>t</sup>JIT (per) is the maximum deviation in the <sup>t</sup>RC or <sup>t</sup>DSC period from the average or nominal <sup>t</sup>RC or <sup>t</sup>DSC period. It is allowed in either the positive or negative direction.
- 6) The cycle-to-cycle jitter <sup>t</sup>JITcc is the amount the clock period can deviate from one cycle to the next.
- 7) The duty cycle jitter applies to either the high pulse or low pulse; however, the two cumulatively cannot exceed <sup>t</sup>JITper. As long as the absolute minimum half period <sup>t</sup>RP(abs), <sup>t</sup>REH(abs), <sup>t</sup>DQSH, or <sup>t</sup>DQSL is not less than 43 percent of the average cycle.
- 8) All timing parameter values assume differential signaling for RE# and DQS is used.
- 9) When the device is operated with input clock jitter, <sup>t</sup>QSL, <sup>t</sup>QSH, and <sup>t</sup>QH need to be derated by the actual <sup>t</sup>JITper in the input clock. (output deratings are relative to the NAND input RE pulse that generated the DQS pulse).
- 10) The <sup>t</sup>DS and <sup>t</sup>DH times listed are based on an input slew rate greater than or equal to 1 V/ns for single-ended signal, and based on an input slew rate greater than or equal to 2 V/ns for differential signal. If the input slew rate is less than 1 V/ns for single-ended signal, or less than 2 V/ns for differential signal, then the derating methodology should be used.
- 11) When the device is operated with input RE (RE\_t/RE\_c) jitter, <sup>t</sup>QSL, <sup>t</sup>QSH, and <sup>t</sup>QH need to be derated by the actual input duty cycle jitter beyond 0.45 × <sup>t</sup>RC(avg) but not exceeding 0.43 × <sup>t</sup>RC(avg). Output deratings are relative to the device input RE pulse that generated the DQS pulse.
- 12) The parameter <sup>t</sup>DIPW is defined as the pulse width of the input signal between the first crossing of  $V_{REFQ(DC)}$  and the consecutive crossing of  $V_{REFQ(DC)}$ .
- 13) <sup>t</sup>ADL SPEC for SET FEATURES operations is 70ns.
- 14) <sup>t</sup>CR2 (MIN) is 150ns for Read ID sequence only. For all other command sequences <sup>t</sup>CR2 (MIN) requirement is 100ns.
- 15) <sup>t</sup>DQSRH is only required if Matrix ODT is enabled.
- 16) Any command (including READ STATUS commands) cannot be issued during <sup>t</sup>WB, even if R/B# or RDY is ready.
- 17) <sup>t</sup>CS2 should be applied when the device has any type of ODT enabled including ODT only enabled for data input.
- 18) Parameters tDQSQ and tQH are used to calculate overall <sup>t</sup>DVW (<sup>t</sup>DVW = <sup>t</sup>QH <sup>t</sup>DQSQ). Since data eye training to optimize strobe placement is expected at high I/O speeds (≥533 MT/s), <sup>t</sup>DQSQ and <sup>t</sup>QH may borrow time from each other without changing <sup>t</sup>DVW. For example, if there exists X ps of margin on <sup>t</sup>DQSQ, then <sup>t</sup>QH can be provided with an additional X ps without changing the value of <sup>t</sup>DVW. When timing margin is borrowed from <sup>t</sup>DQSQ to provide additional timing for <sup>t</sup>QH, the same amount of timing margin can be used for additional timing for <sup>t</sup>QSL or <sup>t</sup>QSH.



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### Table 48: AC Characteristics: NV-DDR2/NV-DDR3 Command, Address, and Data for Timing Modes 8–9

|  |                               | Мо  | de 8 | Мос | le 9 |      | Notes |
|--|-------------------------------|-----|------|-----|------|------|-------|
| Parameter  | Symbol                        | Min | Max  | Min | Max  | Unit |       |
| Clock period   |                               | 3.  | .75  | 3   | }    | ns   |       |
| Frequency  |                               | ≈.  | 266  | ≈3  | 33   | MHz  |       |
| Command and Address  |                               |     |      |     |      |      |       |
| Access window of DQ[7:0] from RE#<br>LOW or RE_t/RE_c                | <sup>t</sup> AC               | 3   | 25   | 3   | 25   | ns   |       |
| ALE to data loading time   | <sup>t</sup> ADL              | 150 | _    | 150 | _    | ns   | 13    |
| ALE to RE# LOW or RE_t/RE_c  | <sup>t</sup> AR               | 10  | _    | 10  | _    | ns   |       |
| DQ hold – command, address   | <sup>t</sup> CAH              | 5   | _    | 5   | _    | ns   |       |
| ALE, CLE hold  | <sup>t</sup> CALH             | 5   | _    | 5   | _    | ns   |       |
| ALE, CLE setup with ODT disabled                                     | <sup>t</sup> CALS             | 15  | _    | 15  | _    | ns   |       |
| ALE, CLE setup with ODT enabled                                      | <sup>t</sup> CALS2            | 25  | -    | 25  | _    | ns   |       |
| DQ setup – command, address  | <sup>t</sup> CAS              | 5   | _    | 5   | _    | ns   |       |
| CE# HIGH hold time   | <sup>t</sup> CEH              | 20  | _    | 20  | _    | ns   |       |
| Delay before CE# HIGH for any volume after a volume is selected      | <sup>t</sup> CEVDLY           | 50  | _    | 50  | -    | ns   |       |
| CE# hold   | <sup>t</sup> CH               | 5   | _    | 5   | _    | ns   |       |
| CE# HIGH to output High-Z  | <sup>t</sup> CHZ              | -   | 30   | -   | 30   | ns   | 1     |
| CLE HIGH to output High-Z  | <sup>t</sup> CLHZ             | -   | 30   | -   | 30   | ns   | 1     |
| CLE to RE# LOW or RE_t/RE_c  | <sup>t</sup> CLR              | 10  | -    | 10  | -    | ns   |       |
| CE# to RE# LOW or RE_t/RE_c  | <sup>t</sup> CR               | 10  | -    | 10  | -    | ns   |       |
|  | <sup>t</sup> CR2              | 100 | _    | 100 | _    | ns   |       |
| CE# to RE# LOW or RE_t/RE_c if CE#<br>has been HIGH for >1µs         | <sup>t</sup> CR2 (Read<br>ID) | 150 | _    | 150 | _    | ns   | 14    |
| CE# setup  | tCS                           | 20  | _    | 20  | _    | ns   |       |
| CE# setup for data output with ODT disabled                          | <sup>t</sup> CS1              | 30  | _    | 30  | _    | ns   |       |
| CE# setup for DQS/DQ[7:0] with ODT enabled                           | <sup>t</sup> CS2              | 40  | -    | 40  | _    | ns   | 18    |
| CE# setup time to DQS (DQS_t) low after<br>CE# has been HIGH for>1µs | <sup>t</sup> CD               | 100 | -    | 100 | _    | ns   |       |
| ALE, CLE, WE#, hold time from CE#<br>HIGH                            | <sup>t</sup> CSD              | 10  | -    | 10  | -    | ns   |       |
| ENi LOW until any issued command is ignored                          | <sup>t</sup> ENi              | -   | 15   | _   | 15   | ns   |       |
| CE_# LOW until ENo LOW   | <sup>t</sup> ENo              | -   | 50   | -   | 50   | ns   |       |
| Ready to data output   | <sup>t</sup> RR               | 20  | _    | 20  | _    | ns   |       |
| WE# HIGH to R/B# LOW   | <sup>t</sup> WB               | _   | 100  | -   | 100  | ns   | 17    |
| WE# cycle time   | tWC                           | 25  | _    | 25  | _    | ns   |       |
| WE# pulse width  | tWH                           | 11  | _    | 11  | _    | ns   |       |



|  | Mode 8                                       |        | de 8  | Mod  | le 9 |                        |       |
|--|--|--------|-------|--|------|------------------------|-------|
| Parameter  | Symbol                                       | Min    | Max   | Min  | Max  | Unit                   | Notes |
| Command cycle to data output   | <sup>t</sup> WHR                             | 80     | -     | 80   | -    | ns                     |       |
| WE# pulse width  | <sup>t</sup> WP                              | 11     | -     | 11   | _    | ns                     |       |
| WP# transition to command cycle  | tWW  | 100    | _     | 100  | _    | ns                     |       |
| Delay before next command after a volume is selected   | <sup>t</sup> VDLY                            | 50     | _     | 50   | _    | ns                     |       |
| Jitter   |  | •      | •     | L  |      | •                      |       |
| The deviation of a given <sup>t</sup> DQS(abs)/<br><sup>t</sup> DSC(abs) from a <sup>t</sup> DQS(avg)/ <sup>t</sup> DSC(avg) | <sup>t</sup> JITper<br>(DQS)                 | -0.30  | 0.30  | -0.24  | 0.24 | ns                     | 3,5,7 |
| The deviation of a given <sup>t</sup> RC(abs)/<br><sup>t</sup> DSC(abs) from a <sup>t</sup> RC(avg)/ <sup>t</sup> DSC(avg)   | <sup>t</sup> JITper<br>(RE#)                 | -0.225 | 0.225 | -0.18  | 0.18 | ns                     | 3,5,7 |
| Cycle to cycle jitter for DQS  | <sup>t</sup> JITcc<br>(DQS)                  | -      | 0.6   | -  | 0.48 | ns                     | 3,6   |
| Cycle to cycle jitter for RE#  | <sup>t</sup> JITcc<br>(RE#)                  | _      | 0.45  | _  | 0.36 | ns                     | 3,6   |
| Data Input   |  | •      | •     | L  |      | •                      |       |
| DQS setup time for data input start  | <sup>t</sup> CDQSS                           | 30     | _     | 30   | _    | ns                     |       |
| DQS hold time for data input burst end   | <sup>t</sup> CDQSH                           | 100    | _     | 100  | _    | ns                     |       |
| DQS (DQS_t) HIGH and RE# (RE_t) HIGH<br>setup to ALE, CLE and CE# LOW during<br>data burst                                   | <sup>t</sup> DBS                             | 5      | _     | 5  | _    | ns                     |       |
| Data In hold   | <sup>t</sup> DH                              | 0.30   | -     | 0.24   | -    | ns                     | 10    |
| Data In setup  | <sup>t</sup> DS                              | 0.30   | -     | 0.24   | -    | ns                     | 10    |
| DQ input pulse width   | <sup>t</sup> DIPW                            | 0.31   | -     | 0.31   | -    | <sup>t</sup> DCS (avg) | 12    |
| DQS input high pulse width   | <sup>t</sup> DQSH                            | 0.43   | -     | 0.43   | -    | <sup>t</sup> DCS (avg) |       |
| DQS input low pulse width  | <sup>t</sup> DQSL                            | 0.43   | -     | 0.43   | -    | <sup>t</sup> DCS (avg) |       |
| Average DQS cycle time   | <sup>t</sup> DCS(avg)<br>or <sup>t</sup> DCS | 3.75   | _     | 3  | _    | ns                     | 2     |
| Absolute DQS cycle time, from rising edge to rising edge   | <sup>t</sup> DCS(abs)                        | . ,    | •     | avg) + <sup>t</sup> JITper<br>avg) + <sup>t</sup> JITper |      | ns                     |       |
| ENi LOW until any issued command is<br>ignored   | <sup>t</sup> ENi                             | -      | 15    | -  | 15   | ns                     |       |
| CE# LOW until ENo LOW  | <sup>t</sup> ENo                             | _      | 50    | _  | 50   | ns                     |       |
| DQS write preamble with ODT disabled   | tWPRE  | 15     | _     | 15   | -    | ns                     |       |
| DQS write preamble with ODT enabled  | <sup>t</sup> WPRE2                           | 25     | _     | 25   | _    | ns                     |       |
| DQS write postamble  | tWPST  | 6.5    | -     | 6.5  | _    | ns                     |       |
| DQS write postamble hold time  | tWPSTH                                       | 25     | -     | 25   | _    | ns                     |       |
| Data Output  |  |        |       |  |      |                        |       |
| Access window of DQ[7:0] from CLK  | <sup>t</sup> AC                              | 3      | 25    | 3  | 25   | ns                     |       |
| DQS (DQS_t) HIGH and RE# (RE_t) HIGH setup to ALE, CLE, and CE# LOW during data burst  | <sup>t</sup> DBS                             | 5      | -     | 5  | -    | ns                     |       |



|  |   | Mode 8           |  | Mod                    | le 9 |                       |       |
|--|---|------------------|--|------------------------|------|-----------------------|-------|
| Parameter  | Symbol                                      | Min              | Max  | Min                    | Max  | Unit                  | Notes |
| DQS-DQ skew  | <sup>t</sup> DQSQ                           | -                | 0.350  | _                      | 0.30 | ns                    |       |
| Access window of DQS from RE# or<br>RE_t/RE_c              | <sup>t</sup> DQSRE                          | 3                | 25   | 3                      | 25   | ns                    |       |
| RE# LOW to DQS or DQ[7:0] driven                           | <sup>t</sup> DQSD                           | 6                | 18   | 6                      | 18   | ns                    |       |
| DQS hold time after RE# LOW or<br>RE_t/RE_c crosspoint     | <sup>t</sup> DQSRH                          | 5                | -  | 5                      | -    | ns                    | 15    |
| Data valid window  | <sup>t</sup> DVW                            |                  | <sup>t</sup> DVW = <sup>t</sup> O                    | QH - <sup>t</sup> DQSQ |      | ns                    |       |
| DQ-DQS hold, DQS to first DQ to go<br>nonvalid, per access | ţQH   | 0.37             | -  | 0.37                   | -    | <sup>t</sup> RC (avg) | 9,11  |
| DQS (DQS_t/DQS_c) output HIGH time                         | <sup>t</sup> QSH                            | 0.37             | -  | 0.37                   | -    | <sup>t</sup> RC (avg) | 9,11  |
| DQS (DQS_t/DQS_c) output LOW time                          | tQSL  | 0.37             | _  | 0.37                   | -    | <sup>t</sup> RC (avg) | 9,11  |
| Average RE# cycle time                                     | <sup>t</sup> RC (avg) or<br><sup>t</sup> RC | 3.75             | -  | 3                      | _    | ns                    | 2     |
| Absolute RE# cycle time                                    | <sup>t</sup> RC (abs)                       | . ,              | MIN = <sup>t</sup> RC(av<br>MAX = <sup>t</sup> RC(av | ns                     |      |                       |       |
| Average RE# HIGH hold time                                 | <sup>t</sup> REH (avg)                      | 0.45             | 0.55   | 0.45                   | 0.55 | <sup>t</sup> RC(avg)  | 4     |
| Absolute RE# HIGH hold time                                | <sup>t</sup> REH (abs)                      | 0.43             | -  | 0.43                   | -    | <sup>t</sup> RC(avg)  |       |
| Data output to command, address, or data input             | <sup>t</sup> RHW                            | 100              | -  | 100                    | _    | ns                    |       |
| Average RE# pulse width                                    | <sup>t</sup> RP (avg)                       | 0.45             | 0.55   | 0.45                   | 0.55 | <sup>t</sup> RC(avg)  | 4     |
| Absolute RE# pulse width                                   | <sup>t</sup> RP (abs)                       | 0.43             | Ι  | 0.43                   | -    | <sup>t</sup> RC(avg)  |       |
| Read preamble with ODT disabled                            | <sup>t</sup> RPRE                           | 15               | -  | 15                     | -    | ns                    |       |
| Read preamble with ODT enabled                             | <sup>t</sup> RPRE2                          | 25               | -  | 25                     | _    | ns                    |       |
| Read postamble   | <sup>t</sup> RPST                           | <sup>t</sup> RPS | T (MIN) = <sup>t</sup> D<br><sup>t</sup> RPST (I     | ns                     |      |                       |       |
| Read postamble hold time                                   | <sup>t</sup> RPSTH                          | 15               | _  | 15                     | _    | ns                    |       |

#### Notes:

1) <sup>t</sup>CHZ and <sup>t</sup>CLHZ are not referenced to a specific voltage level, but specify when the device output is no longer driving.

- The parameters <sup>t</sup>RC(avg) and <sup>t</sup>DSC(avg) are the average over any 200 consecutive periods and <sup>t</sup>RC(avg)/<sup>t</sup>DSC(avg) min are the smallest rates allowed, with the exception of a deviation due to <sup>t</sup>JIT (per).
- 3) Input jitter is allowed provided it does not exceed values specified.
- 4) <sup>t</sup>REH(avg) and <sup>t</sup>RP(avg) are the average half clock period over any 200 consecutive clocks and is the smallest half period allowed, expect a deviation due to the allowed clock jitter. Input clock jitter is allowed provided it does not exceed values specified.
- 5) The period jitter <sup>t</sup>JIT (per) is the maximum deviation in the <sup>t</sup>RC or <sup>t</sup>DSC period from the average or nominal <sup>t</sup>RC or <sup>t</sup>DSC period. It is allowed in either the positive or negative direction.
- 6) The cycle-to-cycle jitter <sup>t</sup>JITcc is the amount the clock period can deviate from one cycle to the next.
- 7) The duty cycle jitter applies to either the high pulse or low pulse; however, the two cumulatively cannot exceed <sup>t</sup>JITper. As long as the absolute minimum half period <sup>t</sup>RP(abs), <sup>t</sup>REH(abs), <sup>t</sup>DQSH, or <sup>t</sup>DQSL is not less than 43 percent of the average cycle.
- 8) All timing parameter values assume differential signaling for RE# and DQS is used.
- 9) When the device is operated with input clock jitter, <sup>t</sup>QSL, <sup>t</sup>QSH, and <sup>t</sup>QH need to be derated by the actual <sup>t</sup>JITper in the input clock. (output deratings are relative to the NAND input RE pulse that generated the DQS pulse).
- 10) The <sup>t</sup>DS and <sup>t</sup>DH times listed are based on an input slew rate greater than or equal to 1 V/ns for single-ended signal, and based on an input slew rate greater than or equal to 2 V/ns for differential signal. If the input slew rate is less than 1 V/ns for single-ended signal, or less than 2 V/ns for differential signal, then the derating methodology should be used.
- 11) When the device is operated with input RE (RE\_t/RE\_c) jitter, <sup>t</sup>QSL, <sup>t</sup>QSH, and <sup>t</sup>QH need to be derated by the actual



### 4Tb TLC NAND Flash UT81NDQ512G8T

input duty cycle jitter beyond  $0.45 \times {}^{t}RC(avg)$  but not exceeding  $0.43 \times {}^{t}RC(avg)$ . Output deratings are relative to the device input RE pulse that generated the DQS pulse.

- 12) The parameter <sup>t</sup>DIPW is defined as the pulse width of the input signal between the first crossing of  $V_{REFQ(DC)}$  and the consecutive crossing of  $V_{REFQ(DC)}$ .
- 13) <sup>t</sup>ADL SPEC for SET FEATURES operations is 70ns.
- 14) <sup>t</sup>CR2 (MIN) is 150ns for Read ID sequence only. For all other command sequences <sup>t</sup>CR2 (MIN) requirement is 100ns.
- 15) <sup>t</sup>DQSRH is only required if Matrix ODT is enabled.
- 16) Parameters <sup>t</sup>DQSQ and <sup>t</sup>QH are used to calculate overall <sup>t</sup>DVW (tDVW = <sup>t</sup>QH <sup>t</sup>DQSQ). Since data eye training to optimize strobe placement is expected at high I/O speeds (≥533 MT/s), <sup>t</sup>DQSQ and <sup>t</sup>QH may borrow time from each other without changing <sup>t</sup>DVW. For example, if there exists X ps of margin on <sup>t</sup>DQSQ, then <sup>t</sup>QH can be provided with an additional X ps without changing the value of <sup>t</sup>DVW. When timing margin is borrowed from <sup>t</sup>DQSQ to provide additional timing for <sup>t</sup>QH, the same amount of timing margin can be used for additional timing for <sup>t</sup>QSL or <sup>t</sup>QSH.
- 17) Any command (including READ STATUS commands) cannot be issued during <sup>t</sup>WB, even if R/B# or RDY is ready.
- 18) <sup>t</sup>CS2 should be applied when the device has any type of ODT enabled including ODT only enabled for data input.

#### 12.11 Array Characteristics

#### **Table 49: TLC Array Characteristics**

| Parameter  | Symbol                | Тур  | Max  | Unit | Notes |
|--|-----------------------|------|------|------|-------|
| ERASE BLOCK operation time   | <sup>t</sup> BERS     | 15   | 30   | ms   | 10    |
| ERASE SUSPEND operation time   | <sup>t</sup> ESPD     | -    | 150  | μs   | 13    |
| ERASE RESUME to ERASE SUSPEND delay  | <sup>t</sup> RSESPD   | -    | Ι    | ms   | 11    |
| Busy time when ERASE SUSPEND is issued when<br>LUN is already in the suspend state or ERASE<br>RESUME is issued when no erase is suspended<br>or ongoing   | tespdn                | μ    | 18   | μs   |       |
| PROGRAM PAGE operation effective time (per page) without $V_{PP}$  | <sup>t</sup> PROG_eff | 1900 | Ι    | μs   |       |
| PROGRAM PAGE operation time (per program command operation)  | <sup>t</sup> PROG     | Ι    | 9500 | μs   | 9     |
| LAST PAGE PROGRAM operation time   | <sup>t</sup> LPROG    | Ι    | Ι    | μs   | 4     |
| Cache busy   | <sup>t</sup> CBSY     | 1400 | 9500 | μs   | 9     |
| Page Buffer Transfer Busy time   | <sup>t</sup> PBSY     | 12   | 14   | μs   |       |
| PROGRAM SUSPEND operation time   | <sup>t</sup> PSPD     | -    | 150  | μs   |       |
| PROGRAM RESUME to PROGRAM SUSPEND delay  | <sup>t</sup> RSPSPD   | -    | -    | μs   | 12    |
| Busy time when PROGRAM SUSPEND is issued<br>when LUN is already in suspend state or<br>PROGRAM RESUME is issued when no program<br>is suspended or ongoing | <sup>t</sup> PSPDN    | -    | 18   | μs   |       |
| READ PAGE operation time without V <sub>PP</sub>   | <sup>t</sup> R        | 88   | 150  | μs   | 7,8   |
| SNAP READ operation time without VPP   | <sup>t</sup> RSNAP    | 51   | 100  | μs   |       |
| Cache read busy time   | <sup>t</sup> RCBSY    | 11   | 150  | μs   | 7,8   |





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| Parameter  | Symbol                       | Тур     | Max       | Unit   | Notes |
|--|------------------------------|---------|-----------|--------|-------|
| Auto Read Calibration time   | <sup>t</sup> RARC            | 600     | 1122      | μs     |       |
| Soft Data Busy Time  | <sup>t</sup> SBSY            | 4       | 15        | μs     |       |
| Soft Data Read Time (One-Bit Soft Data/Two-<br>Bits Soft Data)   | <sup>t</sup> RSD             | 340/485 | 625/875   | μs     |       |
| Single Bit Soft Bit Read (SBSBR) Cache Read<br>Busy Time   | <sup>t</sup> RCBSY_S<br>BSBR | 52      | 350       | μs     |       |
| Single Bit Soft Bit Read (SBSBR) Time  | <sup>t</sup> R_SBSBR         | 185     | 350       | μs     |       |
| Number of partial page programs  | NOP                          | -       | 1         | Cycles | 1     |
| Change column setup time to data in/out or<br>next command for both single LUN and multi-<br>LUN operations  | tCCS                         | -       | _         | ns     | 3     |
| Dummy busy time  | <sup>t</sup> DBSY            | 0.5     | 1         | μs     |       |
| Busy time for SET FEATURES and GET<br>FEATURES operations  | <sup>t</sup> FEAT            | _       | 1         | μs     |       |
| Busy time for interface change   | <sup>t</sup> ITC             | -       | 1         | μs     | 2     |
| Busy time for OTP DATA PROGRAM operation if OTP is protected   | tOBSY                        | -       | 100       | μs     |       |
| Power-on reset time  | <sup>t</sup> POR             | -       | 4         | ms     |       |
| Device reset time (Read/Program/Erase)   | <sup>t</sup> RST             | _       | 15/30/500 | μs     | 5     |
| Busy time for read operation from NAND status<br>bit RDY going<br>HIGH to NAND status bit ARDY going HIGH in<br>completion of array read operation | <sup>t</sup> RTABSY          | 10      | 12.5      | μs     | 14    |
| Full calibration time  | <sup>t</sup> ZQCL            | 1       | -         | μs     | 6     |
| Short calibration time   | tZQCS                        | 0.3     | -         | μs     | 6     |

Notes:

- 1) The pages in the OTP Block have an NOP of 2.
- 2) <sup>t</sup>ITC (MAX) is the busy time when the interface changes from Asynchronous to NV-DDR2 using the SET FEATURES (EFh) or SET FEATURES by LUN (D5h) command or NV-DDR2 to asynchronous using the RESET (FFh) command. During the <sup>t</sup>ITC time, any command, including READ STATUS (70h) and READ STATUS ENHANCED (78h), is prohibited.
- 3) <sup>t</sup>CCS (MIN) = 400ns
- 4) <sup>t</sup>LPROG = <sup>t</sup>PROG (last page) + <sup>t</sup>PROG (last page 1) command load time (last page) address load time (last page) data load time (last page). <sup>t</sup>LPROG only applies to SLC pages and Lower Pages without shared UP/XP programmed

5) If RESET command is issued at any other time other than Read/Program/Erase array busy times, the target goes busy for a maximum of 8µs. If RESET command is issued during <sup>t</sup>PBSY time, <sup>t</sup>RST may be up to 13µs. If RESET command is issued during <sup>t</sup>FEAT time during a Temperature Sensor Readout (FA=E7h), then <sup>t</sup>RST may be up to 150µs.

- 6) Increased time beyond TYP may result when greater than 8 LUNs share a ZQ resistor.
- 7) Read performance numbers are with Flag Check trim = 0 (flags not read). MAX spec is the worst <sup>t</sup>R and <sup>t</sup>RCBSY time when reading a page with all shared pages programmed. If all shared pages are not programmed, <sup>t</sup>R and <sup>t</sup>RCBSY MAX



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will be higher.

- 8) For Read Retry options 8 to 15, <sup>t</sup>R and <sup>t</sup>RCBSY MAX may be up to 480µs
- 9) In the case of a program operation that exceeds <sup>t</sup>PROG/<sup>t</sup>CBSY MAX, that specific NAND block may be retired by the host system.
- 10) In the case of an erase operation that exceeds <sup>t</sup>BERS MAX, that specific NAND block may be retired by the host system. <sup>t</sup>BERS TYP value represents approximately 30% of specified endurance life.
- 11) <sup>t</sup>RSESPD (MIN) = 4ms; If the delay from the ERASE RESUME (D2h) to the subsequent ERASE SUSPEND (61h) command is less than the minimum value of <sup>t</sup>RSESPD there may not be forward progress in the suspended Erase operation.
- 12) tRSPSPD (MIN) = 325µs; If the delay from the PROGRAM RESUME (13h) to the subsequent PROGRAM SUSPEND (84h) command is less than the minimum value of tRSPSPD there may not be forward progress in the suspended Program operation.
- 13) When in the quad plane Erase case,  ${}^{\mbox{t}}\mbox{ESPD}$  may be up to 165us
- 14) <sup>t</sup>RTABSY applies to all array Read operations. In Cache Read based operations <sup>t</sup>RTABSY still applies before the next array Cache Read operation begins.'

Any parameters not referenced in Table 50 should be referenced in Table 49.

#### **Table 50: SLC Array Characteristics**

| Parameter  | Symbol              | Тур | Max  | Unit   | Notes  |
|--|---------------------|-----|------|--------|--------|
| ERASE BLOCK operation time   | <sup>t</sup> BERS   | 15  | 30   | ms     | 4      |
| ERASE SUSPEND operation time   | <sup>t</sup> ESPD   | -   | 150  | μs     | 9      |
| ERASE RESUME to ERASE SUSPEND delay  | <sup>t</sup> RSESPD | -   | _    | ms     | 5      |
| Busy time when ERASE SUSPEND is issued when<br>LUN is already in the suspend state or ERASE<br>RESUME is issued when no erase is suspended or<br>ongoing   | tespdn              | _   | 18   | μs     |        |
| PROGRAM PAGE operation time without $V_{PP}$   | <sup>t</sup> PROG   | 226 | 750  | μs     | 3      |
| LAST PAGE PROGRAM operation time   | <sup>t</sup> LPROG  | -   | -    | μs     | 1      |
| Cache busy   | <sup>t</sup> CBSY   | 31  | 700  | μs     | 3      |
| PROGRAM SUSPEND operation time   | <sup>t</sup> PSPD   | -   | 150  | μs     |        |
| PROGRAM RESUME to PROGRAM SUSPEND delay  | <sup>t</sup> RSPSPD | -   | -    | μs     | 6      |
| Busy time when PROGRAM SUSPEND is issued<br>when LUN is already in suspend state or<br>PROGRAM RESUME is issued when no program is<br>suspended or ongoing | tpspdn              | _   | 18   | μs     |        |
| READ PAGE operation time without V <sub>PP</sub>   | <sup>t</sup> R      | 57  | 60   | μs     | 2,11   |
| SNAP READ operation time   | <sup>t</sup> RSNAP  | 27  | 37   | μs     |        |
| Cache read busy time   | <sup>t</sup> RCBSY  | 11  | 60   | μs     | 2,8,11 |
| Number of partial page programs  | NOP                 | -   | 2    | Cycles | 7      |
| Busy time for read operation from NAND status bit<br>RDY going<br>HIGH to NAND status bit ARDY going HIGH in<br>completion of array read operation         | <sup>t</sup> RTABSY | 10  | 12.5 | μs     | 10     |

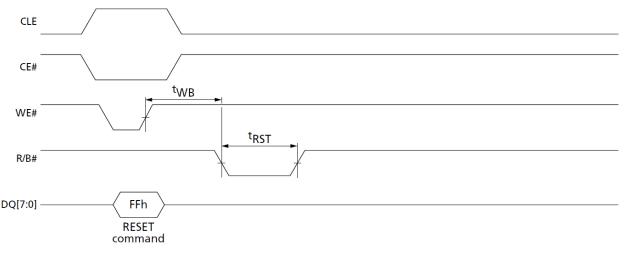
Notes:



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- <sup>t</sup>LPROG = <sup>t</sup>PROG (last page) + <sup>t</sup>PROG (last page 1) command load time (last page) address load time (last page) data load time (last page).
- 2) For Read Retry options 8 to 15, <sup>t</sup>R and <sup>t</sup>RCBSY MAX may be up to 180µs
- In the case of a program operation that exceeds <sup>t</sup>PROG/<sup>t</sup>CBSY MAX, that specific NAND block may be retired by the host system.
- 4) In the case of an erase operation that exceeds <sup>t</sup>BERS MAX, that specific NAND block may be retired by the host system. <sup>t</sup>BERS TYP value represents approximately 30% of specified endurance life.
- 5) <sup>t</sup>RSESPD (MIN) = 4ms; If the delay from the ERASE RESUME (D2h) to the subsequent ERASE SUSPEND (61h) command is less than the minimum value of <sup>t</sup>RSESPD there may not be forward progress in the suspended Erase operation.
- 6) <sup>t</sup>RSPSPD (MIN) = 325µs; If the delay from the PROGRAM RESUME (13h) to the subsequent PROGRAM SUSPEND (84h) command is less than the minimum value of <sup>t</sup>RSPSPD there may not be forward progress in the suspended Program operation.
- 7) The pages in the OTP Block have an NOP of 2.
- 8) If the next READ PAGE CACHE (31h, 00h-31h) or READ PAGE (00h-30h) command is issued when the device is still busy with the cache operation (RDY = 1, ARDY = 0), the next <sup>t</sup>RCBSY time may be up to <sup>t</sup>RCBSY (MAX) + <sup>t</sup>RCBSY (TYP).
- 9) When in the quad plane Erase case, <sup>t</sup>ESPD may be up to 165us
- 10) <sup>t</sup>RTABSY applies to all array Read operations. In Cache Read based operations <sup>t</sup>RTABSY still applies before the next array Cache Read operation begins.
- 11) If a multi-plane read is issued that includes a factory bad block or out of bound block, the maximum <sup>t</sup>R and <sup>t</sup>RCBSY will be 62µs.

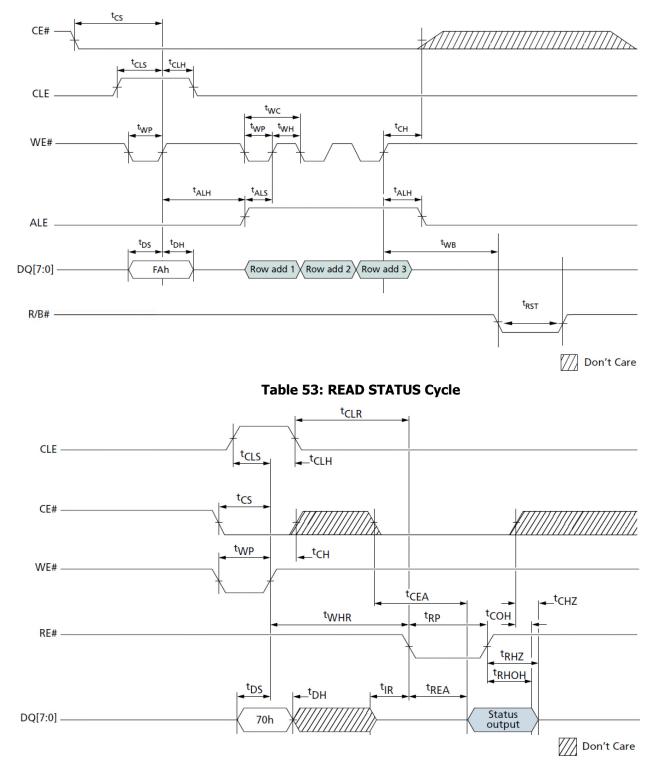
### 12.12 Asynchronous Interface Timing



#### Table 51: RESET Operation



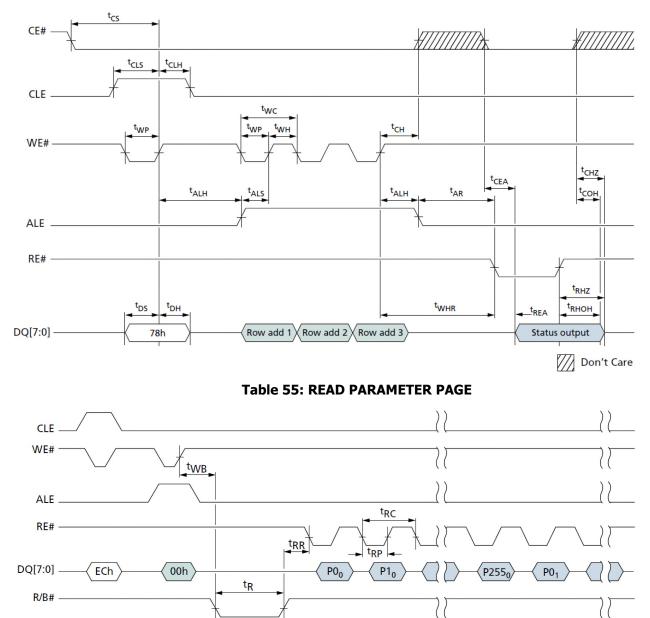
**Table 52: RESET LUN Operation** 





# UT81NDQ512G8T

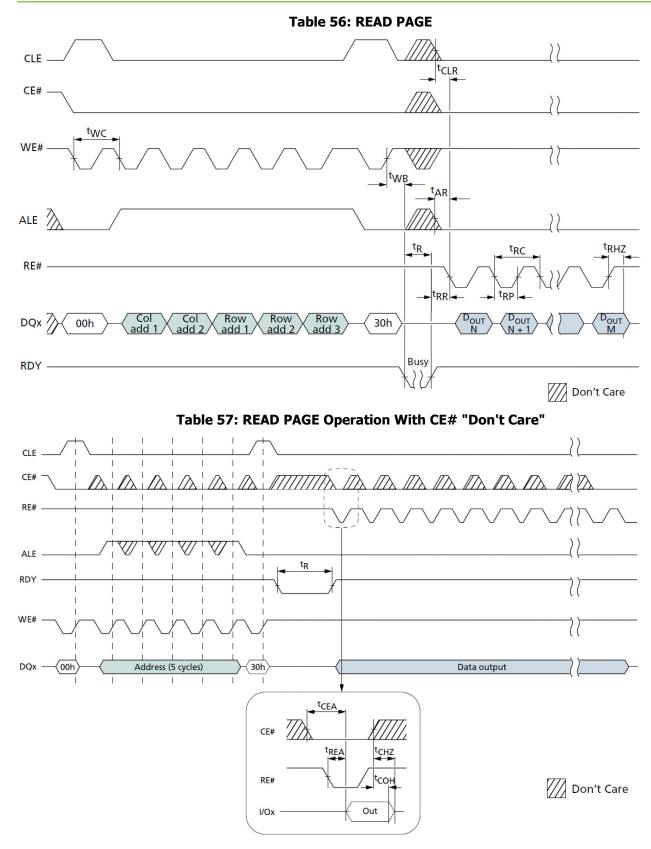
### Table 54: READ STATUS ENHANCED Cycle





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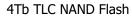
# 4Tb TLC NAND Flash UT81NDQ512G8T





DATASHEET

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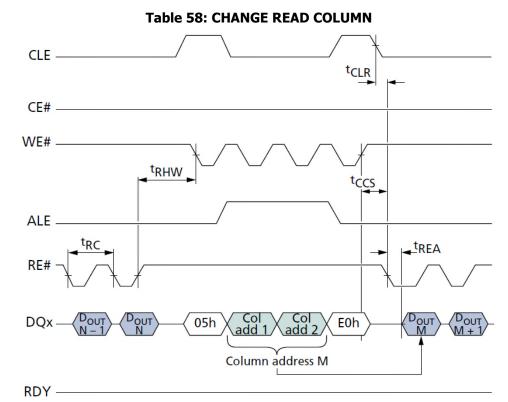
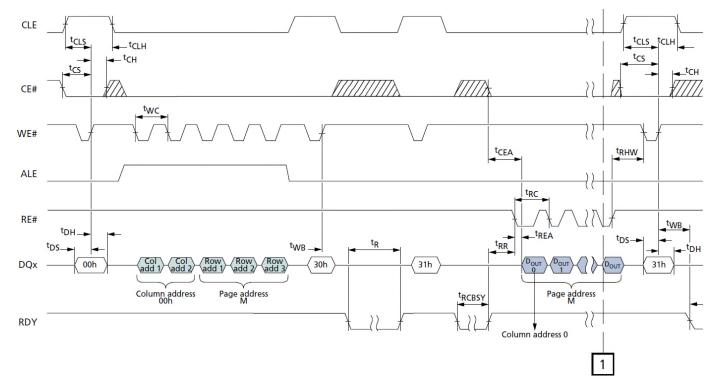
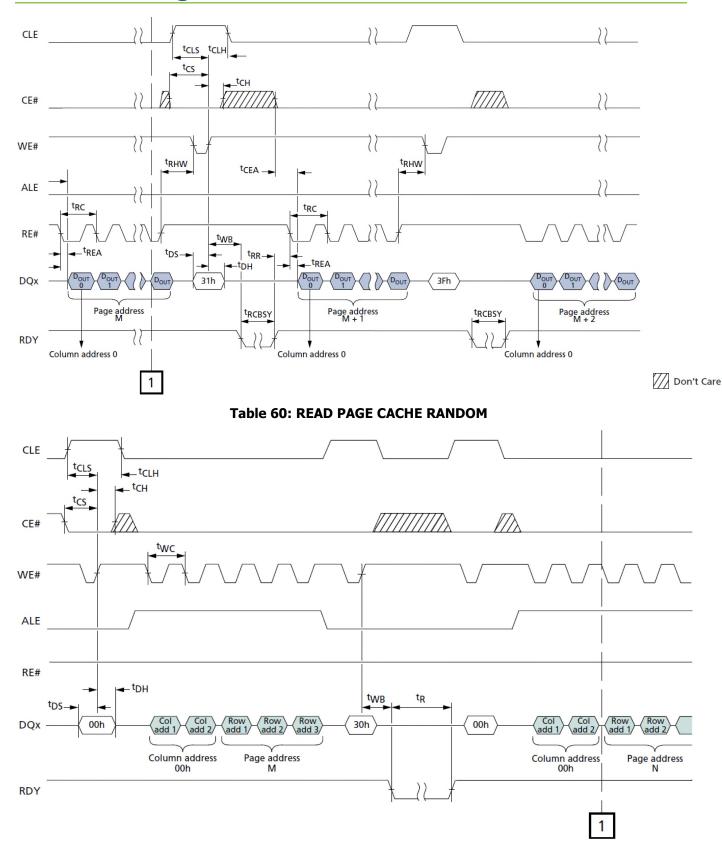


Table 59: READ PAGE CACHE SEQUENTIAL



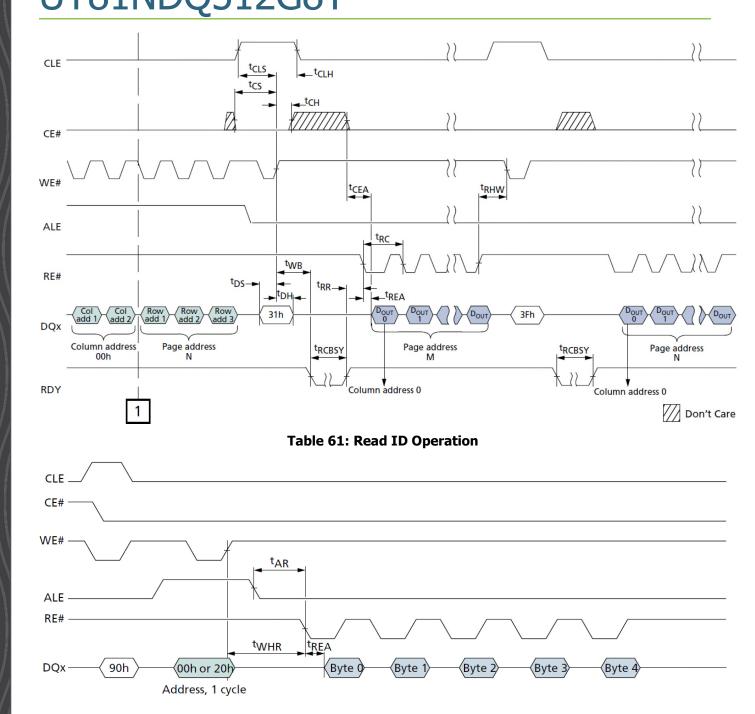


# 4Tb TLC NAND Flash UT81NDQ512G8T



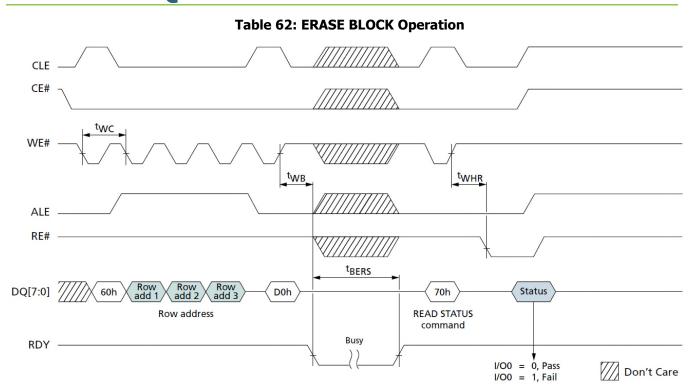






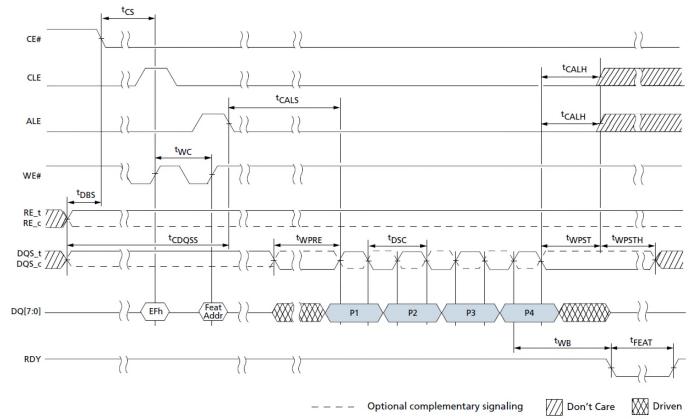


# 4Tb TLC NAND Flash UT81NDQ512G8T



### 12.13 NV-DDR2, NV-DDR3 Interface Timing

### Table 63: SET FEATURES Operation

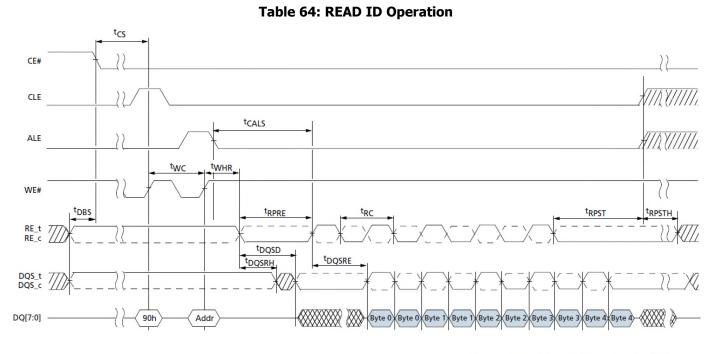


**Note**: DQS is Don't Care during ACTIVE command cycle (CLE is high) and active addresses cycle (ALE is high). When ODT is enabled and anytime CE#, ALE, CLE, and DQS are low additional current may result.





# 4Tb TLC NAND Flash UT81NDQ512G8T

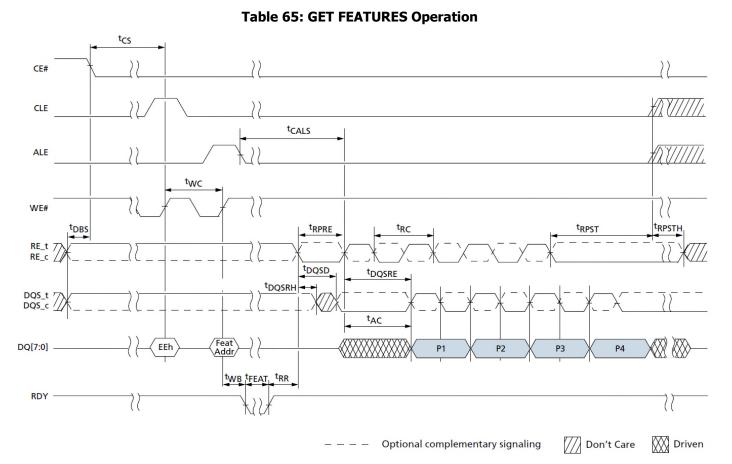


– – – – Optional complementary signaling 께 Don't Care 🗰 Driven

**Note**: DQS is Don't Care during ACTIVE command cycle (CLE is high) and active addresses cycle (ALE is high). When ODT is enabled and anytime CE#, ALE, CLE, and DQS are low additional current may result.



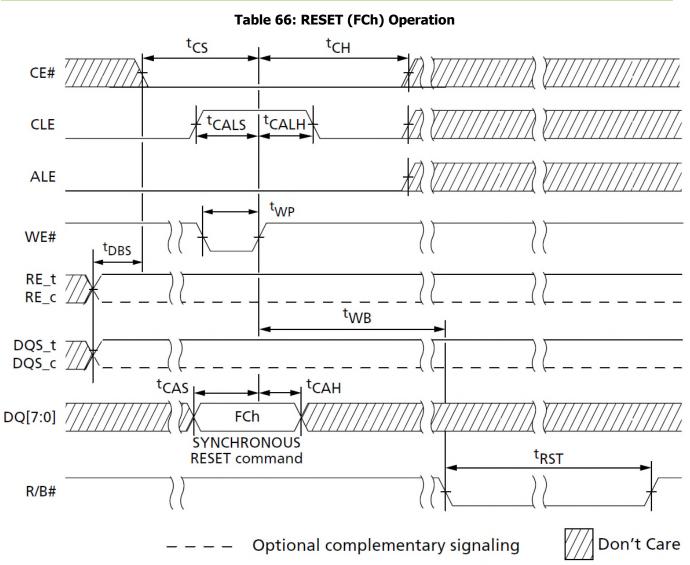
# 4Tb TLC NAND Flash UT81NDQ512G8T



**Note**: DQS is Don't Care during ACTIVE command cycle (CLE is high) and active addresses cycle (ALE is high). When ODT is enabled and anytime CE#, ALE, CLE, and DQS are low additional current may result.



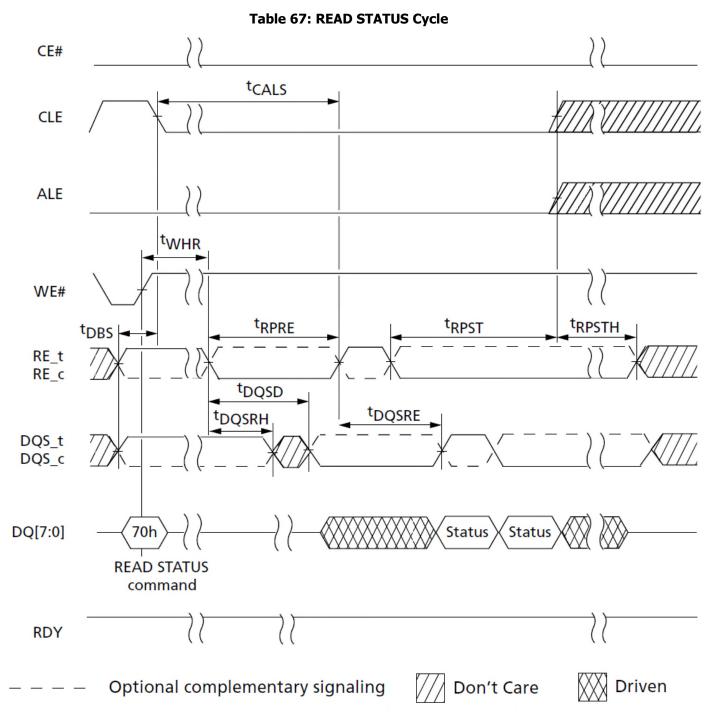
### UT81NDQ512G8T



**Note**: DQS is Don't Care during ACTIVE command cycle (CLE is high). When ODT is enabled and anytime CE#, ALE, CLE, and DQS are low additional current may result.

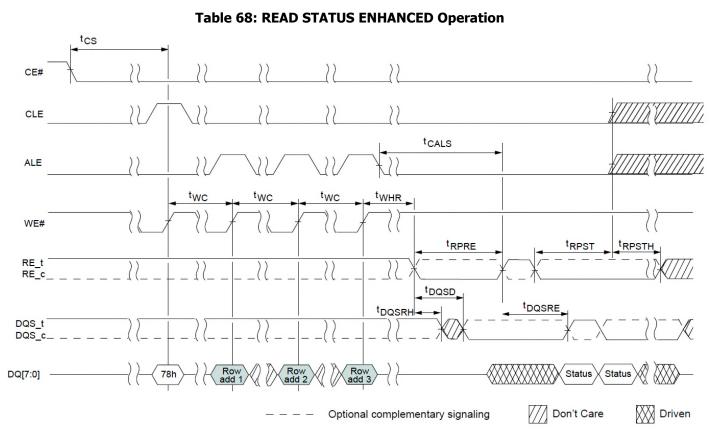


### UT81NDQ512G8T



**Note:** DQS is Don't Care during ACTIVE command cycle (CLE is high). When ODT is enabled and anytime CE#, ALE, CLE, and DQS are low additional current may result.





**Note**: DQS is Don't Care during ACTIVE command cycle (CLE is high) and active addresses cycle (ALE is high). When ODT is enabled and anytime CE#, ALE, CLE, and DQS are low additional current may result.

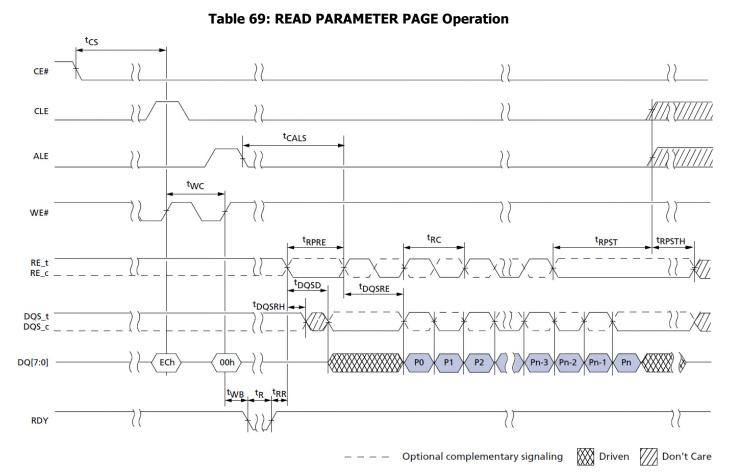
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DATASHEET

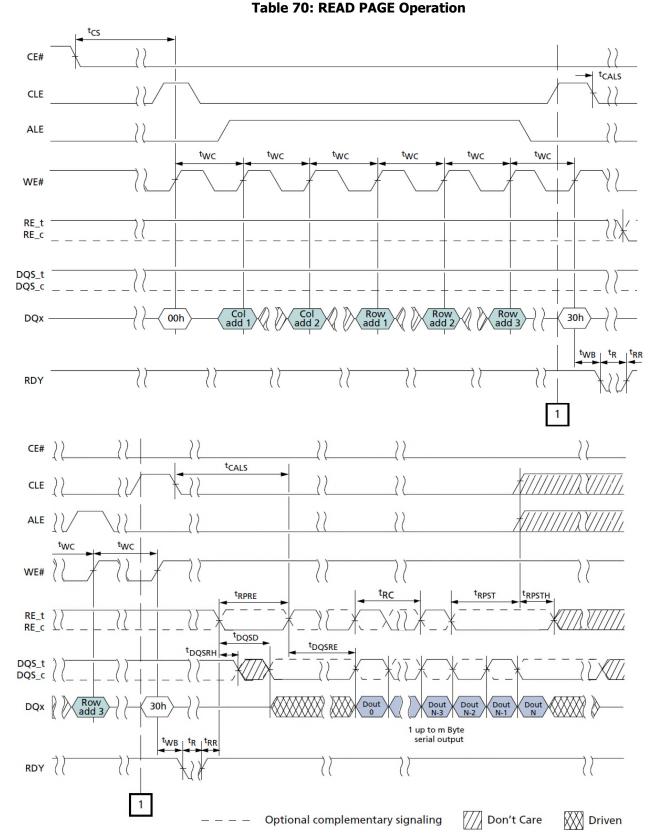
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#### 4Tb TLC NAND Flash

### UT81NDQ512G8T

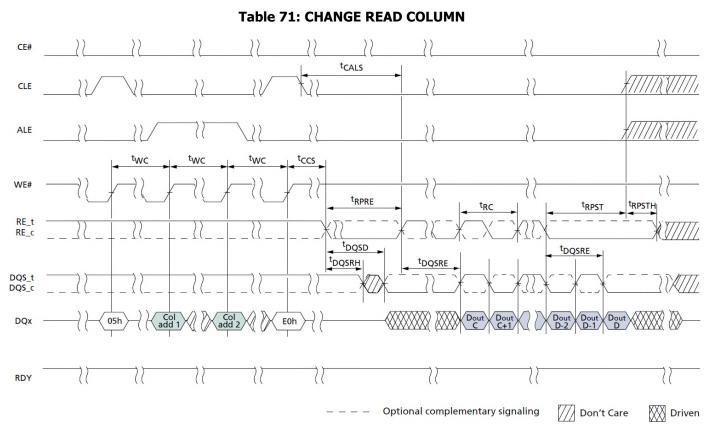








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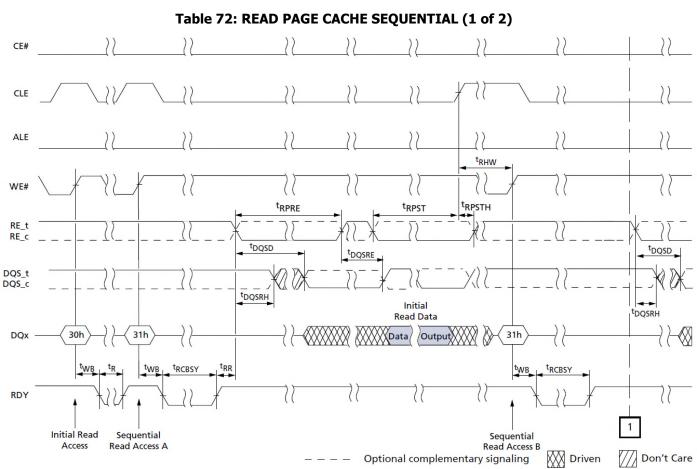


# DATASHEET

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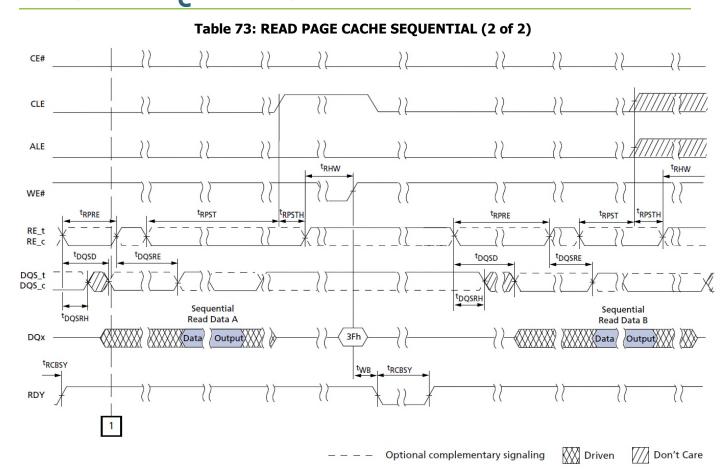
4Tb TLC NAND Flash

#### UT81NDQ512G8T



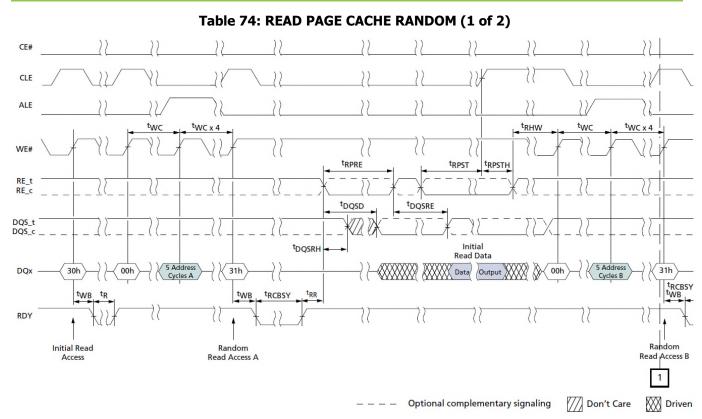
**Note**: DQS is Don't Care during ACTIVE command cycle (CLE is high). When ODT is enabled and anytime CE#, ALE, CLE, and DQS are low additional current may result.



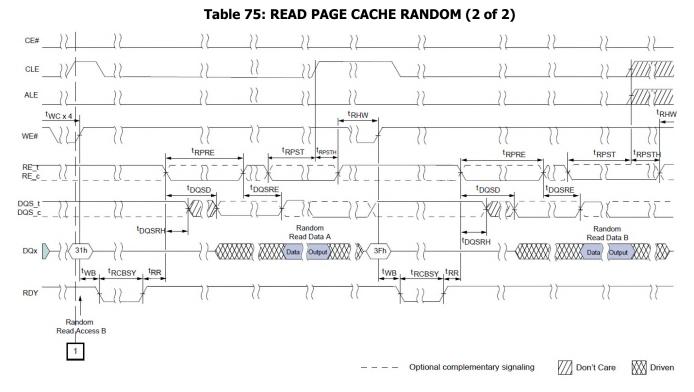


**Note**: DQS is Don't Care during ACTIVE command cycle (CLE is high). When ODT is enabled and anytime CE#, ALE, CLE, and DQS are low additional current may result.

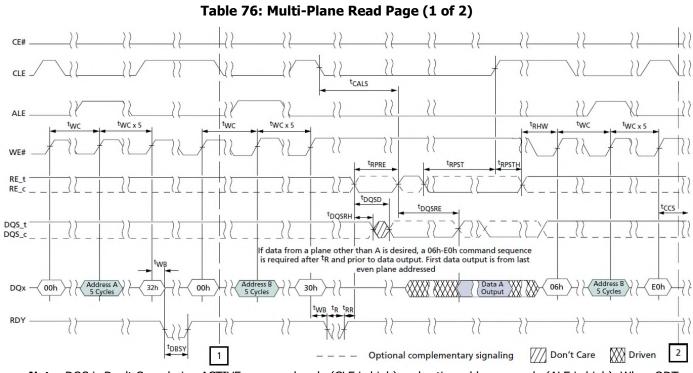




**Note**: DQS is Don't Care during ACTIVE command cycle (CLE is high) and active addresses cycle (ALE is high). When ODT is enabled and anytime CE#, ALE, CLE, and DQS are low additional current may result.



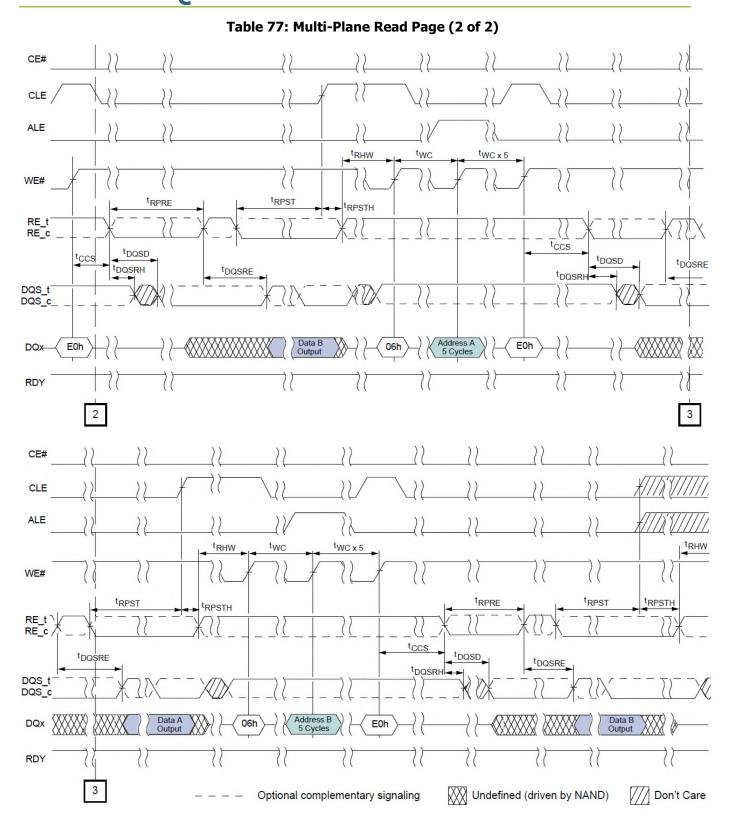




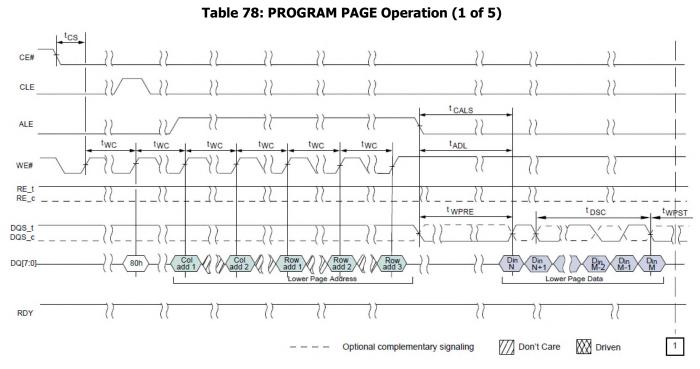












**Note**: DQS is "don't care" during active command cycle (CLE is high) and active addresses cycle (ALE is high). When ODT is enabled and anytime CE#, ALE, CLE and DQS are low additional current may result.

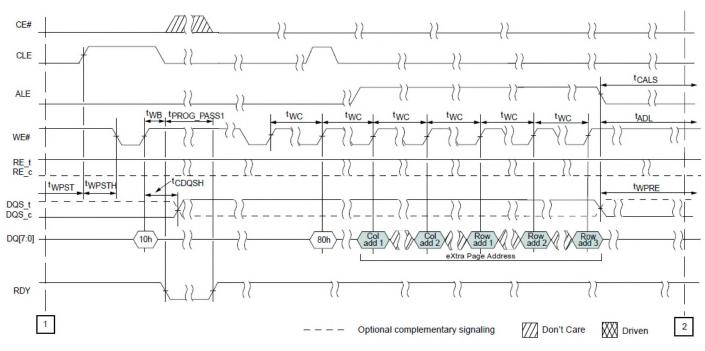
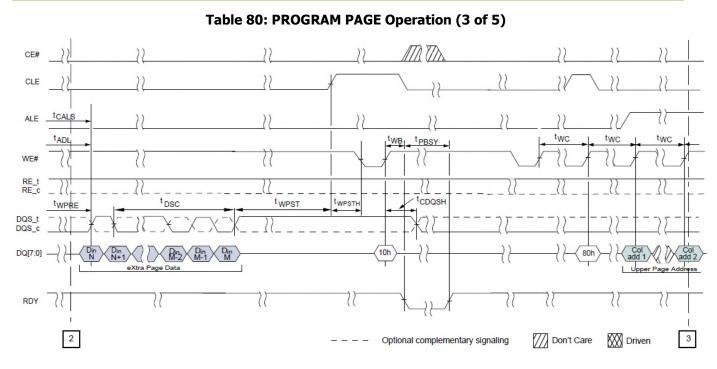


Table 79: PROGRAM PAGE Operation (2 of 5)





**Note**: DQS is "don't care" during active command cycle (CLE is high) and active addresses cycle (ALE is high). When ODT is enabled and anytime CE#, ALE, CLE and DQS are low additional current may result.

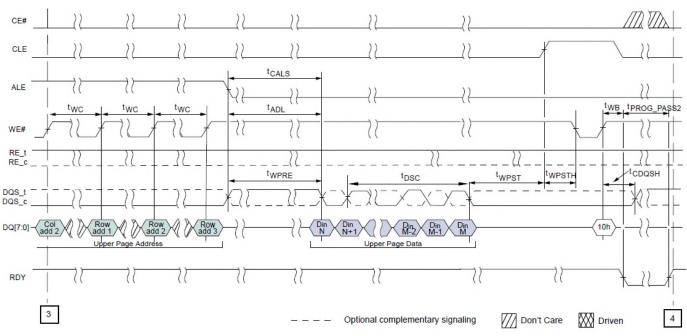


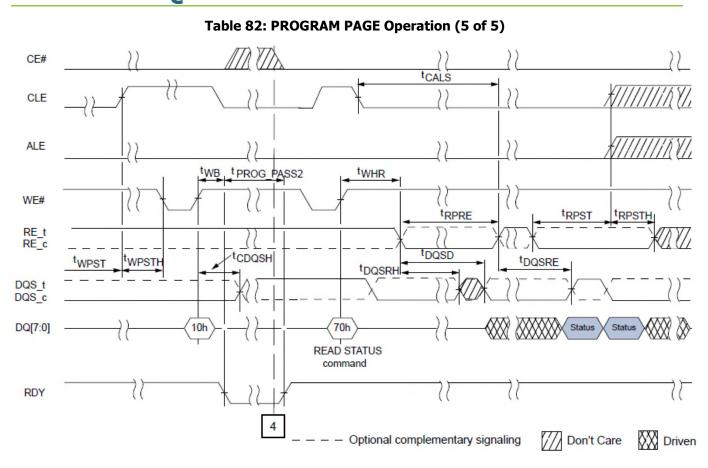
Table 81: PROGRAM PAGE Operation (4 of 5)

**Note**: DQS is "don't care" during active command cycle (CLE is high) and active addresses cycle (ALE is high). When ODT is enabled and anytime CE#, ALE, CLE and DQS are low additional current may result.



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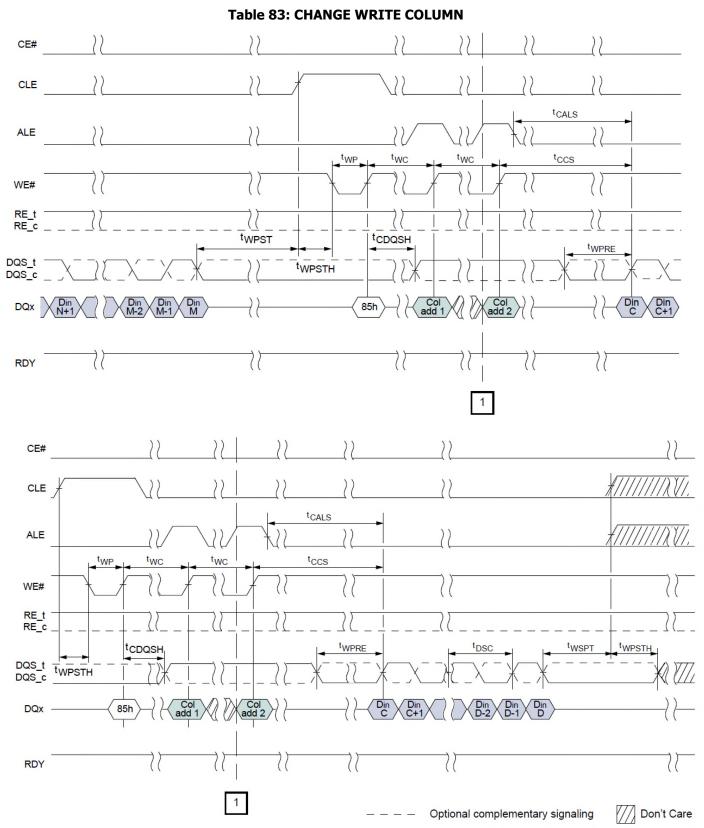






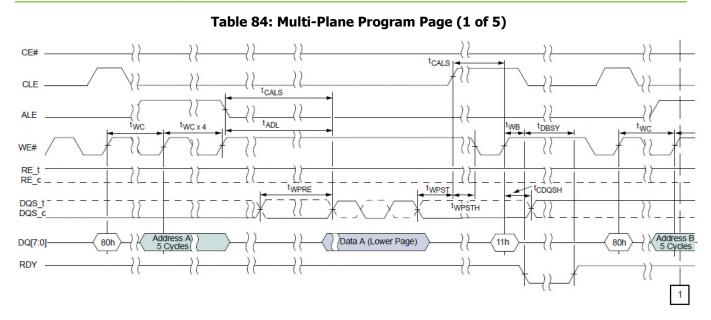
4Tb TLC NAND Flash

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**Note**: DQS is "don't care" during active command cycle (CLE is high) and active addresses cycle (ALE is high). When ODT is enabled and anytime CE#, ALE, CLE and DQS are low additional current may result.

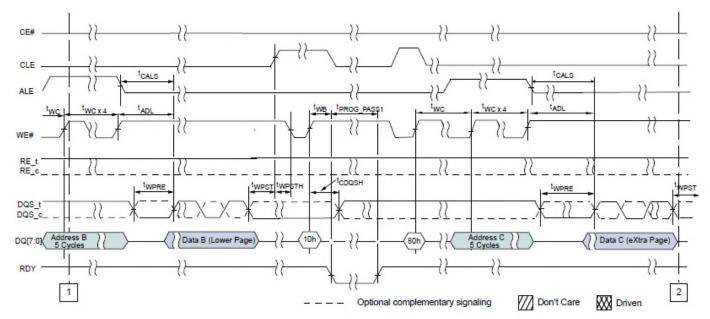
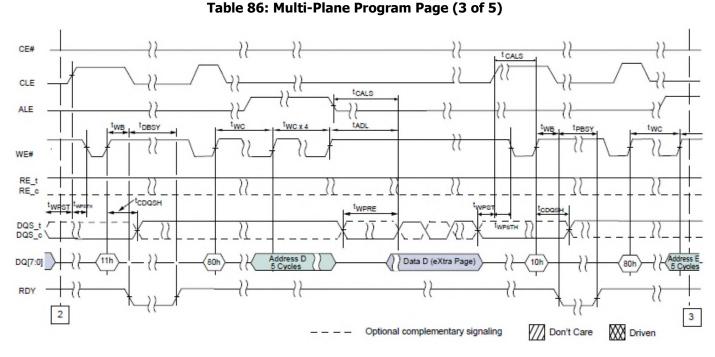


Table 85: Multi-Plane Program Page (2 of 5)



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**Note**: DQS is "don't care" during active command cycle (CLE is high) and active addresses cycle (ALE is high). When ODT is enabled and anytime CE#, ALE, CLE and DQS are low additional current may result.

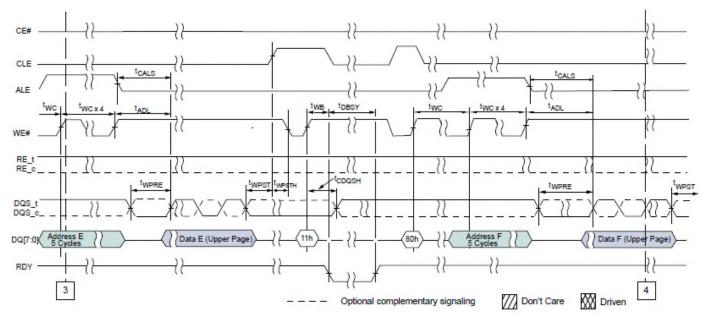
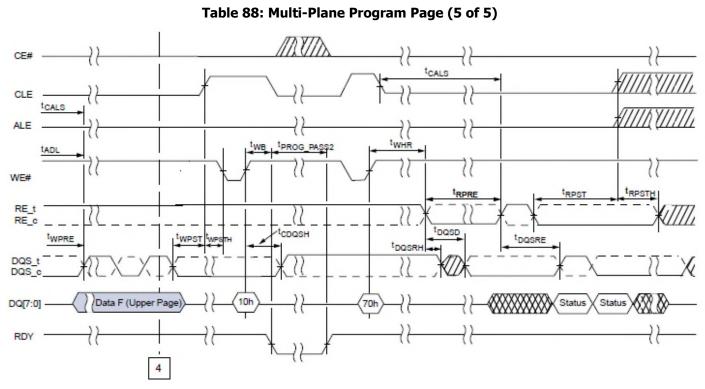


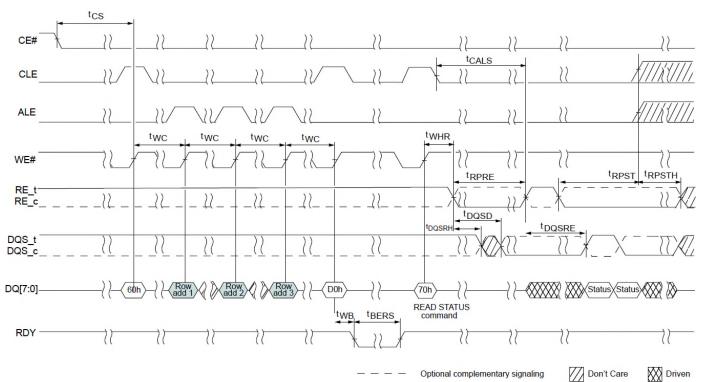
Table 87: Multi-Plane Program Page (4 of 5)



### UT81NDQ512G8T



**Note**: DQS is "don't care" during active command cycle (CLE is high) and active addresses cycle (ALE is high). When ODT is enabled and anytime CE#, ALE, CLE and DQS are low additional current may result.

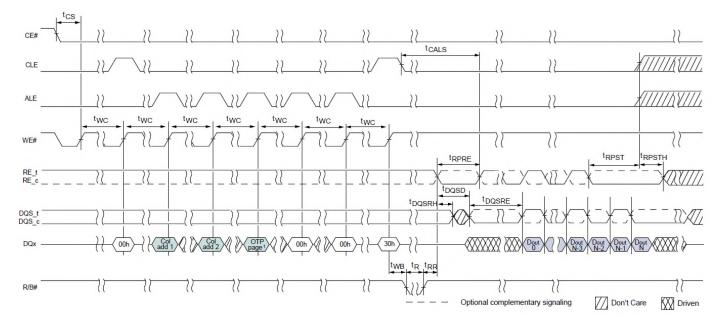


**Table 89: ERASE BLOCK** 



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Table 90: READ OTP PAGE



**Note**: DQS is Don't Care during ACTIVE command cycle (CLE is high) and active addresses cycle (ALE is high). When ODT is enabled and anytime CE#, ALE, CLE, and DQS are low additional current may result.

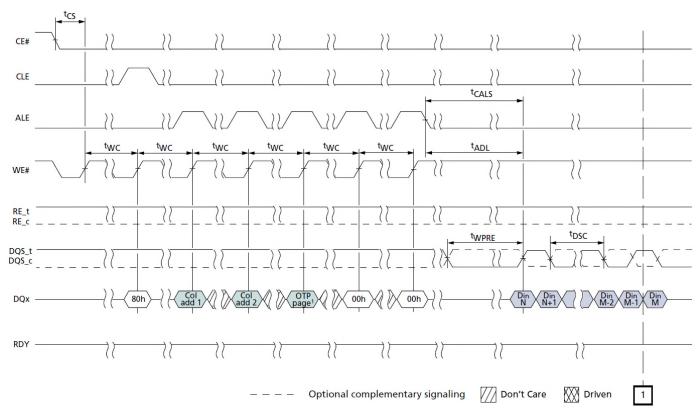
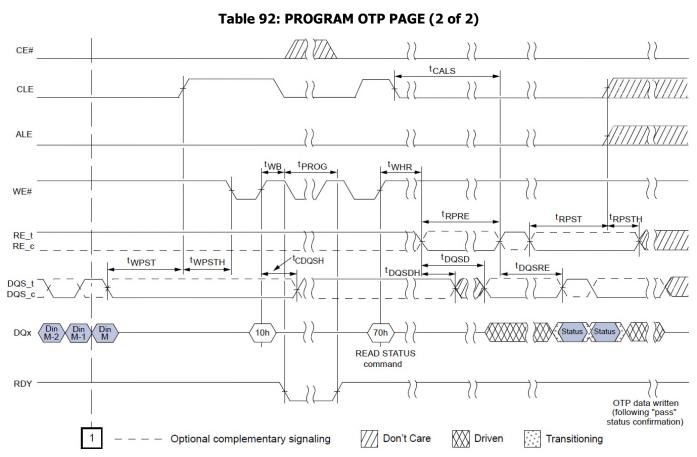


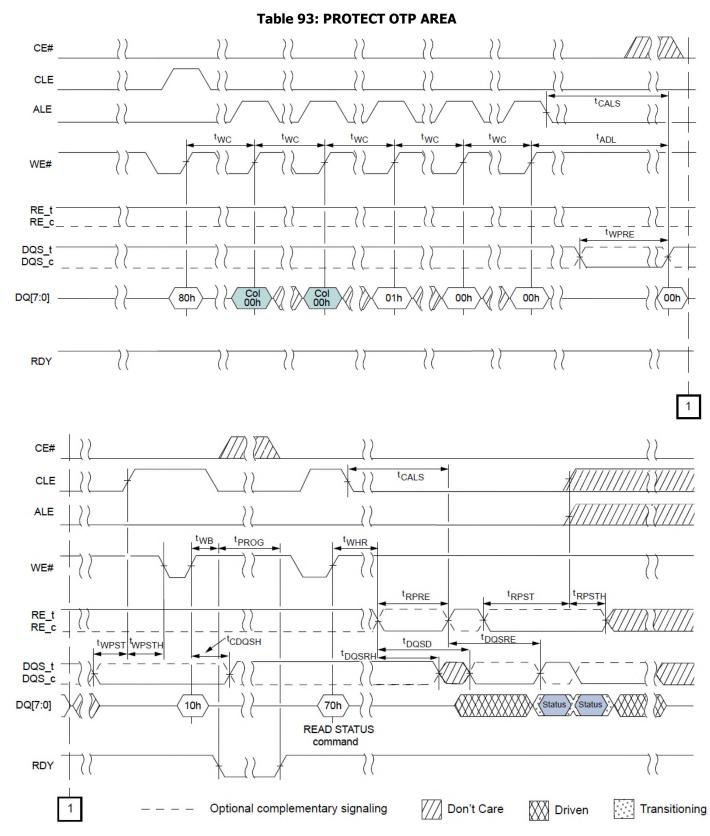
Table 91: PROGRAM OTP PAGE (1 of 2)







#### UT81NDQ512G8T

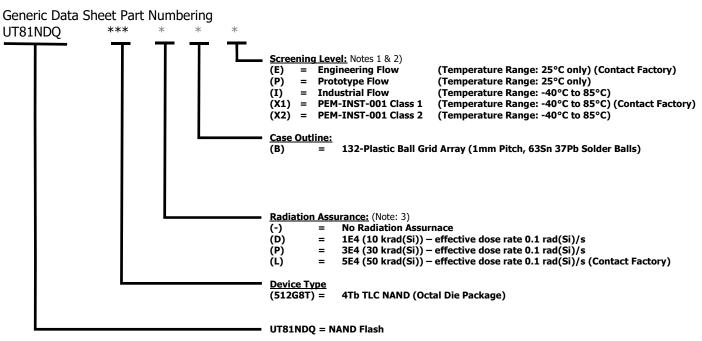




4Tb TLC NAND Flash

#### UT81NDQ512G8T

#### **13 Ordering information**



#### Notes:

- 1) Engineering Units will be marked with the base part number (UT81NDQ512G8T or UT81NDQ512G8ES) only. Engineering units may be shipped with lead free (SAC305) or eutectic (63Sn37Pb) solder balls at factory option.
- 2) Contact factory is listed for options that are subject to availability or do not have a planned availability schedule.
- 3) Radiation assurance levels may ONLY be applied to INDUSTRIAL ("I") and PEM\_INST-001 ("X1" or "X2") orders. When a radiation assurance level is applied to an INDUSTRIAL Flow order, the units delivered will be screened to the INDUSTRIAL flow and include a Radiation Assurance and Generic PEM-INST-001 Qualification Data Pack for the assembly lot used to fulfil the order.



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### UT81NDQ512G8T

#### **14 Revision History**

| Date  | Change Description |  |
|-------|--------------------|--|
| 11/22 | Initial release    |  |



## UT81NDQ512G8T

#### Datasheet Definitions

|                       | DEFINITION  |
|-----------------------|---|
| Advanced Datasheet    | CAES reserves the right to make changes to any products and services described herein at any time without notice. The product is still in the development stage and the datasheet <b>is subject to change</b> . Specifications can be <b>TBD</b> and the part package and pinout are <b>not final</b> . |
| Preliminary Datasheet | CAES reserves the right to make changes to any products and services described herein at any time without notice. The product is in the characterization stage and prototypes are available.  |
| Datasheet             | Product is in production and any changes to the product and services described herein will follow a formal customer notification process for form, fit or function changes.   |

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